## Overview

## HP Pro Mini 400 G9 Desktop PC

| PROMINI SSE-F = SS  |  |
|---|--|
| Type-C <sup>®</sup> SuperSpeed USB 20Gbps signaling rate port<br>(charge support up to 5V/3A) | <ol> <li>Combo Audio Jack with CTIA and OMTP and headse support</li> </ol> |

- 2. Type-A SuperSpeed USB 10Gbps signaling rate port
- 3. Type-A SuperSpeed USB 10Gbps signaling rate port (charge support up to 5V/1.5A)
- et support
- 5. Dual-state power button
- 6. Hard drive activity light

#### Not shown

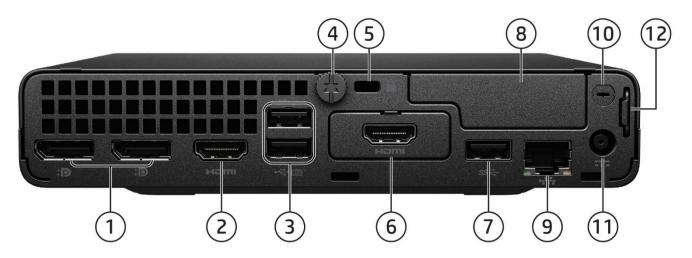
1.

(2) M.2 (1 as M.2 2230 socket for WLAN/Bluetooth® and 1 as M.2 2280 socket for storage)

(1) 2.5" internal storage drive bay

## Overview

## HP Pro Mini 400 G9 Desktop PC



- 1. 2x Dual Mode DisplayPort<sup>™</sup> 1.4a(DP++)
- 2. HDMI 2.1
- 3. 2x Type-A SuperSpeed USB 5Gbps signaling rate port (Supporting wake from S4/S5 with keyboard/mouse connected and enabled in BIOS)
- 4. Cover release thumbscrew
- 5. Standard cable lock slot (10 mm)
- 6. Flex Port 1, choice of:
  - DisplayPort<sup>™</sup>1.4a with HBR3 VGA
  - HDMI 2.1a
  - Type-C<sup>®</sup> SuperSpeed USB 10Gbps signaling rate port w/ DisplayPort<sup>™</sup> Alt mode and power intake via Type-C<sup>®</sup> Power Delivery up to 100W

Serial<sup>1</sup>

#### Not shown

- Slots
- (1) Internal M.2 2230 connector for WLAN
- (1) Internal M.2 SSD storage 2280 connector

- 7. Type-A SuperSpeed USB 10Gbps signaling rate port
- 8. Flex Port 2<sup>2</sup>, choice of:
  - 2x Type-A Hi-Speed USB 480Mbps signaling rate port
  - Serial
  - 2<sup>nd</sup> External Antenna
- 9. RJ45 network connector
- 10. External WLAN antenna opening<sup>2</sup>
- 11. Power connector
- 12. Retractable Padlock loop

### Mounting

Support for

- Dual VESA Sleeve V4 Standalone
- -Quick Release Bracket
- B200/B300/B500/B550/B560/B600 Mounting bracket
- Integrated Work Center Stand
- HP Single Monitor Arm

- 1. Sold separately or as an optional feature.
- 2. Must be configured at time of purchase.

# Overview

## HP Pro SFF 400 G9 Desktop PC



- 1. Slim optical drive (optional)
- 2. (1) Type-C<sup>®</sup> SuperSpeed USB 10Gbps signaling rate port
- 3. (1) Type-A SuperSpeed USB 10Gbps signaling rate port
- 4. (2) Type-A SuperSpeed USB 10Gbps signaling rate port
- 5. SD card 4.0 reader (optional)
- 6. Combo Audio Jack with CTIA and OMTP and headset support
- 7. Dual-state power button
- 8. Hard drive activity light

### <u>Not shown</u>

- (1) PCI Express x16
- (1) PCI Express x1

(2) M.2 (1 as M.2 2230 socket for WLAN/Bluetooth<sup>®1</sup> and 1 as M.2 2280 socket for storage)

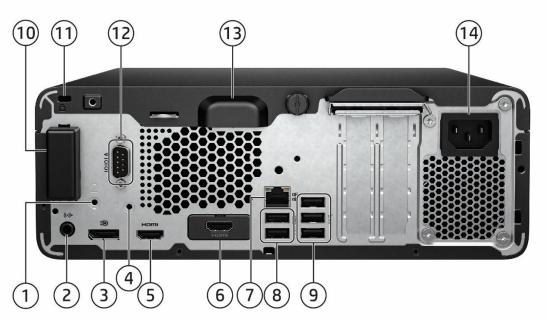
1. Must be configured at time of purchase.

### HP Pro Series 400 G9 Desktops PCs

# QuickSpecs

## Overview

## HP Pro SFF 400 G9 Desktop PC



- 1. External antenna (optional)
- 2. Audio line-in/line-out connector
- 3. Dual-Mode DisplayPort<sup>™</sup> 1.4a (DP++)
- 4. External antenna (option 1)
- 5. HDMI 1.4b
- 6. Flex Port, choice of:
  - DisplayPort™1.4a •VGA
  - HDMI 2.1 Serial
  - Dual Type-A SuperSpeed USB 5Gbps signaling rate
  - Type-C<sup>®</sup> SuperSpeed USB 10Gbps signaling rate with DisplayPort<sup>™</sup> Alt mode

### <u>Not shown</u>

#### Port

Optional PS/2 (2 ports) & serial port card<sup>1</sup> (connected with mainboard via flyer cable)

Optional parallel port<sup>1</sup>

Optional 4 Serial Port PCIe Card<sup>1</sup> (1 to 4 serial port dongle)

1. Each of the legacy options will occupy one rear slot.

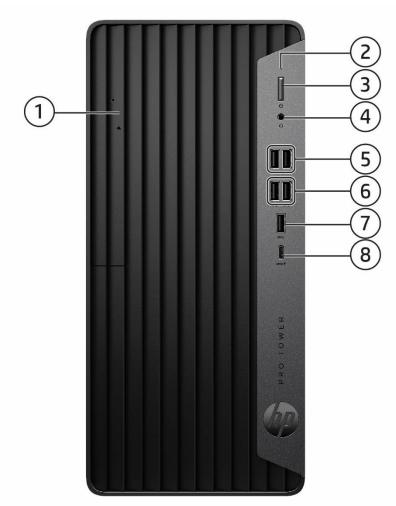
- 7. RJ45 network connector
- 8. (2) Type-A Hi-Speed USB 480Mbps signaling rate port (Supporting wake from S4/S5 with keyboard/mouse connected and enabled in BIOS)
- 9. (3) Type-A SuperSpeed USB 5Gbps signaling rate port
- 10. Internal WLAN antenna cover (optional)
- 11. Standard cable lock slot
- 12. Serial Port (Optional)
- 13. Integrated accessory cable lock
- 14. Power cord connector

#### Bay

- (1) 9.5mm internal optical drive bay
- (1) 3.5" internal storage drive bay



## Overview



5.

# HP Pro Tower 400/480 G9 PCI Desktop PC

- 1. Slim optical drive (optional)
- 2. Hard drive activity light
- 3. Dual-state power button
- 4. Combo Audio Jack with CTIA and OMTP headset support
- <u>Not shown</u>

6. (2) Type-A SuperSpeed USB 10Gbps signaling rate port

Front FlexIO Dual USB module (Option)

- 7. (1) Type-A SuperSpeed USB 10Gbps signaling rate port
- 8. (1) Type-C<sup>®</sup> SuperSpeed USB 10Gbps signaling rate port

PCI Express x16 (1) PCI Express x1 (1) PCI x1 (2) M 2 (1 25 M 2 222)

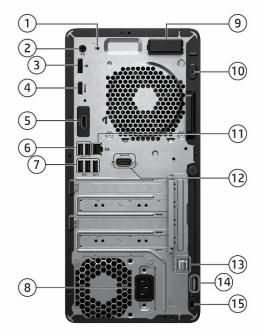
(2) M.2 (1 as M.2 2230 socket for WLAN/Bluetooth<sup>®</sup>/storage<sup>1</sup> and 1 as M.2 2280 socket for storage)

1. Optional

2. SD card and front flex port can only select one at the same time



## Overview



## HP Pro Tower 400/480 G9 PCI Desktop PC

- External WLAN antenna (select products only) 1.
- 2. Audio line-in/line-out connector
- Dual-Mode DisplayPort<sup>™</sup> 1.4a (DP++) 3.
- 4. HDMI 1.4b
- 5. Flex Port, choice of:
  - DisplayPort<sup>™</sup>1.4a VGA
  - HDMI 2.1
  - Serial • Dual Type-A SuperSpeed USB 5Gbps signaling rate
  - Type-C<sup>®</sup> SuperSpeed USB 10Gbps signaling rate with DisplayPort<sup>™</sup> Alt mode)
- (2) Type-A Hi-Speed USB 480Mbps signaling rate (Supporting 6. wake from S4/S5 with keyboard/mouse connected and enabled in BIOS)

### Not shown

#### Port

Optional PS/2 (2 ports) & serial port card (connected with mainboard via flyer cable)<sup>1</sup>

Optional parallel port<sup>1</sup>

Optional 4 Serial Port PCIe Card<sup>1</sup> (1 to 4 serial port dongle)

#### 1. Each of the legacy options will occupy one rear slot

- 7. (3) Type-A SuperSpeed USB 5Gbps signaling rate port
- 8. Power cord connector
- Internal WLAN antenna cover (optional) 9.
- 10. Internal WLAN antenna cover (optional)
- 11. RJ45 network connector
- 12. Serial port (optional)
- 13. Integrated keyboard/mouse wire hoop
- Pad lock 14.
- Standard cable lock slot 15.

### Bay

- (1) 9.5mm internal optical drive bay
- (2) 3.5" internal storage drive bay



Overview

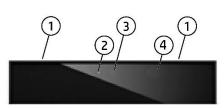


## HP ProOne 440 23.8 inch G9 All-in-One Desktop PC (Touch/Non-Touch)

- 1. Pull-up webcam (optional)
- 2. Combo Audio Jack with CTIA and OMTP headset support
- 3. Speakers (optional)
- 4. SD media card reader (optional)
- 5. On-screen display (OSD) buttons

- 6. Power button
- 7. Power activity light
- 8. Type-C<sup>®</sup> SuperSpeed USB 10Gbps signaling rate port (charge support up to 5V/3A)
- 9. Type-A SuperSpeed USB 10Gbps signaling rate port (charge support up to 5V/1.5A)

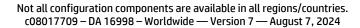
5MP webcam with Temporal Noise Reduction + IR Sensor + Color Light Sensor (optional)



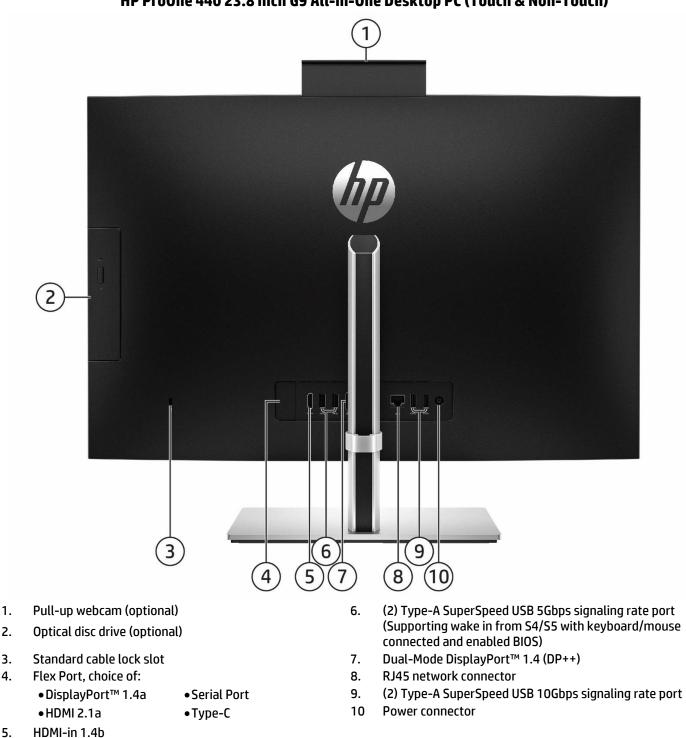
- 1. Dual microphones
- 2. Webcam light
- 3. IR/5MP/CLS webcam
- 4. IR light

5MP webcam with Temporal Noise Reduction (optional)

- 1. Dual microphones
- 2. Webcam light
- 3. 5MP webcam



Overview



## HP ProOne 440 23.8 inch G9 All-in-One Desktop PC (Touch & Non-Touch)

1. Availability may vary by country



### Overview

# AT A GLANCE

- Choice of four form factors: Tower, Small Form Factor, Mini Desktop and All-in-One.
- Latest commercial class Intel<sup>®</sup> Q670 chipsets supporting Intel<sup>®</sup> Core<sup>™</sup> 12<sup>th</sup>, 13<sup>th</sup> and latest 14<sup>th</sup> Generation processors, featuring both integrated Intel<sup>®</sup> UHD Graphics and optional discrete graphics.
- Choice of Windows 11 Professional, Windows 11 Home, and FreeDOS.
- Hardware feature highlights:
  - All Form Factors:
    - Up to 64 GB DDR5 Memory, Max Speed up to 4800 MT/s (and up to 5600 MT/s on TWR and SFF) with selected Intel<sup>®</sup> Core<sup>™</sup> 14th Gen i5 & i7 Processors.
    - Integrated 10/100/1000 Ethernet Controller, with optional Wi-Fi 6E, Wi-Fi 6 (802.11ax) and Wi-Fi 5 (802.11ac) and Bluetooth<sup>®</sup>.
    - TUV Ultra Low Noice Certification on selected configuration.
  - TWR/SFF:
    - Multiply video outputs via 2 standard video ports, optional Flex IO and discrete graphics.
    - Rear Flex IO choices of Serial, VGA, DisplayPort, HDMI & USB Type-C<sup>®</sup> with DisplayPort<sup>™</sup> Output.
    - Total 9 USB ports including 8 USB-A and 1 USB Type-C<sup>®</sup>
  - o Mini
    - Configurable FlexPort which provides the following choices: HDMI 2.1, Serial, VGA, DisplayPort<sup>™</sup> 1.4a, or USB Type-C<sup>®</sup> with DisplayPort<sup>™</sup> 1.4 with Power Delivery and Dual USB Type-A.
    - 2<sup>nd</sup> FlexPort available for configuration with the following ports: Serial, Dual USB Type-A, and 2<sup>nd</sup> external antenna.
    - Single cable scenario support when configured with FlexPort USB Type-C<sup>®</sup> with DisplayPort<sup>™</sup> 1.4 with Power Delivery via selected HP monitors.
    - Total 10 USB ports including 9 USB-A and 1 USB Type-C<sup>®</sup> when configured with both FelxPorts in USB offering.
  - AiO:
    - Audio with HP Noise Cancellation Software, HP Dynamic Audio, and HP Sound Calibration.
    - Enhanced video conferencing experience with HP Auto Frame, HP Keystone Correction, Auto Camera Select, and Backlight/Lowlight Adjustments.
    - Multicamera software support of an additional webcam (optional) (sold separately).
    - HP Eye Ease TÜV Certified Integrated Low Blue Light panels.
    - Optional 23.8" FHD touchscreen with micro-edge bezel.
    - Optional 5MP pull-up camera with options for Temporal Noise Reduction, IR sensor, and Color Light sensor.
    - HDMI-in enabled Monitor Mode which disassociates panel from CPU for use as strictly display only.
    - Rear Flex IO choices of Serial, DisplayPort, HDMI & USB Type-C<sup>®</sup> with DisplayPort<sup>™</sup> Output.
- Sustainability:
  - ENERGY STAR<sup>®</sup> certified. EPEAT<sup>®</sup> Climate+ registered where applicable.
  - $\circ$  High efficiency energy saving power supply and external power supply adapters.
  - Recycled metals, low halogen & ocean bound plastics used in materials.
  - 100% sustainably sourced and recyclable package.

## Overview

- TCO edge for AiO & TCO 9.0 for TWR/SFF/Mini.Software, Security & Manageability
  - Optional vPro Enterprise and Essentials
  - HP Wolf Security for Business includes HP Sure Click and HP Sure Sense
  - HP Tamper lock
  - o HP Connect
  - HP BIOSphere
- Protected by HP Services, including limited warranty up to 1-1-1 (terms and conditions vary by country; certain restrictions and exclusions apply); Care Packs available with up to 5 years Next Business Day Onsite Hardware Support.
- Power consumption of Desktop Mini PC varies per configuration, for the best user experience, please connect PC power cord while using USB-C<sup>®</sup> cable via Super Speed USB Type-C<sup>®</sup> port in the rear side of the platform.
- Reduce clutter on Mini Desktop with single cable connection for power and video through USB Type-C<sup>®</sup> enabled displays with the optional USB- Type-C<sup>®</sup> port w/ DisplayPort Alt Mode and power intake via USB Type-C<sup>®</sup> Power Delivery up to 100W; reduce desktop footprint with the DM mounted behind a USB-C<sup>™</sup> enabled display.

1. MIL-STD H testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

### NOTE: See important legal disclosures for all listed specs in their respective features sections.



### **PRODUCT NAME**

HP Pro Mini 400 G9 Desktop PC HP Pro SFF 400 G9 Desktop PC HP Pro Tower 400 G9 PCI Desktop PC HP Pro Tower 480 G9 PCI Desktop PC HP ProOne 440 23.8 inch G9 All-in-One Desktop PC

#### **OPERATING SYSTEM**

PreinstalledWindows 11 Pro1<br/>Windows 11 Pro Education1<br/>Windows 11 Home - HP recommends Windows 11 Pro for business1<br/>Windows 11 Home Single Language - HP recommends Windows 11 Pro for business1<br/>Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume<br/>Licensing Agreement)1<br/>FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees apply and additional requirements may apply over time for updates.See <a href="http://www.windows.com">http://www.windows.com</a>.

## CHIPSET

|                         | <u>Mini</u> | <u>SFF</u> | <u>TWR</u> | <u>Ai0</u> |
|-------------------------|-------------|------------|------------|------------|
| Intel <sup>®</sup> Q670 | X           | X          | X          | X          |



# PROCESSORS

| Intel® 12 <sup>th</sup> Generation Core™ Processors  | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|--|-------------|------------|-----|------------|
| Intel <sup>®</sup> Core <sup>™</sup> i7-12700 Processor <sup>1</sup><br>65W<br>2.1 GHz base frequency<br>Up to 4.9 GHz max. turbo frequency with Intel <sup>®</sup> Turbo Boost<br>Technology <sup>2</sup><br>25 MB cache, 12 cores, 20 threads<br>Intel <sup>®</sup> UHD Graphics 770<br>Supports Intel <sup>®</sup> vPro <sup>®</sup> Technology and Intel <sup>®</sup> Stable Image<br>Platform Program (SIPP) <sup>3</sup> |             | x          | x   | x          |
| Intel® Core™ i7-12700T Processor <sup>1</sup><br>35W<br>1.4 GHz base frequency<br>Up to 4.7 GHz max. turbo frequency with Intel® Turbo Boost<br>Technology 3.0 <sup>2</sup><br>25 MB cache, 12 cores, 20 threads<br>Intel® UHD Graphics 770<br>Supports Intel® vPro® Technology and Intel® Stable Image<br>Platform Program (SIPP) <sup>3</sup>  | x           |            |     | x          |
| Intel® Core™ i5-12600 Processor <sup>1</sup><br>65W<br>3.3 GHz base frequency<br>Up to 4.8 GHz max. turbo frequency with Intel® Turbo Boost<br>Technology <sup>2</sup><br>18 MB cache, 6 cores, 12 threads<br>Intel® UHD Graphics 770<br>Supports Intel® vPro® Technology and Intel® Stable Image<br>Platform Program (SIPP) <sup>3</sup>  |             | x          | x   | x          |
| Intel® Core™ i5-12600T Processor <sup>1</sup><br>35W<br>2.1 GHz base frequency<br>Up to 4.6 GHz max. turbo frequency with Single P-core turbo<br>Technology<br>18 MB cache, 6 cores, 12 threads<br>Intel® UHD Graphics 770<br>Supports Intel® vPro® Technology and Intel® Stable Image<br>Platform Program (SIPP) <sup>3</sup>   | x           |            |     | X          |



|   | <u>Mini</u> | <u>SFF</u> | TWR | AiO |
|---|-------------|------------|-----|-----|
| Intel <sup>®</sup> Core <sup>™</sup> i5-12500 Processor <sup>1</sup><br>65W<br>3.0 GHz base frequency<br>Up to 4.6 GHz max. turbo frequency with Intel <sup>®</sup> Turbo Boost<br>Technology <sup>2</sup><br>18 MB cache, 6 cores, 12 threads<br>Intel <sup>®</sup> UHD Graphics 770<br>Supports Intel <sup>®</sup> vPro <sup>®</sup> Technology and Intel <sup>®</sup> Stable Image<br>Platform Program (SIPP) <sup>3</sup> |             | x          | x   | x   |
| Intel® Core™ i5-12500T Processor <sup>1</sup><br>35W<br>2.0 GHz base frequency<br>Up to 4.4 GHz max. turbo frequency with Single P-core Turbo<br>Technology<br>18 MB cache, 6 cores, 12 threads<br>Intel® UHD Graphics 770<br>Supports Intel® vPro® Technology and Intel® Stable Image<br>Platform Program (SIPP) <sup>3</sup>  | x           |            |     | x   |
| Intel <sup>®</sup> Core <sup>™</sup> i5-12400 Processor <sup>1</sup><br>65W<br>2.5 GHz base frequency<br>Up to 4.4 GHz max. turbo frequency with Intel <sup>®</sup> Turbo Boost<br>Technology <sup>2</sup><br>18 MB cache, 6 cores, 12 threads<br>Intel <sup>®</sup> UHD Graphics 730   |             | x          | x   | x   |
| Intel® Core™ i5-12400T Processor <sup>1</sup><br>35W<br>1.8 GHz base frequency<br>Up to 4.2 GHz max. turbo frequency with Single P-core Turbo<br>Technology<br>18 MB cache, 6 cores, 12 threads<br>Intel® UHD Graphics 730  | x           |            |     | x   |
| Intel® Core™ i3-12300 Processor1<br>60W<br>3.5 GHz base frequency<br>Up to 4.4 GHz max. turbo frequency with Single P-Core<br>technology<br>12 MB cache, 4 cores, 8 threads<br>Intel® UHD Graphics 730  |             | x          | x   | x   |



|  | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|--|-------------|------------|-----|------------|
| Intel® Core™ i3-12300T Processor <sup>1</sup><br>35W<br>2.3 GHz base frequency<br>Up to 4.2 GHz max. turbo frequency with Single P-Core<br>technology<br>12 MB cache, 4 cores, 8 threads<br>Intel® UHD Graphics 730                  | x           |            |     | x          |
| Intel® Core™ i3-12100 Processor <sup>1</sup><br>60W<br>3.3 GHz base frequency<br>Up to 4.3 GHz max. turbo frequency with Intel® Turbo Boost<br>Technology <sup>2</sup><br>12 MB cache, 4 cores, 8 threads<br>Intel® UHD Graphics 730 |             | x          | x   | x          |
| Intel® Core™ i3-12100T Processor <sup>1</sup><br>35W<br>2.2 GHz base frequency<br>Up to 4.1 GHz max. turbo frequency with Single P-core<br>Technology12 MB cache, 4 cores, 8 threads<br>Intel® UHD Graphics 730                      | x           |            |     | x          |

| Intel <sup>®</sup> Pentium <sup>®</sup> Processors  | <u>Mini</u> | <u>SFF</u> | <u>TWR</u> | AiO |
|---|-------------|------------|------------|-----|
| Intel® Pentium® Gold G-7400 Processor <sup>1</sup><br>46W<br>3.7 GHz base frequency<br>6 MB cache, 2 cores, 4 threads<br>Intel® UHD Graphics 710  |             | x          | x          | x   |
| Intel® Pentium® Gold G-7400T Processor <sup>1</sup><br>35W<br>3.1 GHz base frequency<br>6 MB cache, 2 cores, 4 threads<br>Intel® UHD Graphics 710 | x           |            |            | x   |
| Intel® Celeron® 6900 Processor <sup>1</sup><br>46W<br>3.4 GHz base frequency<br>4 MB cache, 2 cores, 2 threads<br>Intel® UHD Graphics 710         |             | x          | x          | x   |
| Intel® Celeron® 6900T Processor <sup>1</sup><br>35W<br>2.8 GHz base frequency<br>4 MB cache, 2 cores, 2 threads<br>Intel® UHD Graphics 710        | x           |            |            | x   |



| Intel® 13 <sup>th</sup> Generation Core™ Processors   | <u>Mini</u> | <u>SFF</u> | <u>TWR</u> | <u>Ai0</u> |
|---|-------------|------------|------------|------------|
| Intel <sup>®</sup> Core <sup>™</sup> i7-13700 processor with Intel <sup>®</sup> UHD Graphics 770<br>(P-core Max turbo frequency up to 5.1 GHz, up to 5.2 GHz with<br>Intel <sup>®</sup> Turbo Boost Technology <sup>1</sup> , 30 MB L3 cache, 16 cores) 65W <sup>2</sup><br>Supports Intel <sup>®</sup> vPro <sup>®</sup> Technology <sup>3</sup> |             | x          | x          | x          |
| Intel <sup>®</sup> Core <sup>™</sup> i7-13700T Processor with Intel <sup>®</sup> UHD Graphics 770<br>(P-core Max turbo frequency up to 4.8 GHz, up to 4.9 GHz with<br>Intel <sup>®</sup> Turbo Boost Technology <sup>1</sup> ,30MB cache, 16 cores) 35W <sup>2.</sup><br>Supports Intel <sup>®</sup> vPro <sup>®</sup> Technology <sup>3</sup>    | x           |            |            | x          |
| Intel® Core™ i5-13600T processor with Intel® UHD Graphics 770<br>(P-core Max turbo frequency up to 4.8 GHz, 24 MB cache, 14<br>cores) 35W. Supports Intel® vPro® Technology   | x           |            |            | x          |
| Intel <sup>®</sup> Core™ i5-13500 processor with Intel <sup>®</sup> UHD Graphics 770<br>(P-core Max turbo frequency up to 4.8 GHz, 24 MB cache, 14<br>cores) 65W <sup>2.</sup><br>Supports Intel <sup>®</sup> vPro <sup>®</sup> Technology <sup>3</sup>   |             | x          | x          | x          |
| Intel <sup>®</sup> Core™ i5-13500T processor with Intel <sup>®</sup> UHD Graphics 770<br>(P-core Max turbo frequency up to 4.6 GHz, 20 MB cache, 14<br>cores) 35W <sup>2.</sup><br>Supports Intel <sup>®</sup> vPro <sup>®</sup> Technology <sup>3</sup>  | х           |            |            | x          |
| Intel® Core™ i5-13400 processor with Intel® UHD Graphics 730<br>(P-core Max turbo frequency up to 4.6 GHz, 20 MB cache, 10<br>cores) 65W <sup>2.</sup>  |             |            |            | x          |
| Intel® Core™ i3-13100 processor with Intel® UHD Graphics 730<br>(P-core Max turbo frequency up to 4.5 GHz, 12 MB cache, 4<br>cores) 65W <sup>2.</sup>   |             | x          | x          | x          |
| Intel <sup>®</sup> Core™ i3-13100T processor with Intel <sup>®</sup> UHD Graphics 730   |             |            |            |            |

| Intel® Core™ i3-13100T processor with Intel® UHD Graphics 73<br>(P-core Max turbo frequency up to 4.2 GHz, 12 MB cache, 4<br>cores) 35W <sup>2.</sup> | x |  |  | х |
|---|---|--|--|---|
|---|---|--|--|---|

 Multi-core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
 Intel® Turbo Boost technology requires a PC with a processor with Intel® Turbo Boost capability. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.
 Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro.

frequency, 6 MB L3 cache, 2 P-cores, 4 threads)

| Intel® 14 <sup>th</sup> Generation Core™ Processors  | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|--|-------------|------------|-----|------------|
| Intel <sup>®</sup> Core <sup>™</sup> i7-14700 with Intel UHD Graphics 770 (1.5 GHz E-core base<br>frequency, 2.1 GHz P-core base frequency, up to 4.2 GHz E-core Max Turbo<br>frequency, up to 5.3 GHz P-core Max Turbo frequency, 33 MB L3 cache, 8 P-<br>cores and 12 E-cores, 28 threads), supports Intel <sup>®</sup> vPro <sup>®</sup> Technology |             | x          | x   | x          |
| Intel <sup>®</sup> Core <sup>™</sup> i7-14700T with Intel UHD Graphics 770 (0.9 GHz E-core base frequency, 1.3 GHz P-core base frequency, up to 3.7 GHz E-core Max Turbo frequency, up to 5.0 GHz P-core Max Turbo frequency, 33 MB L3 cache, 8 P-cores and 12 E-cores, 28 threads), supports Intel <sup>®</sup> vPro <sup>®</sup> Technology          | X           |            |     | <u>×</u>   |
| Intel <sup>®</sup> Core <sup>™</sup> i5-14500 with Intel UHD Graphics 770 (1.9 GHz E-core base<br>frequency, 2.6 GHz P-core base frequency, up to 3.7 GHz E-core Max Turbo<br>frequency, up to 5.0 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-<br>cores and 8 E-cores, 20 threads), supports Intel <sup>®</sup> vPro <sup>®</sup> Technology  |             | x          | x   | x          |
| Intel <sup>®</sup> Core <sup>™</sup> i5-14500T with Intel UHD Graphics 770 (1.2 GHz E-core base frequency, 1.7 GHz P-core base frequency, up to 3.4 GHz E-core Max Turbo frequency, up to 4.8 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 threads), supports Intel <sup>®</sup> vPro <sup>®</sup> Technology           | х           |            |     | x          |
| Intel® Core™ i3-14100 with Intel UHD Graphics 730 (3.5 GHz P-core base frequency, up to 4.7 GHz P-core Max Turbo frequency, 12 MB L3 cache, 4 P-cores, 8 threads)  |             | x          | x   | x          |
| Intel <sup>®</sup> Core™ i3-14100T with Intel UHD Graphics 730 (2.7 GHz P-core base frequency, up to 4.4 GHz P-core Max Turbo frequency, 12 MB L3 cache, 4 P-cores, 8 threads)   | X           |            |     | x          |
| Intel® Core™ 300 with Intel UHD Graphics 710 (3.9 GHz P-core base<br>frequency, 6 MB L3 cache, 2 P-cores, 4 threads)   |             | x          | x   | X          |
| Intel <sup>®</sup> Core <sup>™</sup> 300T with Intel UHD Graphics 710 (3.4 GHz P-core base<br>frequency. 6 MB L3 cache. 2 P-cores. 4 threads)  | х           |            |     | х          |



## GRAPHICS

| Integrated Graphics   | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |  |
|---|-------------|------------|-----|------------|--|
| Intel® UHD Graphics 770 (integrated on 12 <sup>th</sup> , 13 <sup>th</sup> & 14 <sup>th</sup> gen Core i7, Core<br>i5-1x500 and Core i5-1x500T) | x           | x          | X   | X          |  |
| Intel® UHD Graphics 730 (integrated on 12 <sup>th</sup> , 13 <sup>th</sup> & 14 <sup>th</sup> gen Core i3/i5-<br>1x400, i5-1x400T)              | x           | x          | X   | X          |  |
| Intel® UHD Graphics 710 (integrated on Pentium® Gold, Celeron® and 300 series)  | х           | x          | x   | x          |  |

| otional Discrete Graphics Solutions                                       | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|---|-------------|------------|-----|------------|
| NVIDIA <sup>®</sup> GeForce <sup>®</sup> RTX 3050 8GB GDDR6 Graphics card |             |            | x   |            |
| NVIDIA® T400 4GB Graphics Card  |             | X          | X   |            |
| Intel <sup>®</sup> Arc A380 6GB GDDR6 Graphics card                       |             |            | X   |            |
| AMD Radeon™ 6300M with 2 GB GDDR6 Graphics                                |             |            |     | X          |
| AMD Radeon™ RX 6300 2GB GDDR6 Graphics card                               |             | X          | X   |            |

1. Only available with the 12<sup>th</sup> Generation processors.

| Adapters and Cables                     | <u>Mini</u> | <u>SFF</u> | <u>TWR</u> | <u>Ai0</u> |
|---|-------------|------------|------------|------------|
| HP DisplayPort™ Cable                   | X           | X          | X          | X          |
| HP DisplayPort™ to DVI-D Adapter        | X           | X          | X          | X          |
| HP DisplayPort™ to HDMI True 4K Adapter | X           | X          | X          | X          |
| HP DisplayPort™ to VGA Adapter          | X           | X          | X          | X          |
| HP USB to Serial Port Adapter           | X           | X          | X          | X          |

### STORAGE

**NOTE:** Starting from November 1<sup>st</sup>, 2023, all shipments will require Windows to be installed when selecting a SSD. HDD can only be configured as additional data drives and not as the boot drive.

| 3.5 inch SATA Hard Disk Drives (HDD) | <u>Mini</u> | <u>SFF</u> | <u>TWR</u> | <u>Ai0</u> |
|--------------------------------------|-------------|------------|------------|------------|
| 1TB* 7200RPM SATA HDD                |             | X          | X          |            |
| 2TB* 7200RPM SATA HDD                |             | X          | X          |            |
| 2.5 inch SATA Hard Disk Drives (HDD) | Mini        | <u>SFF</u> | TWR        | <u>Ai0</u> |
| 1TB* 7200RPM SATA HDD                | X           |            |            | X          |



Standard Features and Configurable Components (availability may vary by country)

| PCIe NMVe Solid State Drives (SSD)  | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|---|-------------|------------|-----|------------|
| 256GB M.2 2280 PCIe NVMe SSD  | X           | X          | X   | X          |
| 512GB M.2 2280 PCIe NVMe SSD  | Х           | X          | X   | X          |
| 1TB M.2 2280 PCIe NVMe SSD  | X           | X          | X   | X          |
| 256GB M.2 2280 PCIe NVMe Three Layer Cell SSD <sup>1</sup>                      | X           | X          | X   | Х          |
| 512GB M.2 2280 PCIe NVMe Three Layer Cell SSD                                   | X           | X          | X   | X          |
| 1TB M.2 2280 PCIe NVMe Three Layer Cell SSD                                     | X           | X          | X   | X          |
| 2TB M.2 2280 PCIe NVMe Three Layer Cell SSD                                     | X           | X          | X   | X          |
| 256GB M.2 2280 PCIe NVMe Self Encrypted OPAL2 Three Layer Cell SSD <sup>1</sup> | X           | X          | X   | X          |
| 512GB M.2 2280 PCIe NVMe Self Encrypted OPAL2 Three Layer Cell SSD              | X           | X          | X   | X          |
| 256GB M.2 2280 PCIe OPAL2 NVMe SSD  | X           | X          | X   | Х          |

**NOTE\*:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows) of system disk is reserved for the system recovery software.

**NOTE\*\*:** Storage DriveLock does not work with Self Encrypting or Optane based storage.

1. Only available with the 12<sup>th</sup> Generation processors.

| Optical Disc Drives                      | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|--|-------------|------------|-----|------------|
| HP 9.5mm Slim DVD-ROM Drive <sup>1</sup> |             | Х          | Х   | X          |
| HP 9.5mm Slim DVD Writer Drive           |             | Х          | Х   | X          |

1. HD-DVD disks cannot be played on this drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs. Discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

| Media Card Reader   | <u>Mini</u> | <u>SFF</u> | <u>twr</u> | <u>Ai0</u> |
|---|-------------|------------|------------|------------|
| SD 4.0 with 5-in-1 Interface (Supports SD, SDXC, SDHC, UHS-I, UHS-II) |             | X          | Х          |            |
| SD 3.0 with 4-in-1 Interface (Supports SD, SDXC, SDHC, UHS-I)         |             |            |            | X          |

### MEMORY

|  | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|--|-------------|------------|-----|------------|
| DDR4-3200 (Transfer rates up to 3200 MT/s), Max 64 GB, 2 SO-DIMM | X           |            |     | X          |
| DDR4-3200 (Transfer rates up to 3200 MT/s), Max 64 GB, 2 U-DIMM  |             | Х          | X   |            |
| DDR5-4800 (Transfer rates up to 4800 MT/s), Max 64 GB, 2 U-DIMM  |             | Х          | X   |            |
| DDR5-4800 (Transfer rates up to 4800 MT/s) Max 64 GB, 2 SO-DIMM  | X           |            |     | X          |
| DDR5-5600 (Transfer rates up to 5600 MT/s), Max 64 GB, 2 U-DIMM  |             | Х          | X   |            |



| lemory Configuration | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|----------------------|-------------|------------|-----|------------|
| 4GB (4GB x 1)        | X           | X          | Х   | X          |
| 8GB (4GB x 2)        | X           | X          | X   | X          |
| 8GB (8GB x 1)        | X           | X          | X   | X          |
| 16GB (8GB x 2)       | X           | X          | X   | X          |
| 16GB (16GB x 1)      | X           | X          | X   | X          |
| 32GB (16GB x 2)      | X           | X          | X   | X          |
| 32GB (32GB x 1)      | X           | X          | X   | X          |
| 64GB (32GB x 2)      | X           | X          | X   | X          |

**NOTE:** For systems configured with more than 3GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4GB requires a 64-bit operating system.

**NOTE:** Memory modules support data transfer rates up to 3200 MT/s respectively depending on memory module used; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

**NOTE:** All memory slots are customer accessible / upgradeable.

**NOTE**: Memory speed 3200 MT/s can be achieved via two UDIMMs per channel (2DPC) when populated with the same part number. **NOTE**: Memory modules support data transfer rates up to 5600/MTs requires selected i5, i7 or i9 CPUs. Memory configuration without selected

CPUs support data transfer rates up to 4800 MT/s.

### **NETWORKING/COMMUNICATIONS**

| Ethernet (RJ-45)   | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|--|-------------|------------|-----|------------|
| Intel <sup>®</sup> I219-LM 1 Gigabit Network Connection LOM (vPro <sup>®</sup> ) | X           | X          | X   | X          |
| Network Adapter Intel FoxPond1 I225-T1 2.5GbE                                    |             | X          | Х   |            |

#### Wireless

| Intel® Wi-Fi 6E <sup>2</sup> AX211 + Bluetooth® 5.3 wireless card (802.11AX 2x2 vPro®, supporting gigabit data rate <sup>3</sup> ) <sup>4.5</sup> | X | X | х | X |
|---|---|---|---|---|
| Intel® Wi-Fi 6E² AX211 + Bluetooth® 5.3 wireless card (802.11AX 2x2<br>non-vPro®, supporting gigabit data rate³) <sup>4,5</sup>                   | X | X | х | X |
| Realtek Wi-Fi 6 <sup>2</sup> RTL8852BE 802.11ax 2x2 with Bluetooth <sup>®</sup> 5.3 wireless card   | X | X | х | X |
| Realtek RTL8821CE 802.11ac <sup>5</sup> 1x1 with Bluetooth® 4.2 wireless card   | X | X | X | X |

1. Only available with Intel Core 14<sup>th</sup> Gen processors.

2. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

3. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

4.The HP 400 G9 TWR/SFF requires Intel<sup>®</sup> Core <sup>™</sup> processor with DDR5 memory modules to support Wi-Fi 6E and requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. Available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. For HP 400 G9 TWR/SFF without Intel<sup>®</sup> Core <sup>™</sup> processors and DDR5 memory modules, the product does not support Wi-Fi 6E standard and does not operate under 6GHz band. The products are compatible with 6GHz and other routers, sold separately, which have capability to operate in 2.4GHz and 5GHz, in compliance with Wi-Fi 6 and prior 802.11 specs. The actual throughput depends on network condition and router configuration. Internet service required and public wireless access points are limited.

5. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

NOTE: Usage of the 6GHz band relies on Windows 11 Operating System support.

## **KEYBOARDS AND POINTING DEVICES**

| eyboards   | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|--|-------------|------------|-----|------------|
| HP Business Slim PS/2 Wired Keyboard               |             | X          | X   |            |
| HP Wired Desktop 320K Keyboard                     | X           | X          | X   | X          |
| HP USB Business Slim Wired SmartCard CCID Keyboard | X           | X          | X   | X          |
| HP 125 Wired Keyboard                              | X           | X          | X   | X          |
| HP 125 Antimicrobial Wired Keyboard (China Only)   | X           | X          | X   | X          |

#### **Keyboard & Mouse Combo**

| HP 655 Wireless Keyboard and Mouse Combo | X | X | X | X | ĺ |
|--|---|---|---|---|---|
|--|---|---|---|---|---|



#### Mouse

| HP PS/2 Mouse                                 |   | X | X |   |
|---|---|---|---|---|
| HP Wired Desktop 320M Mouse                   | X | X | X | X |
| HP 125 Wired Mouse                            | X | X | X | X |
| HP 125 Wired Antimicrobial Mouse (China Only) | X | X | X | X |
| HP 128 Wired Laser Mouse                      | X | X | X | X |

NOTE: Availability may vary by country

### SECURITY

|   | <u>Mini</u>                                 | <u>SFF</u> | TWR | <u>Ai0</u> |
|---|---|------------|-----|------------|
| TPM 2.0 (FW: 15.21) endpoint security controller (Infineon<br>SLB9672/Nuvoton NPCT760HABYX) Common Criteria EAL4+ Certified. FIPS<br>140-2 Level 2 Certified. | х   | x          | x   | x          |
| Intrusion Sensor (Optional)   |   | X          | X   |            |
| Intrusion Sensor (integrated in the system board, can be enabled/disabled through BIOS)   | x   |            |     | x          |
| Support for chassis cable lock devices  | <b>X</b><br>(10 mm<br>barrel or<br>smaller) | x          | x   | x          |
| Support for chassis padlocks devices  | X   | X          | X   |            |
| Support for table lock  |   |            |     | X          |
| SATA port disablement (via BIOS)  | X   | X          | X   |            |
| Serial, USB enable/disable (via BIOS)   | X   | X          | X   | X          |
| Intel <sup>®</sup> Identify Protection Technology (IPT) <sup>1</sup>  | X   | X          | X   | X          |
| Removable media write/boot control  | X   | X          | X   | X          |
| Power-on password (via BIOS)  | X   | X          | X   | X          |
| Setup password (via BIOS)   | X   | X          | X   | X          |

1. Models configured with Intel<sup>®</sup> Core<sup>™</sup> processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module

### PORTS

| ternal Slots and Ports            | <u>Mini</u>  | <u>SFF</u> | <u>TWR</u>         | <u>Ai0</u>   |
|-----------------------------------|--|------------|--------------------|--|
| M.2 PCIe                          | (1) M.2 PCle x1 2230<br>(for WLAN/BT)<br>(1) M.2 PCle x4 2280<br>(for storage) | 2230 (for  | 2280 (for storage) | (1) M.2 PCIe x1<br>2230 (for WLAN)<br>(1) M.2 PCIe x4<br>2280 (for storage)<br>(1) M.2 PCIe x3<br>2280 (for storage) |
| PCI Express v4.0 x1               |  | 1          | 1                  |  |
| PCI Express v4.0 x16              |  | 1          | 1                  |  |
| PCI x1                            |  |            | 1                  |  |
| SATA port                         |  | 2          | 3                  |  |
| Integrated SATA storage connector | 1  |            |                    | 1  |

1. Optional.

**NOTE:** For Desktop Mini with M.2 Storage config, there will be no SATA drive bracket. If you plan to use or upgrade the storage with any 2.5" SATA drive, please select a DM SATA Drive Bracket (available as both factory configured and after market option). **NOTE:** PCI slots for TWR are full height and SFF are low profile.

| Bays                                   | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> |
|--|-------------|------------|-----|------------|
| 9.5mm Slim Optical Disc Drive (ODD)    |             | 1          | 1   | 11         |
| SD Card Reader <sup>1</sup> (optional) |             | 1          | 1   | 1          |
| 2.5" Internal Storage Drive            | 1           |            |     | 1          |
| 3.5" Internal Storage Drive            |             | 1          | 2   |            |

1. Must be configured at time of purchase

2. Need to be configured at the time of purchase, either SATA or the ODD can only be selected one at the same time.

| ndard User Accessible Ports                                      | <u>Mini</u>   | <u>SFF</u>  | TWR   | <u>AiO</u>   |
|--|---|---|---|--|
| Type-A Hi-Speed USB 480Mbps signaling rate port                  |   | 2 (rear)  | 2 (rear)  |  |
| Type-A SuperSpeed USB 5Gbps signaling rate port                  | 2 (rear)  | 3 (rear)  | 3 (rear)  | 2 (rear)   |
| Type-A SuperSpeed USB 10Gbps signaling rate<br>port              | 2 (front)<br>1 (rear)   | 3 (front)   | 3 (front)   | 2 (rear)<br>1 (side)   |
| Type-C <sup>®</sup> SuperSpeed USB 10Gbps signaling rate<br>port |   | 1 (front)   | 1 (front)   | 1 (side)   |
| Type-C <sup>®</sup> SuperSpeed USB 20Gbps signaling rate<br>port | 1 (front)   |   |   |  |
| Video  | 2 DisplayPort™<br>1.4a (rear)<br>1 HDMI 2.1a (rear)               | 1 DisplayPort™<br>1.4a (rear)<br>1 HDMI 1.4b<br>(rear)  | 1 DisplayPort™<br>1.4a (rear)<br>1 HDMI 1.4b (rear) | 1<br>DisplayPort™1.4a<br>1 HDMI-in (Rear)<br>1.4b                        |
| Audio  | 1 Combo Audio<br>Jack with CTIA<br>and headset<br>support (front) | 1 Combo Audio<br>Jack with CTIA &<br>OMTP and<br>headset support<br>(front)<br>1 Audio-Line-<br>in/Line out<br>(rear) | OMTP and headset                                    | 1 Combo Audio<br>Jack with CTIA<br>and OMTP<br>headset support<br>(side) |
| Network Interface  | 1 RJ45 (rear)   | 1 RJ45 (rear)   | 1 RJ45 (rear)                                       | 1 RJ45 (rear)  |

1. Upgradeable to SuperSpeed USB 10Gbps signaling rate port if configured with additional digital video port via Flex Port 1 and/or Intel® vPro®



## Rear Configurable Non-PCIe/PCI Slot User Accessible Ports

| ible Port 1, choice of one<br>ne following: | <u>Mini</u>   | <u>SFF</u>  | TWR  | <u>AiO</u>  |
|---|---|---|--|---|
| Type-A USB                                  |   | 2 Type-A SuperSpeed<br>USB 5Gbps signaling<br>rate port                       | 2 Type-A SuperSpeed USB<br>5Gbps signaling rate port<br>(rear)             |   |
| Type-C <sup>®</sup> USB                     | 1 SuperSpeed USB<br>10Gbps signaling rate<br>port w/ DisplayPort™<br>Alt Mode and power<br>intake via USB Type-C®<br>Power Delivery up to<br>100W | 1 SuperSpeed USB<br>10Gbps signaling rate<br>port w/ DisplayPort™<br>Alt Mode | 1 SuperSpeed USB 10Gbps<br>signaling rate port w/<br>DisplayPort™ Alt Mode | 1 SuperSpeed USB<br>10Gbps signaling rate<br>port w/ DisplayPort™<br>Alt Mode |
| Video                                       | 1 DisplayPort™ 1.4a <u>or</u><br>HDMI 2.1a <u>or</u> VGA  | 1 DisplayPort™ 1.4a <u>or</u><br>HDMI 2.1a <u>or</u> VGA                      | 1 DisplayPort™ 1.4a <u>or</u><br>HDMI 2.1a <u>or</u> VGA                   | 1 DisplayPort™ 1.4a<br><u>or</u><br>HDMI 2.1a or USB-C                        |
| Serial (RS-232)                             | 1 <sup>1</sup>  | 1   | 1  | 1   |

1. Sold separately or as an optional feature

| (1) Flexible Port 2, choice of one of the following: | <u>Mini</u>   | <u>SFF</u> | TWR  | <u>AiO</u> |
|--|---|------------|--|------------|
| Type-A USB   | 2 Hi-Speed USB<br>480Mbps signaling<br>rate port <sup>1</sup> |            | 1 Type-A SuperSpeed<br>USB 5Gbps signaling rate<br>port² (front) |            |
| Serial (RS-232)                                      | 1 <sup>1</sup>  |            |  |            |
| 2 <sup>nd</sup> External antenna                     | 1 <sup>1</sup>  |            |  |            |

1. Must be configured at time of purchase

2. Front flex IO – Dual USB port and SD card reader can only select one at the same time.



# USB SPECIFICATION AND MARKETING NAME MAPPING TABLE

| Marketing Name                       | Technical Terminology |
|--------------------------------------|-----------------------|
| Hi-Speed USB 480Mbps signaling rate  | USB 2.0               |
| SuperSpeed USB 5Gbps signaling rate  | USB 3.2 Gen 1         |
| SuperSpeed USB 10Gbps signaling rate | USB 3.2 Gen 2         |
| SuperSpeed USB 20Gbps signaling rate | USB 3.2 Gen 2x2       |



## SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

#### Software

HP Easy Clean<sup>1</sup> HP PC Hardware Diagnostics UEFI HP Desktop Support Utilities HP Privacy Settings HP Setup Integrated OOBE HP Support Assistant<sup>2</sup> myHP with Multicamera support (AIO&Mini)<sup>3</sup> HP Notifications HP Connection Optimizer HP Smart Support<sup>4</sup> HP Services Scan<sup>5</sup> Microsoft Office<sup>6</sup> Miro<sup>7</sup>

#### **Manageability Features**

HP Connect<sup>8</sup> HP Image Assistant (download) HP Manageability Integration Kit (download) (Win 10 Only)<sup>9</sup> HP Client Management Script Library (download) HP Patch Assistant (download)<sup>10</sup> HP Driver Packs (download) HP Cloud Recovery<sup>11</sup> HP Client Catalog (download)

#### **Security Features**

HP Wolf Security for Business<sup>12</sup> includes HP Sure Click<sup>13</sup> and HP Sure Sense<sup>14</sup> HP Sure Start<sup>15</sup> HP Tamper Lock<sup>16</sup> HP Sure Admin<sup>17</sup> Secured-Core PC (AIO&Mini)<sup>18</sup> Windows Hello Enhanced Sign-in Security (ESS) (AIO)<sup>19</sup>

#### BIOS

HP BIOSphere<sup>20</sup> HP Secure Erase<sup>21</sup> HP DriveLock & Automatic DriveLock BIOS Update via Network Absolute Persistence Module<sup>22</sup> Power-On Authentication<sup>23</sup> Microsoft 3rd Party UEFI CA Enable

1. HP Easy Clean requires Windows 10 RS3 and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.

2. HP Support Assistant is available on Windows. For more information, please visit http://www.support.hp.com/help/hp-support-assistant.
3. MyHP with Multicamera support for Mini Desktop PC will only available on 13<sup>th</sup> processor and beyond.
HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
5. HP Services Scan automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
5. HP Services Scan automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
6. Microsoft 365 sold separately and requires Internet access for activation.



## HP Pro Series 400 G9 Desktops PCs

# QuickSpecs

Standard Features and Configurable Components (availability may vary by country)

7. HP customers qualify for a 90 day trail of Miro, this offer ends September 2025. Complete terms and conditions are provided by Miro when accepting the offer.

8. HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required. 9. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

10. HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html. 11. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. Note: You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail, please refer to: https://support.hp.com/us-en/document/c05115630.

12. HP Wolf Security for Business requires Windows 10 or 11 Pro or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features.

13. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details.

14. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

15. HP Sure Start is available on select HP PCs and requires Windows 10 and higher

16. HP Tamper Lock can be Enabled/disabled by customers or IT administrator with administrator authority.

17. HP Sure Admin requires HP G8 or newer platforms, Windows 10 or higher, HP BIOS, HP Manageability Kit or KMS Service from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store 18. Secured-Core PC Enable requires an Intel® vPro®, AMD Ryzen™ Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.

19. Requires a Windows Hello webcam or fingerprint reader.

20. HP BIOSphere features may vary depending on the platform and configuration.

21. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel<sup>®</sup> Optane<sup>™</sup>.

22. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: http://www.absolute.com/about/legal/agreements/absolute.

23. Ensures that only authorized users can start up the PC or access the BIOS by requiring user authentication using a password prior to system start-up.



## UNIT ENVIRONMENT AND OPERATING CONDITIONS

**General Unit Operating Guidelines** 

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign
  matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

| Temperature Range                   | Operating: 5° to 35° C <sup>1</sup><br>Non-Operating for AiO: -20° to 60° C <sup>1</sup><br>Non-Operating for MT/SFF/DM: -30° to 60° C <sup>1</sup> |
|-------------------------------------|---|
| Relative Humidity                   | Operating: 10% to 90% (non-condensing at ambient)<br>Non-operating: 5% to 95% (non-condensing at ambient)   |
| Maximum Altitude<br>(unpressurized) | Operating: 5000m<br>Non-operating: 50000ft (15240 m)  |

1. Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.



### **ENVIRONMENTAL & INDUSTRY**

### HP Pro Mini 400 G9 Desktop PC

| Eco-Label Certifications<br>& declarations                                   | <ul> <li>labeled with one or more of these</li> <li>IT ECO declaration</li> <li>US ENERGY STAR<sup>®</sup></li> <li>US Federal Energy Manage</li> <li>EPEAT<sup>®</sup> Climate+ register<br/>status in your country.*</li> <li>TCO Certified</li> <li>China Energy Conservation</li> <li>China State Environment</li> <li>Taiwan Green Mark</li> <li>Korea Eco-label</li> <li>Japan PC Green label</li> </ul>                   | marks:<br>gement Program (FEMP)<br>ed in the United States. See http:/   |  |  |  |
|--|--|--|--|--|--|
|  | <b>NOTE*</b> : Based on US EPEAT® regis<br>varies by country. Visit http://www   |  |  |  |  |
| Sustainable Impact<br>Specifications   | <ul> <li>Ocean-bound plastic in Frame, Panel and Speaker<sup>1</sup></li> <li>40% post-consumer recycled plastic<sup>2</sup></li> <li>Low halogen<sup>3</sup></li> <li>Outside Box and corrugated cushions are 100% sustainably sourced and recyclable<sup>4</sup></li> <li>Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable<sup>5</sup></li> <li>Bulk packaging available<sup>6</sup></li> </ul> |  |  |  |  |
| System Configuration   | The configuration used for the En<br>Desktop model is based on a Typi  |  | oise Emissions data for the  |  |  |
| Energy Consumption<br>(in accordance with US<br>ENERGY STAR® test<br>method) | 115VAC, 60Hz   | 230VAC, 50Hz   | 100VAC, 60Hz   |  |  |
| Normal Operation<br>(Short idle)   | 7.23 W   | 7.31 W   | 7.07 W   |  |  |
| Normal Operation<br>(Long idle)  | 2.16 W   | 2.24 W   | 2.01 W   |  |  |
| Sleep  | 2.14 W   | 2.21 W   | 1.99 W   |  |  |
| Off  | 0.62 W   | 0.7 W  | 0.47 W   |  |  |
|  | <b>NOTE:</b> Energy efficiency data listed is<br>HP computers marked with the ENERG<br>Protection Agency (EPA) ENERGY STAL<br>STAR <sup>®</sup> certified configurations, then e<br>disk drive, a high efficiency power sup  | GY STAR® Logo are certified with the a<br>R® specifications for computers. If a m<br>energy efficiency data listed is for a ty | pplicable U.S. Environmental<br>nodel family does not offer ENERGY<br>pically configured PC featuring a hard |  |  |
| Heat Dissipation*  | 115VAC, 60Hz   | 230VAC, 50Hz   | 100VAC, 50Hz   |  |  |
| Normal Operation<br>(Short idle)   | 24.7 BTU/hr  | 25 BTU/hr  | 24.2 BTU/hr  |  |  |
| Normal Operation<br>(Long idle)  | 7.4 BTU/hr   | 7.7 BTU/hr   | 6.9 BTU/hr   |  |  |
| Sleep  | 7.3 BTU/hr   | 7.6 BTU/hr   | 6.8 BTU/hr   |  |  |
| Off  | 2.1 BTU/hr   | 2.41 BTU/hr  | 1.6 BTU/hr   |  |  |



|  | <b>NOTE:</b> Heat di<br>hour.   | ssipation is calculated based on the measur   | ed watts, assuming the   | service level is attained for one  |
|--|---|---|--|--|
| Declared Noise<br>Emissions<br>(in accordance with<br>ISO 7779 and ISO 9296) |   | Sound Power<br>(L <sub>WAd</sub> , bels)  |  | und Pressure<br>Am, decibels)  |
| Typically Configured –<br>Idle   |   | 2.9   |  | 17   |
| Fixed Disk – Random<br>writes  |   | 3.0   |  | 19   |
| Longevity and upgrading  | features and<br>• 2 SODIMM i<br>• Interchang<br>Spare parts a   | can be upgraded, possibly extending it<br>/or components contained in the produ<br>nemory slots<br>eable M.2 PCIe NVME SSD & 2.5" SATA H<br>are available throughout the warranty p | ict may include:<br>IDD  |  |
| Batteries  | Batteries use<br>Mercury grea<br>Cadmium gre  | s) in this product comply with EU Direct<br>ed in the product do not contain:<br>ater than 1ppm by weight<br>eater than 20ppm by weight<br>CR2032 (coin cell)                       | tive 2006/66/EC  |  |
| Additional Information   | <ul> <li>This product</li> <li>2011/65/EC.</li> <li>This HP product</li> <li>Directive – 2</li> <li>This product</li> <li>This product</li> <li>Plastics part</li> <li>This product</li> <li>10% ITE-der</li> <li>This product</li> </ul> | t is in compliance with the Restrictions<br>duct is designed to comply with the Wa  | oste Electrical and Ele<br>osition 65 (State of Ca<br>product are marked p<br>osumer recycled (PCR)<br>disposed of at end of | ctronic Equipment (WEEE)<br>lifornia; Safe Drinking Water<br>per ISO11469 and ISO1043.<br>plastic (by wt.); including<br>life. |
| Packaging Materials  | External:   | PAPER/Paper   |  | 562g   |
| (vary by country)  | Internal:   | PAPER/Molded Pulp   |  | 79g  |
| Material Usage   | the HP Gener<br>http://www.<br>• Asbestos<br>• Certain Azc<br>• Certain Bro<br>• Cadmium<br>• Chlorinated<br>• Chlorinated<br>• Formaldeh<br>• Halogenate<br>• Lead carbo   | minated Flame Retardants – may not b<br>I Hydrocarbons<br>I Paraffins   | substances in excess o<br>conment/pdf/gse.pdf):  |  |

|                        | Mercuric Oxide Batteries  |
|------------------------|---|
|                        | • Nickel – finishes must not be used on the external surface designed to be frequently handled or   |
|                        | carried by the user.  |
|                        | Ozone Depleting Substances  |
|                        | Polybrominated Biphenyls (PBBs)   |
|                        | Polybrominated Biphenyl Ethers (PBBEs)  |
|                        | Polybrominated Biphenyl Oxides (PBBOs)  |
|                        | Polychlorinated Biphenyl (PCB)  |
|                        | Polychlorinated Terphenyls (PCT)  |
|                        | <ul> <li>Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been<br/>valuate virus and form most and limiting.</li> </ul> |
|                        | voluntarily removed from most applications.   |
|                        | • Radioactive Substances  |
| De alta airea llas es  | Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)  |
| Packaging Usage        | HP follows these guidelines to decrease the environmental impact of product packaging:  |
|                        | <ul> <li>Design packaging materials for ease of disassembly.</li> </ul>   |
|                        | <ul> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> </ul>  |
|                        | <ul> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> </ul>  |
|                        | <ul> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> </ul>   |
|                        | • Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.   |
|                        |   |
| End-of-life Management | HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To  |
| and Recycling          | recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP   |
|                        | sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible   |
|                        | manner.   |
|                        | The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for  |
|                        | each product type for use by treatment facilities. This information (product disassembly  |
|                        | instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These   |
|                        | instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM   |
|                        | customers who integrate and re-sell HP equipment.   |
|                        | Global Citizenship Report   |
|                        | http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html  |
|                        | Eco-label certifications  |
|                        | http://www8.hp.com/us/en/hp-information/environment/ecolabels.html  |
|                        | ISO 14001 certificates:   |
|                        | http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_   |
|                        | Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf   |
| Footnotes              | 1. Percentage of ocean-bound plastic contained in each component varies by product.   |
|                        | 2. Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.   |
|                        | 3. External power supplies, WWAN modules, power cords, cables and peripherals excluded.   |
|                        | 4. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled  |
|                        | fibers.   |
|                        | 5. Fiber cushions made from 100% recycled wood fiber and organic materials.   |
|                        | 6. Plastic cushions are made from >90% recycled plastic.  |

#### HP Pro SFF 400 G9 Desktop PC

| HP Pro SFF 400 G9 Desk   |  | he are seen of heine contified to the  | fellowing approvale and may be                     |  |  |  |
|--------------------------|--|--|--|--|--|--|
| Eco-Label Certifications | e following approvals and may be   |  |  |  |  |  |
| & declarations           | labeled with one or more of these  | marks:   |  |  |  |  |
|                          |  | IT ECO declaration   |  |  |  |  |
|                          | US ENERGY STAR <sup>®</sup>  |  |  |  |  |  |
|                          | US Federal Energy Manag  | jement Program (FEMP)  |  |  |  |  |
|                          | EPEA <sup>®</sup> Climate+ registere   | d in the United States. See http://v   | www.epeat.net for registration                     |  |  |  |
|                          | status in your country.*   |  |  |  |  |  |
|                          | TCO Certified  |  |  |  |  |  |
|                          | China Energy Conservatio   | n Program (CECP)   |  |  |  |  |
|                          |  | al Protection Administration (SEPA   | .)   |  |  |  |
|                          | Taiwan Green Mark  |  | .)   |  |  |  |
|                          |  |  |  |  |  |  |
|                          | Korea Eco-label  |  |  |  |  |  |
|                          | Japan PC Green label   |  |  |  |  |  |
|                          | Commission Regulation (B   | EC) No 617/2013 (ErP Lot 3)  |  |  |  |  |
|                          | NOTE*: Based on US EPEAT® regist   | tration according to IEEE 1680.1-2   | 018 EPEAT <sup>®</sup> . EPEAT <sup>®</sup> status |  |  |  |
|                          | varies by country. Visit http://www  | v.epeat.net for more information.  |  |  |  |  |
| Sustainable Impact       | Ocean-bound plastic in Sp  |  |  |  |  |  |
| Specifications           | <ul> <li>50% post-consumer recycle</li> </ul>                                      | cled plastic   |  |  |  |  |
|                          | Low halogen  |  |  |  |  |  |
|                          | -  | ed cushions are 100% sustainably   | sourced and recyclable                             |  |  |  |
|                          |  | on inside box is 100% sustainably s  |  |  |  |  |
|                          | Bulk packaging available   |  |  |  |  |  |
|                          | Bulk packaging available   |  |  |  |  |  |
| System Configuration     | The configuration used for the Ene   |  | pise Emissions data for the                        |  |  |  |
|                          | Desktop model is based on a Typic  | ally Configured Desktop.   |  |  |  |  |
| Energy Consumption       |  |  |  |  |  |  |
| (in accordance with US   | 115VAC, 60Hz   | 230VAC, 50Hz   | 100VAC, 60Hz                                       |  |  |  |
| ENERGY STAR® test        |  | ,  | ,  |  |  |  |
| method)                  |  |  |  |  |  |  |
| Normal Operation         | 12.12 W  | 12.15 W  | 12.10 W  |  |  |  |
| (Short idle)             | 12.12 W  | 12.15 W  | 12:10 W  |  |  |  |
| Normal Operation         |  |  |  |  |  |  |
| (Long idle)              | 10.38 W  | 10.41 W  | 10.35 W  |  |  |  |
| Sleep                    | 0.94 W   | 0.94 W   | 0.94 W   |  |  |  |
| Off                      | 0.78 W   | 0.78 W   | 0.78 W   |  |  |  |
|                          |  |  |  |  |  |  |
|                          | NOTE: Energy efficiency data listed is   |  |  |  |  |  |
|                          | HP computers marked with the ENERG   |  |  |  |  |  |
|                          | Protection Agency (EPA) ENERGY STAR  |  |  |  |  |  |
|                          | STAR <sup>®</sup> certified configurations, then end disk drive, a high efficiency | STAR® certified configurations, then energy efficiency data listed is for a typically configured PC featuring a hard |  |  |  |  |
|                          |  |  |  |  |  |  |
|                          | , and a Microsoft Windows® operating   | system.  |  |  |  |  |
| Heat Dissipation*        | 115VAC, 60Hz   | 230VAC, 50Hz   | 100VAC, 60Hz                                       |  |  |  |
| Normal Operation         |  |  |  |  |  |  |
| (Short idle)             | 41.34 BTU/hr   | 41.42 BTU/hr   | 41.26 BTU/hr                                       |  |  |  |
| Normal Operation         | +  |  |  |  |  |  |
| (Long idle)              | 35.40 BTU/hr   | 35.50 BTU/hr   | 35.28 BTU/hr                                       |  |  |  |
|                          | 3.21 BTU/hr  | 3.20 BTU/hr  | 3.21 BTU/hr  |  |  |  |
|                          |  | 3 ZU B U / Dr  |  |  |  |  |
| Sleep<br>Off             | 2.65 BTU/hr  | 2.64 BTU/hr  | 2.64 BTU/hr  |  |  |  |



**NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

| Declared Noise<br>Emissions<br>(in accordance with<br>ISO 7779 and ISO 9296) |  | Sound Power<br>(L <sub>WAd</sub> , bels)  | Sound Pressure<br>(L <sub>pAm</sub> , decibels)  |  |  |  |
|--|--|---|--|--|--|--|
| Typically Configured –<br>Idle   |  | 3.3   | 23   |  |  |  |
| Fixed Disk – Random<br>writes  |  | 4.6   | 36   |  |  |  |
| Optical Drive sequential<br>reads  |  | 3.2   | 23   |  |  |  |
| Longevity and Upgrading  | features and<br>• 2 DIMM me<br>• Interchang  | /or components contained in the produ<br>mory slots<br>eable M.2 PCIe NVME SSD & 2.5"/3.5" SA   | -  |  |  |  |
| Batteries  | This battery<br>Batteries use<br>Mercury grea<br>Cadmium gre   | production.<br>This battery(s) in this product comply with EU Directive 2006/66/EC<br>Batteries used in the product do not contain:<br>Mercury greater than 1ppm by weight<br>Cadmium greater than 20ppm by weight<br>Battery size: CR2032 (coin cell)  |  |  |  |  |
| Additional Information   | This produce     2011/65/EC.     This HP pro     Directive – 2     This produce     and Toxic En     Plastics pare     This produce     10% ITE-der     This produce | tt is in compliance with the Restrictions<br>duct is designed to comply with the Wa<br>002/96/EC.<br>It is in compliance with California Propo<br>forcement Act of 1986).<br>Its weighing over 25 grams used in the p<br>tt contains a minimum of 35% post-con<br>ived post-consumer recycled plastic.*<br>It is 92.1% recycle-able when properly o | of Hazardous Substances (RoHS) directive –<br>ste Electrical and Electronic Equipment (WEEE)<br>sition 65 (State of California; Safe Drinking Wat<br>product are marked per ISO11469 and ISO1043.<br>sumer recycled (PCR) plastic (by wt.); including<br>disposed of at end of life. |  |  |  |
| Packaging Materials  | External:  | PAPER/Corrugated  | 1104 g   |  |  |  |
| (vary by country)  | Internal:  | PAPER/Molded pulp<br>PLASTIC/Polyethylene low density   | 462 g<br>26 g  |  |  |  |
| Material Usage   | the HP Gener<br>http://www.<br>• Asbestos<br>• Certain Azo<br>• Certain Bro<br>• Cadmium   | does not contain any of the following s<br>ral Specification for the Environment at<br>hp.com/hpinfo/globalcitizenship/enviro<br>Colorants<br>minated Flame Retardants – may not be<br>Hydrocarbons<br>Paraffins  | ubstances in excess of regulatory limits (refer t<br>nment/pdf/gse.pdf):   |  |  |  |



|                        | • Halogenated Diphenyl Methanes   |
|------------------------|---|
|                        | Lead carbonates and sulfates  |
|                        | Lead and Lead compounds   |
|                        | Mercuric Oxide Batteries  |
|                        | <ul> <li>Nickel – finishes must not be used on the external surface designed to be frequently handled or</li> </ul> |
|                        | carried by the user.  |
|                        | • Ozone Depleting Substances  |
|                        | Polybrominated Biphenyls (PBBs)   |
|                        | Polybrominated Biphenyl Ethers (PBBEs)  |
|                        | Polybrominated Biphenyl Oxides (PBBOs)  |
|                        | Polychlorinated Biphenyl (PCB)  |
|                        | • Polychlorinated Terphenyls (PCT)  |
|                        | • Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been                     |
|                        | voluntarily removed from most applications.   |
|                        | Radioactive Substances  |
|                        | Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)  |
| Packaging Usage        | HP follows these guidelines to decrease the environmental impact of product packaging:                              |
|                        |   |
|                        | • Design packaging materials for ease of disassembly.   |
|                        | • Maximize the use of post-consumer recycled content materials in packaging materials.                              |
|                        | <ul> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> </ul>              |
|                        | <ul> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> </ul>                   |
|                        | • Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.                             |
| End-of-life Management | HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To                    |
| and Recycling          | recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP                   |
|                        | sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible                   |
|                        | manner.   |
|                        |   |
|                        | The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for                      |
|                        | each product type for use by treatment facilities. This information (product disassembly                            |
|                        | instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These                   |
|                        | instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM                         |
|                        | customers who integrate and re-sell HP equipment.   |
| HP Inc. Corporate      | For more information about HP's commitment to the environment:  |
| Environmental          |   |
| Information            | Global Citizenship Report   |
|                        | http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html  |
|                        | Eco-label certifications  |
|                        | http://www8.hp.com/us/en/hp-information/environment/ecolabels.html  |
|                        | ISO 14001 certificates:   |
|                        | http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_                           |
|                        | Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf                             |



### HP Pro Tower 400/480 G9 PCI Desktop PC

|  | <ul> <li>This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: <ul> <li>IT ECO declaration</li> <li>US ENERGY STAR<sup>®</sup></li> <li>US Federal Energy Management Program (FEMP)</li> <li>EPEAT<sup>®</sup> Climate+ registered in the United States. See http://www.epeat.net for registration status in your country.*</li> <li>TCO Certified</li> <li>China Energy Conservation Program (CECP)</li> <li>China State Environmental Protection Administration (SEPA)</li> <li>Taiwan Green Mark</li> <li>Korea Eco-label</li> <li>Japan PC Green label</li> <li>Commission Regulation (EC) No 617/2013 (ErP Lot 3)</li> </ul> </li> <li>NOTE*: *Based on US EPEAT<sup>®</sup> registration according to IEEE 1680.1-2018 EPEAT<sup>®</sup>. EPEAT<sup>®</sup> status varies by country. Visit http://www.epeat.net for more information.</li> </ul> |              |              |  |
|--|--|--------------|--------------|--|
|  |  |              |              |  |
| Sustainable Impact<br>Specifications   | <ul> <li>Ocean-bound plastic in Speaker and Fan</li> <li>60% post-consumer recycled plastic</li> <li>Low halogen</li> <li>Outside Box and corrugated cushions are 100% sustainably sourced and recyclable</li> <li>Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable</li> <li>Bulk packaging available</li> </ul>  |              |              |  |
| System Configuration   | The configuration used for the Energy Consumption and Declared Noise Emissions data for the Desktop model is based on a Typically Configured Desktop.  |              |              |  |
| Energy Consumption<br>(in accordance with US<br>ENERGY STAR® test<br>method) | 115VAC, 60Hz   | 230VAC, 50Hz | 100VAC, 60Hz |  |
| Normal Operation<br>(Short idle)   | 12.69 W  | 12.69 W      | 12.69 W      |  |
| Normal Operation<br>(Long idle)  | 10.95 W  | 10.97 W      | 10.95 W      |  |
| Sleep  | 0.99 W   | 0.99 W       | 0.98 W       |  |
| Off  | 0.80 W   | 0.80 W       | 0.80 W       |  |
|  | <b>NOTE:</b> Energy efficiency data listed is for an ENERGY STAR® certified product if offered within the model family.<br>HP computers marked with the ENERGY STAR® Logo are certified with the applicable U.S. Environmental<br>Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY<br>STAR® certified configurations, then energy efficiency data listed is for a typically configured PC featuring a hard<br>disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.   |              |              |  |
| Heat Dissipation*  | 115VAC, 60Hz   | 230VAC, 50Hz | 100VAC, 60Hz |  |
| Normal Operation<br>(Short idle)   | 43.27 BTU/hr   | 43.28 BTU/hr | 43.26 BTU/hr |  |
| Normal Operation<br>(Long idle)  | 37.35 BTU/hr   | 37.40 BTU/hr | 37.34 BTU/hr |  |
| Sleep  | 3.36 BTU/hr  | 3.37 BTU/hr  | 3.35 BTU/hr  |  |
| Off  | 2.72 BTU/hr  | 2.72 BTU/hr  | 2.71 BTU/hr  |  |



| Declared Noise                      |   |   |                           |                               |  |
|-------------------------------------|---|---|---------------------------|-------------------------------|--|
| Emissions                           | Sound Power   |   | S                         | Sound Pressure                |  |
| (in accordance with                 |   | (L <sub>wAd</sub> , bels)                                     |                           | L <sub>pAm</sub> , decibels)  |  |
| ISO 7779 and ISO 9296)              |   |   |                           | Epain, decibets)              |  |
| Typically Configured –              | 3.1   |   |                           | 21                            |  |
| Idle                                |   | 5.1   |                           | 21                            |  |
| Fixed Disk – Random                 |   | 3.2   |                           | 22                            |  |
| writes                              |   | 5.2   |                           |                               |  |
| Optical Drive - Sequential<br>reads |   | 4.0   |                           | 28                            |  |
| Longevity and Upgrading             | This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:<br>• 2 DIMM memory slots<br>• Interchangeable M.2 PCIe NVME SSD & 2.5"/3.5" SATA HDD  |   |                           |                               |  |
|                                     | Spare parts a production.   | are available throughout the warr                             | anty period and or for up | to "5" years after the end of |  |
| Batteries                           | This battery  | (s) in this product complies with E                           | J Directive 2006/66/EC    |                               |  |
|                                     | Pattorios us  | ad in the product do not contain:                             |                           |                               |  |
|                                     |   | ed in the product do not contain:<br>ater than 1ppm by weight |                           |                               |  |
|                                     |   | eater than 20ppm by weight                                    |                           |                               |  |
|                                     | J   |   |                           |                               |  |
|                                     | Battery size: CR2032 (coin cell)<br>Battery type: Lithium<br>• This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -   |   |                           |                               |  |
| Additional Information              |   |   |                           |                               |  |
|                                     | <ul> <li>2011/65/EC.</li> <li>This HP product is designed to complies with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <sup>®</sup> Climate+ level, see http://www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per IS011469 and IS01043.</li> <li>This product contains 44.4% post-consumer recycled plastic (by wt.)</li> <li>This product is 92.1% recycle-able when properly disposed of at end of life.</li> </ul> |   |                           |                               |  |
| Packaging Materials                 | External:   | PAPER/Corrugated  |                           | 1110 g                        |  |
| (vary by country)                   |   | PAPER/Molded Pulp   |                           | 654 g                         |  |
|                                     | Internal:   | PLASTIC/Polyethylene low den                                  |                           | 32 g                          |  |
| Material Usage                      | This product does not contain any of the following substances in excess of regulatory limits (refer to<br>the HP General Specification for the Environment at<br>http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):<br>• Asbestos<br>• Certain Azo Colorants<br>• Certain Brominated Flame Retardants – may not be used as flame retardants in plastics<br>• Cadmium<br>• Chlorinated Hydrocarbons<br>• Chlorinated Paraffins<br>• Formaldehyde<br>• Halogenated Diphenyl Methanes<br>• Lead carbonates and sulfates  |   |                           |                               |  |
|                                     | Lead and Lead compounds     Mercuric Oxide Batteries  |   |                           |                               |  |
|                                     |   |   |                           |                               |  |



|   | • Nickel – finishes must not be used on the external surface designed to be frequently handled or   |
|---|---|
|   | carried by the user.  |
|   | Ozone Depleting Substances  |
|   | Polybrominated Biphenyls (PBBs)   |
|   | Polybrominated Biphenyl Ethers (PBBEs)  |
|   | Polybrominated Biphenyl Oxides (PBBOs)  |
|   | Polychlorinated Biphenyl (PCB)  |
|   | Polychlorinated Terphenyls (PCT)  |
|   | • Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been   |
|   | voluntarily removed from most applications.   |
|   | Radioactive Substances  |
|   | • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)  |
| Packaging Usage                         | HP follows these guidelines to decrease the environmental impact of product packaging:  |
|   | • Design packaging materials for ease of disassembly.   |
|   | • Maximize the use of post-consumer recycled content materials in packaging materials.  |
|   | • Use readily recyclable packaging materials such as paper and corrugated materials.  |
|   | Reduce size and weight of packages to improve transportation fuel efficiency.   |
|   |   |
| End of life Management                  | <ul> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> <li>HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To</li> </ul> |
| End-of-life Management<br>and Recycling | recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP   |
| and Recycling                           | sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible   |
|   | manner.   |
|   |   |
|   | The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for  |
|   | each product type for use by treatment facilities. This information (product disassembly  |
|   | instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These   |
|   | instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM   |
|   | customers who integrate and re-sell HP equipment.   |
| HP Inc. Corporate                       | For more information about HP's commitment to the environment:  |
| Environmental                           |   |
| Information                             | Global Citizenship Report   |
|   | http://www.hp.com/hpinfo/qlobalcitizenship/gcreport/index.html  |
|   | Eco-label certifications  |
|   | http://www8.hp.com/us/en/hp-information/environment/ecolabels.html  |
|   | ISO 14001 certificates:   |
|   | http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_   |
|   | Certificate.pdf   |
|   | and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf   |
|   |   |

## HP ProOne 440 23.8 inch G9 All-in-One Desktop PC

| Eco-Label Certifications<br>& declarations<br>Sustainable Impact<br>Specifications | in your country.<br>TCO Certified<br>China Energy Conservation P  | ent Program (FEMP)<br>in the United States. See http://www<br>rogram (CECP)<br>rotection Administration (SEPA)<br>No 617/2013 (ErP Lot 3) | wing approvals and may be labeled<br>w.epeat.net for registration status                                      |
|--|---|---|---|
|  | <ul> <li>Low halogen</li> <li>Outside Box and corrugated of Recycled Plastic cushions</li> </ul>  | cushions are 100% sustainably sourc   | ced and recyclable  |
| System Configuration   | The configuration used for the Energy<br>based on a "Typically Configured Deskt   |   | iissions data for the Desktop model is  |
| Energy Consumption<br>(in accordance with US<br>ENERGY STAR® test<br>method)       | 115VAC, 60Hz  | 230VAC, 50Hz  | 100VAC, 60Hz  |
| Normal Operation<br>(Short idle)   | 16.13 W   | 16.47 W   | 16.25 W   |
| Normal Operation<br>(Long idle)  | 4.60 W  | 4.73 W  | 4.87 W  |
| Sleep  | 1.75 W  | 1.76 W  | 1.73 W  |
| Off  | 0.67 W  | 0.62 W  | 0.62 W  |
|  | <b>NOTE:</b> Energy efficiency data listed is f<br>HP computers marked with the ENERG<br>Protection Agency (EPA) ENERGY STAR<br>STAR® certified configurations, then er<br>disk drive, a high efficiency power supp | Y STAR® Logo are certified with the a<br>® specifications for computers. If a n<br>hergy efficiency data listed is for a ty               | applicable U.S. Environmental<br>nodel family does not offer ENERGY<br>pically configured PC featuring a hard |
| Heat Dissipation*  | 115VAC, 60Hz  | 230VAC, 50Hz  | 100VAC, 60Hz  |
| Normal Operation<br>(Short idle)   | 55 BTU/hr   | 56 BTU/hr   | 55 BTU/hr   |
| Normal Operation<br>(Long idle)  | 15 BTU/hr   | 16 BTU/hr   | 17 BTU/hr   |
| Sleep  | 6 BTU/hr  | 6 BTU/hr  | 6 BTU/hr  |
| Off  | 2 BTU/hr<br>NOTE: Heat dissipation is calculated ba<br>hour.  | 2 BTU/hr<br>ased on the measured watts, assumi  | 2 BTU/hr<br>ng the service level is attained for one  |
| Declared Noise<br>Emissions  | Sound Power<br>(L <sub>WAd</sub> , bels)  |   | Sound Pressure<br>(L <sub>pAm</sub> , decibels)   |



| (in accordance with<br>ISO 7779 and ISO 9296)  |   |   |                             |                               |
|--|---|---|-----------------------------|-------------------------------|
| Typically Configured –<br>Idle   |   | 2.6   |                             | 15                            |
| Fixed Disk – Random<br>writes  |   | 2.6   |                             | 16                            |
| Optical Drive – Sequential reads   |   | 4.7   |                             | 35                            |
| Longevity and Upgrading  | This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:<br>• 2 SODIMM memory slots  |   |                             | ral years. Upgradeable        |
|  | Spare parts a production.   | are available throughout the wa   | rranty period and or for up | to "5" years after the end of |
| Batteries  | This battery(   | s) in this product comply with El   | J Directive 2006/66/EC      |                               |
|  | Mercury grea  | ed in the product do not contain:<br>ater than 1ppm by weight<br>eater than 20ppm by weight |                             |                               |
|  | Battery size:<br>Battery type   | CR2032 (coin cell)<br>: Lithium   |                             |                               |
| Additional Information   | <ul> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard, see http://www.epeat.net.</li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>This product contains a minimum of 50% post-consumer recycled (PCR) plastic (by wt.); including 10% ITE-derived post-consumer recycled plastic.*</li> <li>This product is 95.9% recycle-able when properly disposed of at end of life.</li> </ul> |   |                             |                               |
| Packaging Materials  | External:   | PAPER/Corrugated  |                             | 2072 g                        |
| (vary by country)  | EALCHIGL.   | Paper/Paperboard  |                             | 1040 g                        |
| (in the second sec | Internal:   | PLASTIC/EPE (Expanded Poly  | ethvlene)                   | 182 g                         |
|  |   | PLASTIC/Polyethylene low de   |                             | 45 g                          |
|  | The plastic packaging material contains at least 0.0% recycled content.   |   |                             |                               |
|  |   |   | -                           |                               |
| Material Usage   | The corrugated paper packaging materials contains at least 90.0% recycled content.This product does not contain any of the following substances in excess of regulatory limits (refer to<br>the HP General Specification for the Environment at   |   |                             |                               |
|  | http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf): <ul> <li>Asbestos</li> <li>Certain Azo Colorants</li> <li>Certain Brominated Flame Retardants – may not be used as flame retardants in plastics</li> <li>Cadmium</li> <li>Chlorinated Hydrocarbons</li> <li>Chlorinated Paraffins</li> <li>Formaldehyde</li> </ul>   |   |                             |                               |
|  |   |   |                             |                               |
| Halogenated Diphenyl Methanes  |   |   |                             |                               |

Standard Features and Configurable Components (availability may vary by country)

|   | -  |
|---|--|
|   | <ul> <li>Lead carbonates and sulfates</li> <li>Lead and Lead compounds</li> <li>Mercuric Oxide Batteries</li> <li>Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.</li> <li>Ozone Depleting Substances</li> <li>Polybrominated Biphenyls (PBBs)</li> <li>Polybrominated Biphenyl Ethers (PBBEs)</li> <li>Polybrominated Biphenyl Oxides (PBBOs)</li> <li>Polychlorinated Biphenyl (PCB)</li> <li>Polychlorinated Terphenyls (PCT)</li> <li>Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.</li> <li>Radioactive Substances</li> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul>  |
| Packaging Usage                         | <ul> <li>HP follows these guidelines to decrease the environmental impact of product packaging:</li> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>  |
| End-of-life Management<br>and Recycling | HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.<br>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP 0EM customers who integrate and re-sell HP equipment.<br>Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html<br>Eco-label certifications http://www.hp.com/us/en/hp-information/environment/ecolabels.html<br>ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf |
| footnotes                               | <ul> <li>Percentage of ocean-bound plastic contained in each component varies by product</li> <li>Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.</li> <li>External power supplies, WWAN modules, power cords, cables and peripherals excluded.</li> <li>100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.</li> <li>Plastic cushions are made from &gt;90% recycled plastic.</li> </ul>   |



## **SERVICE AND SUPPORT**

On-site Warranty<sup>1</sup>: One-year (1-1-1) limited warranty delivers one year of on-site, next business day<sup>2</sup> service for parts and labor support. Service offers terms up to 5 years by choosing an optional HP Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: http://www.hp.com/go/cpc.<sup>3</sup>

Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.
 On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
 Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications - Processors

## PROCESSORS

#### 12<sup>th</sup> /13<sup>th</sup>/14<sup>th</sup> Generation Intel® Core™ Processors<sup>1</sup>

All HP ProDesk & ProOne 400 Business PC models featuring this technology include processors that are part of the Intel<sup>®</sup> Stable Image Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP ProDesk and ProOne 400 Business PC.

Intel<sup>®</sup> Advanced Management Technology (AMT)<sup>1</sup> v16 – An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 16 includes the following advanced management functions:

- Support for configuration of Intel<sup>®</sup> AMT 16.0 capabilities
- No reset after provisioning
- Support for Intel<sup>®</sup> Enterprise Digital Fence
- The Platform Discovery Utility can now discover these additional Intel<sup>®</sup> products:
  - Intel<sup>®</sup> Identity Protection Technology with One Time Password
  - Public Key Infrastructure
  - Multi Factor Authentication
- Profile Editor and Profile Editor Plugin Interface
- Required Permissions for Solutions Framework

1. Intel<sup>®</sup> Active Management Technology requires an Intel<sup>®</sup> AMT-enabled chipset, network hardware and software, as well as connection with a power source and a corporate network connection. Setup requires configuration by the purchaser and may require scripting with the management console or further integration into existing security frameworks to enable certain functionality. It may also require modifications of implementation of new business processes.



## Technical Specifications - Display Panel Specifications

### **DISPLAY PANEL SPECIFICATIONS**

**NOTE:** All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

#### HP ProOne 440 23.8 inch G9 All-in-One Desktop PC

#### 23.8" diagonal IPS widescreen WLED backlit anti-glare LCD (1920 x 1080) Projected Capacitive Touch supports up to 10 touch-points Support HW low blue light feature

| Sepperture to the traction of the second |   |
|--|---|
| Туре                                     | IPS WLED Backlit LCD                              |
| Active area (mm)                         | 527.04 x 296.46                                   |
| Native Resolution (HxV)                  | 1920 x 1080                                       |
| Refresh Rate                             | 60 Hz @ 1920 x 1080                               |
| Aspect ratio                             | 16:9  |
| Pixel pitch (HxV)(mm)                    | 0.2745 x 0.2745                                   |
| Contrast ratio                           | 1000:1  |
| Brightness*                              | 300nits*  |
| Viewing angle (HxV)                      | 178° x 178°                                       |
| Backlight lamp life (to half brightness) | 30,000 hours minimum                              |
| Color support                            | Up to 16.7 million colors with 8 Bit(6 Bit + FRC) |
| Color gamut                              | sRGB 99%  |
| Anti-glare                               | Yes   |
| Response Time                            | 14ms  |
| Default color temperature                | Warm (6500K)                                      |

\*Actual brightness will be lower with touchscreen

# 23.8" diagonal IPS widescreen WLED backlit anti-glare LCD (1920 x 1080) non-touch

| Support HW low blue light feature        |   |
|--|---|
| Туре                                     | IPS WLED Backlit LCD                              |
| Active area (mm)                         | 527.04 x 296.46                                   |
| Native Resolution (HxV)                  | 1920 x 1080                                       |
| Refresh Rate                             | 60 Hz @ 1920 x 1080                               |
| Aspect ratio                             | 16:9  |
| Pixel pitch (HxV)(mm)                    | 0.2745 x 0.2745                                   |
| Contrast ratio                           | 1000:1  |
| Brightness*                              | 250nits*  |
| Viewing angle (HxV)                      | 178° x 178°                                       |
| Backlight lamp life (to half brightness) | 30,000 hours minimum                              |
| Color support                            | Up to 16.7 million colors with 8 Bit(6 Bit + FRC) |
| Color gamut                              | NTSC 72%  |
| Anti-glare                               | Yes   |
| Response Time                            | 14ms  |
| Default color temperature                | Warm (6500K)                                      |
|  |   |

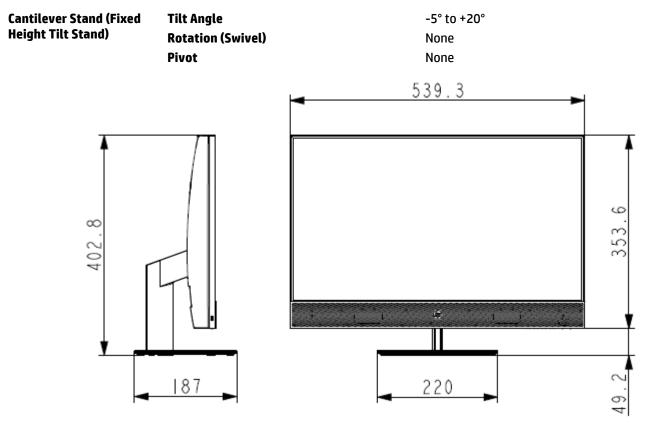
\*Actual brightness will be lower with touchscreen



Technical Specifications - All-in-One Stand Specifications

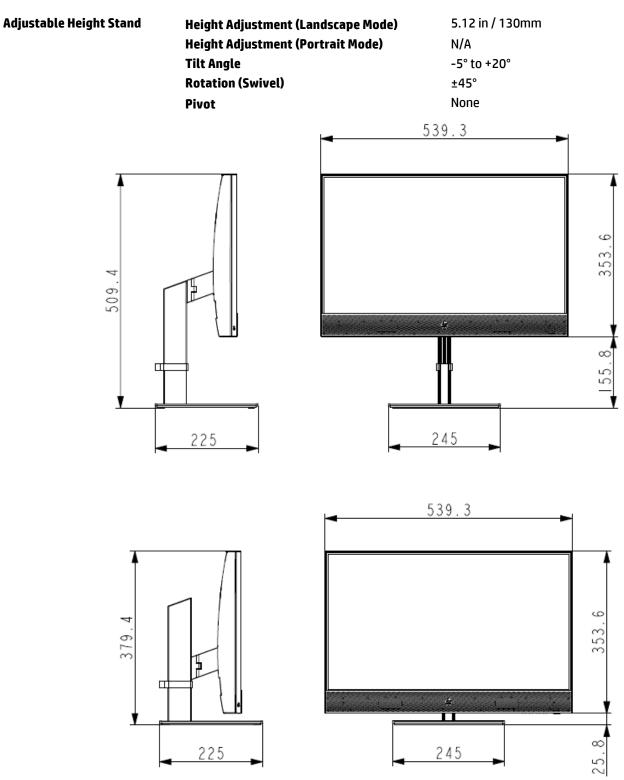
## **ALL-IN-ONE STAND SPECIFICATIONS**

### HP ProOne 440 23.8 inch G9 All-in-One Desktop PC



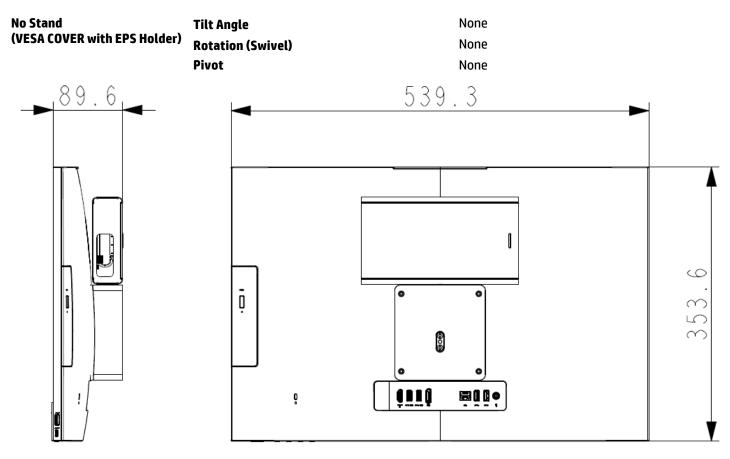


## Technical Specifications - All-in-One Stand Specifications





## Technical Specifications - All-in-One Stand Specifications



Technical Specifications – Graphics

## GRAPHICS

| HP Pro Mini 400 G9 Desktop PC                         |   |
|---|---|
| Intel® UHD Graphics (integrate<br>Graphics Controller | Integrated  |
| DisplayPort™  | Multimode capable; supports HDCP, Display Port Audio , HBR2 link rates and Multi-Stream<br>Technology for a maximum of 3 displays connected to any output controlled by Intel®<br>Graphics  |
| HDMI (on board/optional)                              | Supports HDMI 2.1 features<br>Supports HDCP 2.3<br>Supports audio over HDMI   |
| VGA (optional)  | VGA output  |
| USB-C <sup>®</sup> DP Alt Mode(optional)              | DisplayPort™ over the USB-C <sup>®</sup> module   |
| Memory  | The actual amount of maximum graphics memory can be >4GB. System memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use. |
| Maximum Color Depth                                   | up to 16 bits/color   |
| Graphics/Video API Support                            | HEVC 10b Enc/12b Dec HW<br>VP9 12b Dec HW<br>HDR<br>Rec. 2020<br>DX12   |
| Max. Resolution (HDMI)                                | 4096 x 2160@60Hz  |
| Max. Resolution (DP)                                  | 4096 x 2304@60Hz  |
| Max Resolution (optional VGA)                         | 2048 x 1536@60Hz  |
| Max Resolution (optional DP)                          | 5120 x 2160@60Hz  |
| Max Resolution (optional HDMI)                        | 3840 x 2160@60Hz  |

# Technical Specifications – Graphics

| HP Pro SFF 400 G9 Desktop PC                |   |
|---|---|
| Intel <sup>®</sup> HD Graphics (integrated) |   |
| VGA Controller                              | Integrated  |
| DisplayPort™                                | Multimode capable; supports HDCP, Display Port Audio, Onboard support HBR2 link<br>rates/option DP support to HBR3 and Multi-Stream Technology for a maximum of 3 displays<br>connected to any output controlled by Intel® Graphics     |
| HDMI (onboard / optional)                   | Supports HDMI 2.1 features (onboard HDMI support HDMI1.4; Option HDMI support HDMI 2.1)<br>Supports HDCP 2.3 (Support HDCP 1.4/2.3)<br>Supports audio over HDMI   |
| VGA (optional)                              | VGA output  |
| USB-C <sup>®</sup> DP Alt Mode (optional)   | DisplayPort™ over the optional USB-C <sup>®</sup> module (Support DP1.4 HBR2)   |
| Memory                                      | The actual amount of maximum graphics memory can be >4GB. System memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use. |
| Maximum Color Depth                         | up to 16 bits/color   |
| Graphics/Video API Support                  | HEVC 10b Enc/12b Dec HW   |
|   | VP9 12b Dec HW à AV1 decode support 8/10b, 4:2:0  |
|   | HDR   |
|   | Rec. 2020   |
|   | DX12  |
| Max. Resolution (VGA Option)                | 2048 x 1536@60Hz  |
| Max. Resolution (Onboard HDMI)              | 1920 x 1080@60Hz  |
| Max. Resolution (Option HDMI)               | 3840 x 2160@60Hz  |
| Max. Resolution (On board DP)               | HBR2: 4096 x 2304@60hz 24 bpp   |
| Max. Resolution (Option DP)                 | HBR3: 5120 x3200 @60hz 24 bpp   |
| Max. Resolution (Option Type C)             | DP HBR2: 4096 x2304 @60hz 24bpp   |
|   |   |
| NVIDIA® Quadro T400 2GB Grap                |   |
| Engine Clock                                | 2100 MHz  |

| Engine Clock                  | 2100 MHz  |
|-------------------------------|---|
| Memory Clock                  | 5001 MHz  |
| Memory Size (width)           | 2GB (64-bit)  |
| Memory Type                   | 256M x 16 GDDR6                                     |
| Max. Resolution (DP)          | 7680x4320@120Hz                                     |
| Multi Display Support         | 3 displays  |
| HDCP Compliance               | Yes   |
| Rear I/O connectors (bracket) | mDPx3   |
| Cooling (active/passive)      | Active fan-sink (Active cooling with dynamic speed) |
| Total power consumption (W)   | 30W   |
| PCB form-factor with bracket  | LP PCB with LP bracket                              |
|                               |   |

## Technical Specifications – Graphics

### NVIDIA® T400 4GB Graphics Card

| Engine Clock                  | 2100 MHz  |
|-------------------------------|---|
| Memory Clock                  | 5001 MHz  |
| Memory Size (width)           | 4GB (64-bit)  |
| Memory Type                   | 512M x 16 GDDR6                                     |
| Max. Resolution (DP)          | 7680x4320@120Hz                                     |
| Multi Display Support         | 3 displays  |
| HDCP Compliance               | Yes   |
| Rear I/O connectors (bracket) | mDPx3   |
| Cooling (active/passive)      | Active fan-sink (Active cooling with dynamic speed) |
| Total power consumption (W)   | 30W   |
| PCB form-factor with bracket  | LP PCB with LP bracket                              |

#### AMD Radeon™ RX 6300 2GB GDDR6 Graphics card

| Engine Clock                  | Base: 1512 Mhz Boost: 2040 Mhz                    |
|-------------------------------|---|
| Memory Size / Width           | 2GB / 32bit                                       |
| Graphic Memory Type / Clock   | 512Mx32 GDDR6 ,1 pcs / 16Gbps                     |
| Max. Resolution (HDMI)        | 7680x4320@60Hz                                    |
| Max. Resolution (DP)          | 7680x4320@120Hz                                   |
| Multi Display Support         | 2 displays  |
| HDCP Compliance               | Yes   |
| Rear I/O connectors (bracket) | HDMIx1+ DPx1 (LP)                                 |
| Cooling (active/passive)      | Active  |
| Total power consumption (W)   | 57W   |
| Form-factor                   | X:160.2mm/Y:68.9mm/Z: 22.6mm PCB with single slot |
|                               |   |



## Technical Specifications – Graphics

# HP Pro Tower 400 G9 Desktop PC

| Intel <sup>®</sup> HD Graphics (integrated) |   |
|---|---|
| VGA Controller                              | Integrated  |
| DisplayPort™                                | Multimode capable; supports HDCP, Display Port Audio, Onboard support HBR2 link         |
|   | rates/option DP support to HBR3 and Multi-Stream Technology for a maximum of 3 displays |
|   | connected to any output controlled by Intel® Graphics                                   |
| HDMI (onboard / optional)                   | Supports HDMI 2.1 features (onboard HDMI support HDMI1.4; Option HDMI support HDMI 2.1) |
|   | Supports HDCP 2.3 (Support HDCP 1.4/2.3)  |
|   | Supports audio over HDMI  |
| VGA (optional)                              | VGA output  |
| USB-C <sup>®</sup> DP Alt Mode (optional)   | DisplayPort™ over the optional USB-C® module (Support DP1.4 HBR2)                       |
| Memory                                      | The actual amount of maximum graphics memory can be >4GB. System memory is allocated    |
|   | for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide |
|   | an optimal balance between graphics and system memory use.                              |
| Maximum Color Depth                         | up to 16 bits/color   |
| Graphics/Video API Support                  | HEVC 10b Enc/12b Dec HW   |
|   | VP9 12b Dec HW à AV1 decode support 8/10b, 4:2:0  |
|   | HDR   |
|   | Rec. 2020   |
|   | DX12  |
| Max. Resolution (VGA Option)                | 2048 x 1536@60Hz  |
| Max. Resolution (Onboard HDMI)              | 1920 x 1080@60Hz  |
| Max. Resolution (Option HDMI)               | 3840 x 2160@60Hz  |
| Max. Resolution (On board DP)               | HBR2: 4096 x 2304@60hz 24 bpp   |
| Max. Resolution (Option DP)                 | HBR3: 5120 x3200 @60hz 24 bpp   |
| Max. Resolution (Option Type C)             | DP HBR2: 4096 x2304 @60hz 24bpp   |

#### NVIDIA® Quadro T400 2GB Graphics Card

| ·····                         |   |
|-------------------------------|---|
| Engine Clock                  | 2100 MHz  |
| Memory Clock                  | 5001 MHz  |
| Memory Size (width)           | 2GB (64-bit)  |
| Memory Type                   | 256M x 16 GDDR6                                     |
| Max. Resolution (DP)          | 7680x4320@120Hz                                     |
| Multi Display Support         | 3 displays  |
| HDCP Compliance               | Yes   |
| Rear I/O connectors (bracket) | mDPx3   |
| Cooling (active/passive)      | Active fan-sink (Active cooling with dynamic speed) |
| Total power consumption (W)   | 30W   |
| PCB form-factor with bracket  | LP PCB with LP bracket                              |

#### NVIDIA® T400 4GB Graphics Card

| <b>-</b>                      | -   |
|-------------------------------|---|
| Engine Clock                  | 2100 MHz  |
| Memory Clock                  | 5001 MHz  |
| Memory Size (width)           | 4GB (64-bit)  |
| Memory Type                   | 512M x 16 GDDR6                                     |
| Max. Resolution (DP)          | 7680x4320@120Hz                                     |
| Multi Display Support         | 3 displays  |
| HDCP Compliance               | Yes   |
| Rear I/O connectors (bracket) | mDPx3   |
| Cooling (active/passive)      | Active fan-sink (Active cooling with dynamic speed) |
|                               |   |



## Technical Specifications – Graphics

| Total power consumption (W)  | 30W                    |
|------------------------------|------------------------|
| PCB form-factor with bracket | LP PCB with LP bracket |

### NVIDIA® GeForce® RTX 3050 8GB GDDR6 Graphics Card

| Engine Clock                  | Base: 1515 Mhz Boost: 1755 Mhz                                       |
|-------------------------------|--|
| Frame Buffer Size / Width     | 8GB/128bit   |
| Graphic Memory Type / Clock   | 512Mx32 GDDR6 @ 4 pcs/14Gbps   |
| Max. Resolution (HDMI)        | 7680x4320@60Hz   |
| Max. Resolution (DP)          | 7680x4320@60Hz   |
| Multi Display Support         | 4 displays   |
| HDCP Compliance               | Yes  |
| Rear I/O connectors (bracket) | HDMIx1+ DPx3   |
| •                             |  |
| Cooling (active/passive)      | Active fansink with 4 pin fan control                                |
| Total power consumption (W)   | 120W   |
| Form-factor                   | ATX (X:144.7mm/Y:111.15mm/Z: 36.70mm) PCB with ATX dual slot bracket |

NOTE: PCIe 2x4 power connector requires for RTX3050 with 400W PSU

#### Intel<sup>®</sup> Arc<sup>™</sup> A380 6GB GDDR6 Graphics card<sup>4</sup>

| Engine Clock                  | 2150Mhz               |
|-------------------------------|-----------------------|
| Frame Buffer Size / Width     | 6GB/96bit             |
| Graphic Memory Type / Clock   | GDDR6 ,3 pcs/15.5Gbps |
| Max. Resolution (HDMI)        | 4096 x2160@60Hz       |
| Max. Resolution (DP)          | 7680x4320@60Hz        |
| Multi Display Support         | 4 displays            |
| HDCP Compliance               | Yes                   |
| Rear I/O connectors (bracket) | DP x3 + HDMI x1       |
| Cooling (active/passive)      | Active                |
| Total power consumption (W)   | 75W                   |

### AMD Radeon™ RX 6300 2GB GDDR6 Graphics card

| Engine Clock                  | Base: 1512 Mhz Boost: 2040 Mhz                    |
|-------------------------------|---|
| Memory Size / Width           | 2GB / 32bit                                       |
| Graphic Memory Type / Clock   | 512Mx32 GDDR6 ,1 pcs / 16Gbps                     |
| Max. Resolution (HDMI)        | 7680x4320@60Hz                                    |
| Max. Resolution (DP)          | 7680x4320@120Hz                                   |
| Multi Display Support         | 2 displays  |
| HDCP Compliance               | Yes   |
| Rear I/O connectors (bracket) | HDMIx1+ DPx1 (LP)                                 |
| Cooling (active/passive)      | Active  |
| Total power consumption (W)   | 57W   |
| Form-factor                   | X:160.2mm/Y:68.9mm/Z: 22.6mm PCB with single slot |



Technical Specifications – Graphics

## HP PROONE 440 23.8 INCH G9 ALL-IN-ONE DESKTOP PC

| Intel <sup>®</sup> UHD Graphics (integrated) |   |
|--|---|
| Graphics Controller                          | Integrated  |
| DisplayPort™                                 | Multimode capable; supports HDCP, Display Port Audio , HBR2 link rates and Multi-Stream |
|  | Technology for a maximum of 3 displays connected to any output controlled by Intel®     |
|  | Graphics  |
| HDMI (onboard / optional)                    | Supports HDMI 2.1 features  |
|  | Supports HDCP 2.3   |
|  | Supports audio over HDMI  |
| USB-C <sup>®</sup> DP Alt Mode (optional)    | DisplayPort™ over the USB-C® module   |
| Memory                                       | The actual amount of maximum graphics memory can be >4GB. System memory is allocated    |
|  | for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide |
|  | an optimal balance between graphics and system memory use.                              |
| Maximum Color Depth                          | up to 16 bits/color   |
| Graphics/Video API Support                   | HEVC 10b Enc/12b Dec HW   |
|  | VP9 12b Dec HW  |
|  | HDR   |
|  | Rec. 2020   |
|  | DX12  |
| Max. Resolution (HDMI)                       | 4096 x 2160@60Hz  |
| Max. Resolution (DP)                         | 4096 x 2304@60Hz  |
| Max. Resolution (Optional VGA)               | 2048 x 1536@60Hz  |
| Max. Resolution (Optional DP)                | 5120 x 2160@60Hz  |
| Max. Resolution (Optional HDMI)              | 3840 x 2160@60Hz  |

### AMD Radeon™ RX 6300 2GB GDDR6 Graphics card

| Engine Clock                | Base: 1512 Mhz Boost: 2040 Mhz |
|-----------------------------|--------------------------------|
| Memory Size / Width         | 2GB/32bit                      |
| Graphic Memory Type / Clock | 512Mx32 GDDR6 ,1 pcs / 16Gbps  |
| HDCP Compliance             | Yes                            |
| Total power consumption (W) | 25W                            |

## Technical Specifications – Storage

## STORAGE

**NOTE:** Starting from November 1<sup>st</sup>, 2023, all shipments will require Windows to be installed when selecting a SSD. HDD can only be configured as additional data drives and not as the boot drive.

#### 1TB 7200RPM 3.5in SATA HDD

| Capacity              | 1TB   |
|-----------------------|---|
| Rotational Speed      | 7,200 rpm   |
| Interface             | SATA 6 Gb/s   |
| Buffer Size           | 64MB  |
| Logical Blocks        | 1,953,525,168   |
| Seek Time             | 11 ms (Average)   |
| Height                | 1in/2.54cm  |
| Width (nominal)       | Media diameter: 3.5 in/8.89 cm<br>Physical size: 4 in/10.2 cm |
| Operating Temperature | 41° to 131° F (5° to 55° C)                                   |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 2TB 7200RPM 3.5in SATA HDD

| Capacity              | 2TB   |
|-----------------------|---|
| Rotational Speed      | 7,200 rpm   |
| Interface             | SATA 6 Gb/s   |
| Buffer Size           | 128MB   |
| Logical Blocks        | 3,907,050,336   |
| Seek Time             | 11 ms (Average)   |
| Height                | 1.028in/26.11mm   |
| Width (nominal)       | Media diameter: 3.5 in/8.89 cm<br>Physical size: 4 in/10.2 cm |
| Operating Temperature | 41° to 131° F (5° to 55° C)                                   |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

### 1TB 7200RPM 2.5in SATA HDD

| Capacity              | 1TB                         |
|-----------------------|-----------------------------|
| Rotational Speed      | 7,200 rpm                   |
| Interface             | SATA 6 Gb/s                 |
| Buffer Size           | Up to 128MB                 |
| Logical Blocks        | 1,953,525,168               |
| Seek Time             | 12 ms (Average)             |
| Height                | 0.283 in/7.2 mm (Max)       |
| Width (nominal)       | 2.75 in/70 mm (nominal)     |
| Operating Temperature | 41° to 131° F (5° to 55° C) |



## Technical Specifications – Storage

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 256GB M.2 2280 PCIe NVMe SSD

| Capacity                 | 256GB          |
|--------------------------|----------------|
| Interface                | PCIe NVMe      |
| Minimum Sequential Read  | 2000 MB/s ±10% |
| Minimum Sequential Write | 900 MB/s ±10%  |
| Logical Blocks           | 500,118,192    |
| Features                 | TRIM; L1.2     |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 512GB M.2 2280 PCIe NVMe SSD

| Capacity                 | 512GB          |
|--------------------------|----------------|
| Interface                | PCIe NVMe      |
| Minimum Sequential Read  | 2200 MB/s ±10% |
| Minimum Sequential Write | 1000 MB/s ±10% |
| Logical Blocks           | 1,000,215,216  |
| Features                 | TRIM; L1.2     |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 1TB M.2 2280 PCIe NVMe SSD

| Capacity                 | 1TB            |
|--------------------------|----------------|
| Interface                | PCIe NVMe      |
| Minimum Sequential Read  | 2200 MB/s ±10% |
| Minimum Sequential Write | 1600 MB/s ±10% |
| Logical Blocks           | 2,000,409,264  |
| Features                 | TRIM; L1.2     |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 256GB M.2 2280 PCIe NVMe Three Layer Cell SSD

| Capacity                 | 256GB                  |
|--------------------------|------------------------|
| Interface                | PCIE Gen4x4            |
| Minimum Sequential Read  | 4000 MB/s ±10%         |
| Minimum Sequential Write | 2000 MB/s ±10%         |
| Logical Blocks           | 500,118,192            |
| Features                 | TRIM; L1.2; Pyrite 2.0 |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.



Technical Specifications – Storage

### 512GB M.2 2280 PCIe NVMe Three Layer Cell SSD

| Capacity                 | 512GB                  |
|--------------------------|------------------------|
| Interface                | PCIE Gen4x4            |
| Minimum Sequential Read  | 6400 MB/s ±10%         |
| Minimum Sequential Write | 3500 MB/s ±10%         |
| Logical Blocks           | 1,000,215,216          |
| Features                 | TRIM; L1.2; Pyrite 2.0 |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

### 1TB M.2 2280 PCIe NVMe Three Layer Cell SSD

| Capacity                 | 1TB                    |
|--------------------------|------------------------|
| Interface                | PCIE Gen4x4            |
| Minimum Sequential Read  | 6400 MB/s ±10%         |
| Minimum Sequential Write | 5000 MB/s ±10%         |
| Logical Blocks           | 2,000,409,264          |
| Features                 | TRIM; L1.2; Pyrite 2.0 |
|                          |                        |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 2TB M.2 2280 PCIe NVMe Three Layer Cell SSD

| Capacity                 | 2TB                    |
|--------------------------|------------------------|
| Interface                | PCIE Gen4x4            |
| Minimum Sequential Read  | 6400 MB/s ±10%         |
| Minimum Sequential Write | 5000 MB/s ±10%         |
| Logical Blocks           | 4,000,797,360          |
| Features                 | TRIM; L1.2; Pyrite 2.0 |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 256GB M.2 2280 PCIe NVMe Self Encrypted OPAL2 Value SSD

| Capacity                 | 256GB                  |
|--------------------------|------------------------|
| Interface                | PCIE NVMe              |
| Minimum Sequential Read  | 2000 MB/s ±10%         |
| Minimum Sequential Write | 900 MB/s ±10%          |
| Logical Blocks           | 500,118,192            |
| Features                 | Pyrite 2.0; TRIM; L1.2 |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.



# Technical Specifications – Storage

#### 256GB M.2 2280 PCIe NVMe Self Encrypted OPAL2 Three Layer Cell SSD

| Capacity                 | 256GB                    |
|--------------------------|--------------------------|
| Interface                | PCIE Gen4x4              |
| Minimum Sequential Read  | 4000 MB/s ±10%           |
| Minimum Sequential Write | 2000 MB/s ±10%           |
| Logical Blocks           | 500,118,192              |
| Features                 | TRIM; L1.2; TCG Opal 2.0 |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 512GB M.2 2280 PCIe NVMe Self Encrypted OPAL2 Three Layer Cell SSD

| Capacity                 | 512GB                    |
|--------------------------|--------------------------|
| Interface                | PCIE Gen4x4              |
| Minimum Sequential Read  | 6400 MB/s ±10%           |
| Minimum Sequential Write | 3500 MB/s ±10%           |
| Logical Blocks           | 1,000,215,216            |
| Features                 | TRIM; L1.2; TCG Opal 2.0 |

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### HP 9.5mm Slim DVD-ROM Drive

| Height<br>Orientation<br>Interface type                  | 9.5 mm height<br>Either horizontal or vertical<br>SATA/ATAPI   |
|--|--|
| Dimensions (W x H x D)                                   | 5.04 x 0.37 x 5.0 in (128 x 9.5 x 127 mm) without bezel  |
| Weight (max)   | Up to 0.31 lb (140g) without bezel   |
| Read Speeds  | DVD+R/-R/+RW/<br>-RW/+R DL /-R DL Up to 8X<br>DVD-ROM Up to 8X<br>CD-ROM, CD-R Up to 24X<br>CD-RW Up to 24X  |
| Access time<br>(typical reads, including<br>settling)    | Random: DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)<br>Full stroke: DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)                        |
| Power  | Source Slimline SATA DC power receptacle<br>DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p<br>DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum) |
| Environmental conditions<br>(operating - non-condensing) | Temperature 41° to 122° F (5° to 50° C)<br>Relative Humidity 10% to 80%<br>Maximum Wet Bulb Temperature 84° F (29° C)                                  |



# Technical Specifications – Storage

### HP 9.5mm Slim DVD Writer Drive

| Height  | 9.5 mm height   |
|---|---|
| Orientation   | Either horizontal or vertical   |
| Interface type  | SATA/ATAPI  |
| Dimensions (W x H x D)                                | 5.04 x 0.37 x 5.0 in (128 x 9.5 x 127 mm) without bezel   |
| Weight (max)  | Up to 0.31 lb (140 g) Without bezel   |
| Write Speeds  | DVD-R DL - Up to 6X<br>DVD+R - Up to 8X<br>DVD+RW - Up to 8X<br>DVD+R DL - Up to 6X<br>DVD-R - Up to 6X<br>DVD-RW - Up to 6X<br>CD-R - Up to 24X  |
| Read Speeds   | CD-RW - Up to 10X<br>DVD-RW, DVD+RW - Up to 8X<br>DVD-R DL, DVD+R DL - Up to 8X<br>DVD+R, DVD-R - Up to 8X<br>DVD-ROM DL, DVD-ROM - Up to 8X<br>CD-ROM, CD-R - Up to 24X<br>CD-RW - Up to 24X     |
| Access time<br>(typical reads, including<br>settling) | Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)<br>Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)<br>Stop Time 6 seconds (typical)                                    |
| Power<br>Environmental conditions                     | Source Slimline SATA DC power receptacle<br>DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p<br>DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)<br>Temperature 41° to 122° F (5° to 50° C) |
| (operating - non-condensing)                          | Relative Humidity 10% to 80%<br>Maximum Wet Bulb Temperature 84° F (29° C)  |



## **NETWORKING AND COMMUNICATIONS**

| Intel® I219-LM 1 Gigabit Net | work Connection LOM (vPro®)   |
|------------------------------|---|
| Connector                    | RJ-45   |
| System Interface             | PCI (Intel® proprietary) + SMBus  |
| Data rates supported         | 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)<br>100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)   |
|                              | 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)<br>Auto-Negotiation (Automatic Speed Selection)<br>Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s                         |
| IEEE Compliance              | IEEE 802.1p QoS (Quality of Service) Support<br>IEEE 802.1q VLAN support<br>IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)   |
| Performance                  | IEEE 802.3az EEE (Energy Efficient Ethernet) TCP/IP/UDP Checksum Offload (configurable)   |
|                              | Protocol Offload (ARP & NS)<br>Large send offload and Giant send offload<br>Receiving Side Scaling (Hash Mode Only)<br>Jumbo Frame 9K   |
| Power consumption            | Cable Disconnection: 25mW<br>100Mbps Full Run: 450mW<br>1000bp Full Run: 1000mW<br>WoL Enable (S3/S4/S5): 50mW<br>WoL Disable (S3/S4/S5): 25mW  |
| Power                        | ACPI compliant – multiple power modes   |
| Management                   | Situation-sensitive features reduce power consumption<br>Advanced link down power saving for reducing link down power consumption   |
| Management Interface         | Auto MDI/MDIX Crossover cable detection   |
| IT Manageability             | Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up<br>Frame); Wake-on-LAN from off (Magic Packet only) <u>, Microsoft Windows Fast Startup must</u><br><u>be disabled.</u><br>PXE 2.1 Remote Boot |
|                              | Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))<br>Comprehensive diagnostic and configuration software suite<br>Virtual Cable Doctor for Ethernet cable status                            |
| Security & Manageability     | Intel <sup>®</sup> vPro <sup>®</sup> support with appropriate Intel <sup>®</sup> chipset components   |



| Network Adapter Intel I | oxPond1 I225-T1 2.5GbE   |
|-------------------------|--|
| Connector               | RJ-45  |
| System Interface        | PCI (Intel® proprietary) + SMBus   |
| Data rates supported    | 1. 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)                   |
|                         | 2. 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)                |
|                         | 3. 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3 clauses 40)                 |
|                         | 4. 2.5 Gbit/s operation (2.5GBASE-T; IEEE 802.3bz Clause 126)                              |
|                         | 5. Auto-Negotiation (Automatic Speed Selection)  |
|                         | Full Duplex Operation at all Speeds, Half Duplex operation at 10, 100 & 1000 Mbit/s        |
| IEEE Compliance         | IEEE 802.1p QoS (Quality of Service) Support   |
|                         | IEEE 802.1q VLAN support   |
|                         | IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)                          |
|                         | IEEE 802.3az EEE (Energy Efficient Ethernet)   |
|                         | IEEE 802.3i 10BASE-T   |
|                         | IEEE 802.3u 100BASE-TX   |
|                         | IEEE 802.3ab 1000BAE-T   |
|                         | IEEE 802.3bz 2.5GBASE-T  |
| Performance             | TCP/IP/UDP Checksum Offload (configurable)   |
|                         | Protocol Offload (ARP & NS)  |
|                         | Large send offload and Giant send offload  |
|                         | Receiving Side Scaling (Hash Mode Only)  |
|                         | Jumbo Frame 9K   |
| Power consumption       | Cable Disconnection: 25mW  |
|                         | 100Mbps Full Run: 450mW  |
|                         | 1000bp Full Run: 1000mW  |
|                         | WoL Enable (S3/S4/S5): 50mW  |
|                         | WoL Disable (S3/S4/S5): 25mW   |
| Power                   | ACPI compliant – multiple power modes  |
| Management              | Situation-sensitive features reduce power consumption                                      |
|                         | Advanced link down power saving for reducing link down power consumption                   |
| Management Interface    | Auto MDI/MDIX Crossover cable detection  |
| IT Manageability        | Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); |
|                         | Wake-on-LAN from off (Magic Packet only), Microsoft Windows Fast Startup must be disabled. |
|                         | PXE 2.1 Remote Boot  |
|                         | Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))    |
|                         | Comprehensive diagnostic and configuration software suite                                  |
|                         | Virtual Cable Doctor for Ethernet cable status   |



| Intel I226-T1 2.5GbE Ethernet Network Adapter |  |
|---|--|
| Connector                                     | RJ-45  |
| System Interface                              | PCI (Intel proprietary) + SMBus  |
| Data rates supported                          | <ol> <li>1. 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)</li> <li>2. 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)</li> <li>3. 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3 clauses 40)</li> <li>4. 2.5 Gbit/s operation (2.5GBASE-T; IEEE 802.3bz Clause 126)</li> <li>5. Auto-Negotiation (Automatic Speed Selection)</li> <li>Full Duplex Operation at all Speeds, Half Duplex operation at 10 &amp; 100 Mbit/s</li> </ol> |
| IEEE Compliance                               | IEEE 802.1p QoS (Quality of Service) Support<br>IEEE 802.1q VLAN support<br>IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)<br>IEEE 802.3az EEE (Energy Efficient Ethernet)<br>IEEE 802.3i 10BASE-T<br>IEEE 802.3u 100BASE-TX<br>IEEE 802.3ab 1000BAE-T<br>IEEE 802.3bz 2.5GBASE-T   |
| Performance                                   | TCP/IP/UDP Checksum Offload (configurable)<br>Protocol Offload (ARP & NS)<br>Large send offload and Giant send offload<br>Receiving Side Scaling(Hash Mode Only)<br>Jumbo Frame 9K   |
| Power consumption                             | Cable Disconnection: 25mW<br>100Mbps Full Run: 450mW<br>1000Mbp Full Run: 1000mW<br>2500Mbp Full Run: 4500mW<br>WoL Enable(S3/S4/S5): 50mW<br>WoL Disable(S3/S4/S5): 25mW  |
| Power   | ACPI compliant – multiple power modes  |
| Management                                    | Situation-sensitive features reduce power consumption<br>Advanced link down power saving for reducing link down power consumption  |
| Management Interface                          | Auto MDI/MDIX Crossover cable detection  |
| IT Manageability                              | Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up<br>Frame); Wake-on-LAN from off (Magic Packet only)<br>PXE 2.1 Remote Boot<br>Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))<br>Comprehensive diagnostic and configuration software suite<br>Virtual Cable Doctor for Ethernet cable status  |

|                           | 1x1) Wi Fi® and Bluetooth® 4.2 wireless card <sup>1</sup>  |
|---------------------------|--|
| Wireless LAN Standards    | IEEE 802.11a   |
|                           | IEEE 802.11b   |
|                           | IEEE 802.11g   |
|                           | IEEE 802.11n   |
|                           | IEEE 802.11ac  |
|                           | IEEE 802.11d   |
|                           | IEEE 802.11e   |
|                           | IEEE 802.11h   |
|                           | IEEE 802.11i   |
|                           | IEEE 802.11k   |
|                           | IEEE 802.11r   |
|                           | IEEE 802.11v   |
| Interoperability          | Wi-Fi <sup>®</sup> certified modules   |
| Frequency Band            | 802.11b/g/n  |
|                           | • 2.402 – 2.482 GHz  |
|                           | 802.11a/n/ac   |
|                           | • 4.9 – 4.95 GHz (Japan)   |
|                           | • 5.15 – 5.25 GHz  |
|                           | • 5.25 – 5.35 GHz  |
|                           | • 5.47 – 5.725 GHz   |
|                           | • 5.825 – 5.850 GHz  |
| Data Rates                | • 802.11b: 1, 2, 5.5, 11 Mbps  |
|                           | • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps   |
|                           | • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps   |
|                           | • 802.11n: max 150Mbps   |
|                           | • 802.11ac: max 433.3Mbps  |
| Modulation                | Direct Sequence Spread Spectrum  |
|                           | BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM   |
|                           |  |
| Security <sup>2</sup>     | <ul> <li>IEEE and Wi-Fi<sup>®</sup> certified 64 / 128 bit WEP encryption for a/b/g mode only</li> </ul> |
|                           | AES-CCMP: 128 bit in hardware  |
|                           | 802.1x authentication  |
|                           | <ul> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> </ul>                                 |
|                           | WPA2 certification   |
|                           | WPA3 certification   |
|                           | • IEEE 802.11i   |
|                           | • WAPI   |
| Network Architecture      | Ad-hoc (Peer to Peer)  |
| Models                    | Infrastructure (Access Point Required)   |
| Roaming                   | IEEE 802.11 compliant roaming between access points  |
| Output Power <sup>3</sup> | • 802.11b: +14dBm minimum  |
|                           | • 802.11g: +12dBm minimum  |
|                           | • 802.11a: +12dBm minimum  |
|                           | • 802.11n HT20(2.4GHz): +12dBm minimum   |
|                           | • 802.11n HT40(2.4GHz): +12dBm minimum   |
|                           | • 802.11n HT20(5GHz): +10dBm minimum   |
|                           | • 802.11n HT40(5GHz): +10dBm minimum   |
|                           | • 802.11ac VHT80(5GHz): +10dBm minimum   |



| Power Consumption                    | Transmit mode 2.0 W     Receive mode 1.6 W   |
|--------------------------------------|--|
|                                      | Idle mode (PSP) 180 mW (WLAN Associated)   |
|                                      | Idle mode 50 mW (WLAN unassociated)  |
|                                      | Connected Standby 10mW   |
|                                      | • Radio disabled 8 mW  |
| Power Management                     | ACPI and PCI Express compliant power management<br>802.11 compliant power saving mode  |
| Receiver Sensitivity <sup>4</sup>    | 802.11b, 1Mbps: -93.5dBm maximum   |
|                                      | 802.11b, 11Mbps: -84dBm maximum  |
|                                      | 802.11a/g, 6Mbps: -86dBm maximum<br>802.11a/g, 54Mbps: -72dBm maximum  |
|                                      | 802.11n, MCS07: -67dBm maximum   |
|                                      | 802.11n, MCS15: -64dBm maximum   |
|                                      | 802.11ac, MCS0: -84dBm maximum   |
|                                      | 802.11ac, MCS9: -59dBm maximum   |
| Antenna type                         | High efficiency antenna.   |
|                                      | One embedded dual band 2.4/5 GHz antenna is provided to the card to support WLAN communications and Bluetooth communications   |
| Form Factor                          | PCI-Express M.2 MiniCard   |
| Dimensions                           | Type 2230: 2.3 x 22.0 x 30.0 mm  |
| Weight                               | Type 2230: 2.8g  |
| Operating Voltage                    | 3.3v +/- 9%  |
| Temperature                          | Operating: 14° to 158° F (–10° to 70° C)   |
|                                      | Non-operating: -40° to 176° F (-40° to 80° C)  |
| Humidity                             | Operating: 10% to 90% (non-condensing)   |
|                                      | Non-operating: 5% to 95% (non-condensing)  |
| Altitude                             | Operating: 0 to 10,000 ft (3,048 m)<br>Non-operating: 0 to 50,000 ft (15,240 m)  |
| LED Activity                         | LED Amber – Radio OFF;<br>LED OFF – Radio ON   |
| HP Integrated Module with Blue       | etooth® 4.0/4.1/4.2 wireless card Technology   |
| Bluetooth <sup>®</sup> Specification | 4.0/4.1/4.2 wireless card Compliant  |
| Frequency Band                       | 2402 to 2480 MHz   |
| Number of Available Channels         | Legacy: 0~79 (1 MHz/CH)<br>BLE: 0~39 (2 MHz/CH)  |
| Data Rates and Throughput            | Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps<br>BLE: 1 Mbps data rate; throughput up to 0.2 Mbps<br>Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels<br>Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) |
|                                      | or 864 kbps symmetric (3-EV5)  |
|                                      | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.  |
|                                      | Peak (Tx) 330 mW   |
|                                      |  |
|                                      | Peak (Rx) 230 mW   |
|                                      | Peak (Rx) 230 mW<br>Selective Suspend 17 mW  |



| Power Consumption  | Microsoft Windows Bluetooth Software   |
|--|--|
| Bluetooth <sup>®</sup> Software Supported<br>Link Topology | Microsoft Windows ACPI, and USB Bus Support  |
| Power Management   | FCC (47 CFR) Part 15C, Section 15.247 & 15.249   |
| Certifications   | 4.0/4.1/4.2 Compliant  |
| Power Management<br>Certifications                         | ETS 300 328, ETS 300 826<br>Low Voltage Directive IEC950<br>UL, CSA, and CE Mark   |
| Bluetooth <sup>®</sup> Profiles Supported                  | BT4.1-ESR 5/6/7 ComplianceLE Link Layer PingLE Dual ModeLE Link LayerLE Low Duty Cycle Directed AdvertisingLE Low Duty Cycle Directed AdvertisingLE L2CAP Connection Oriented ChannelsTrain Nudging & Interlaced ScanBT4.2 ESR08 ComplianceLE Secure Connection- Basic/FullLE Privacy 1.2 -Link Layer PrivacyLE Privacy 1.2 -Extended Scanner Filter PoliciesLE Data Packet Length ExtensionFAX Profile (FAX)Basic Imaging Profile (BIP)2Headset Profile (HSP)Hands Free Profile (HFP)Advanced Audio Distribution Profile (A2DP) |

1. Wi-Fi 5 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



| Realtek RTL8852BE 802.11<br>rate) <sup>1</sup> | ax 2x2 Wi-Fi $^{ m e}$ + Bluetooth $^{ m e}$ 5.3 wireless card (802.11ax 2x2, supporting gigabit data    |
|--|--|
| Wireless LAN Standards                         | IEEE 802.11a<br>IEEE 802.11b   |
|  | IEEE 802.11g   |
|  | IEEE 802.11n   |
|  | IEEE 802.11ac  |
|  | IEEE 802.11ax  |
|  | IEEE 802.11d   |
|  | IEEE 802.11e   |
|  | IEEE 802.11h   |
|  | IEEE 802.11i   |
|  | IEEE 802.11k   |
|  | IEEE 802.11r   |
|  | IEEE 802.11v   |
| Interoperability                               | Wi-Fi <sup>®</sup> certified modules   |
| Frequency Band                                 | 802.11b/g/n/ax   |
|  | • 2.402 – 2.482 GHz  |
|  | 802.11a/n/ac/ax  |
|  | • 4.9 – 4.95 GHz (Japan)   |
|  | • 5.15 – 5.25 GHz  |
|  | • 5.25 – 5.35 GHz  |
|  | • 5.47 – 5.725 GHz   |
|  | • 5.825 – 5.850 GHz  |
| Data Rates                                     | • 802.11b: 1, 2, 5.5, 11 Mbps  |
|  | • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps   |
|  | • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps   |
|  | • 802.11n: max 300Mbps<br>• 802.11ac: max 866.7Mbps  |
|  | • 802.11ac. max 800.7Mbps  |
| M - d-l-4!                                     |  |
| Modulation                                     | Direct Sequence Spread Spectrum<br>BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM                     |
| Security <sup>2</sup>                          | <ul> <li>IEEE and Wi-Fi<sup>®</sup> certified 64 / 128 bit WEP encryption for a/b/g mode only</li> </ul> |
|  | AES-CCMP: 128 bit in hardware  |
|  | • 802.1x authentication  |
|  | WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.   |
|  | WPA2 certification   |
|  | WPA3 certification   |
|  | • IEEE 802.11i   |
|  | • WAPI   |
| Network Architecture                           | Ad-hoc (Peer to Peer)  |
| Models   | Infrastructure (Access Point Required)   |
| Roaming  | IEEE 802.11 compliant roaming between access points  |
| Output Power <sup>3</sup>                      | • 802.11b: +18.5dBm minimum  |
|  | • 802.11g: +17.5dBm minimum  |
|  | • 802.11a: +18.5dBm minimum  |
|  | • 802.11n HT20(2.4GHz): +15.5dBm minimum   |
|  | • 802.11n HT40(2.4GHz): +14.5dBm minimum   |
|  | • 802.11n HT20(5GHz): +15.5dBm minimum   |
|  | • 802.11n HT40(5GHz): +14.5dBm minimum   |
|  | • 802.11ac VHT80(5GHz): +11.5dBm minimum   |



|                                      | • 802.11ax HE40(2.4GHz): +10dBm minimum<br>• 802.11ax HE80(5GHz): +10dBm minimum                                   |
|--------------------------------------|--|
| Power Consumption                    | • 802.114X HE80(SGH2). + FOUBILI IIIIIIIIIIIII     • Transmit mode:2.5 W   |
| i onci consumption                   | • Receive mode:2 W   |
|                                      | • Idle mode (PSP): 180 mW (WLAN Associated)  |
|                                      | Idle mode:50 mW (WLAN unassociated)  |
|                                      | <ul> <li>Connected Standby/Modern Standby: 10mW</li> <li>Radio disabled: 8 mW</li> </ul>                           |
| Power Management                     | ACPI and PCI Express compliant power management<br>802.11 compliant power saving mode                              |
| Receiver Sensitivity <sup>4</sup>    | 802.11b, 1Mbps: -93.5dBm maximum   |
|                                      | 802.11b, 11Mbps: -84dBm maximum  |
|                                      | 802.11a/g, 6Mbps: -86dBm maximum<br>802.11a/g, 54Mbps: -72dBm maximum  |
|                                      | 802.11n, MCS07: -67dBm maximum   |
|                                      | 802.11n, MCS15: -64dBm maximum   |
|                                      | 802.11ac, MCSO: -84dBm maximum   |
|                                      | 802.11ac, MCS9: -59dBm maximum   |
|                                      | •802.11ax, MCS11(HE40): -57dBm maximum   |
| A                                    | •802.11ax, MCS11(HE80): -54dBm maximum   |
| Antenna type                         | High efficiency antenna with spatial diversity, mounted in the display enclosure                                   |
|                                      | Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN                                 |
|                                      | MIMO communications and Bluetooth communications   |
| Form Factor                          | PCI-Express M.2 MiniCard   |
| Dimensions                           | 1. Type 2230: 2.3 x 22.0 x 30.0 mm<br>2. Type 1216: 1.67 x 12.0 x 16.0 mm  |
| Weight                               | 1. Type 2230: 2.8g   |
|                                      | 2. Type 126: 1.3g  |
| Operating Voltage                    | 3.3v +/- 9%  |
| Temperature                          | Operating: 14° to 158° F (–10° to 70° C)<br>Non-operating: –40° to 176° F (–40° to 80° C)                          |
| Humidity                             | Operating: 10% to 90% (non-condensing)<br>Non-operating: 5% to 95% (non-condensing)                                |
| Altitude                             | Operating: 0 to 10,000 ft (3,048 m)  |
|                                      | Non-operating: 0 to 50,000 ft (15,240 m)   |
| LED Activity                         | LED Amber – Radio OFF;<br>LED OFF – Radio ON   |
| HP Integrated Module with Blu        | uetooth® 4.0/4.1/4.2/5.0/5.1/5.2/5.3 wireless card Technology  |
| Bluetooth <sup>®</sup> Specification | 4.0/4.1/4.2/5.0/5.1/5.2 /5.3 wireless card Compliant   |
| Frequency Band                       | 2402 to 2480 MHz   |
| Number of Available Channels         | Legacy: 0~79 (1 MHz/CH)<br>BLE: 0~39 (2 MHz/CH)  |
| Data Rates and Throughput            | Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps   |
|                                      | BLE: 1 Mbps data rate; throughput up to 0.2 Mbps   |
|                                      | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels                                     |
|                                      | Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) |



| Transmit Power                                 | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.  |
|--|--|
| Power Consumption                              | Peak (Tx): 330 mW<br>Peak (Rx): 230 mW<br>Selective Suspend: 17 mW   |
| Electrical Interface                           | Microsoft Windows Bluetooth Software   |
| Bluetooth® Software Supported<br>Link Topology | Microsoft Windows ACPI, and USB Bus Support  |
| Power Management                               | FCC (47 CFR) Part 15C, Section 15.247 & 15.249   |
| Certifications                                 | ETS 300 328, ETS 300 826<br>Low Voltage Directive IEC950<br>UL, CSA, and CE Mark<br>Peak (Tx): 330 mW<br>Peak (Rx): 230 mW<br>Selective Suspend: 17 mW   |
| Power Management<br>Certifications             | Microsoft Windows Bluetooth Software   |
| Bluetooth <sup>®</sup> Profiles Supported      | BT4.1-ESR 5/6/7 Compliance<br>LE Link Layer Ping<br>LE Dual Mode<br>LE Link Layer<br>LE Low Duty Cycle Directed Advertising<br>LE L2CAP Connection Oriented Channels<br>Train Nudging & Interlaced Scan<br>BT4.2 ESR08 Compliance<br>LE Secure Connection- Basic/Full<br>LE Privacy 1.2 –Link Layer Privacy<br>LE Privacy 1.2 –Link Layer Privacy<br>LE Privacy 1.2 –Extended Scanner Filter Policies<br>LE Data Packet Length Extension<br>FAX Profile (FAX)<br>Basic Imaging Profile (BIP)2<br>Headset Profile (HSP)<br>Hands Free Profile (HSP)<br>Hands Free Profile (HFP)<br>Advanced Audio Distribution Profile (A2DP)<br>BT5.1<br>ESR9/10 Compliance<br>LE Advertisement Extensions<br>Channel Selection Algo<br>Limited High Duty Cycle Non-Connectable Advertising<br>2Mbps LE<br>LE Long Range |

1. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



| Intel® AX211 Wi-Fi 6E +Blue | tooth® 5.3 wireless card M.2 160MHz CNVi WW WLAN <sup>1</sup>  |
|-----------------------------|--|
| Wireless LAN Standards      | IEEE 802.11a   |
|                             | IEEE 802.11b   |
|                             | IEEE 802.11g   |
|                             | IEEE 802.11n   |
|                             | IEEE 802.11ac  |
|                             | IEEE 802.11ax  |
|                             | IEEE 802.11d   |
|                             | IEEE 802.11e   |
|                             | IEEE 802.11h   |
|                             | IEEE 802.11i   |
|                             | IEEE 802.11k   |
|                             | IEEE 802.11r   |
|                             | IEEE 802.11v   |
| Interoperability            | Wi-Fi <sup>®</sup> certified   |
| Frequency Band              | 802.11b/g/n/ax   |
|                             | • 2.402 – 2.482 GHz  |
|                             | 802.11a/n/ac/ax  |
|                             | • 4.9 – 4.95 GHz (Japan)   |
|                             | • 5.15 – 5.25 GHz  |
|                             | • 5.25 – 5.35 GHz  |
|                             | • 5.47 – 5.725 GHz   |
|                             | • 5.825 – 5.850 GHz  |
|                             | • 5.955 – 6.415 GHz  |
|                             | • 6.435 – 6.515 GHz  |
|                             | • 6.535 – 6.875 GHz  |
|                             | • 6.895 – 7.115 GHz  |
| Data Rates                  | • 802.11b: 1, 2, 5.5, 11 Mbps  |
|                             | • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps   |
|                             | • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps   |
|                             | • 802.11n: max 300Mbps   |
|                             | • 802.11ac: 1733Mbps   |
|                             | • 802.11ax: max 2.4Gbps  |
| Modulation                  | Direct Sequence Spread Spectrum  |
|                             |  |
|                             | OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM   |
|                             | ,1024QAM   |
| Security <sup>2</sup>       | <ul> <li>IEEE and Wi-Fi<sup>®</sup> compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> </ul> |
|                             | AES-CCMP: 128 bit in hardware  |
|                             | 802.1x authentication  |
|                             | WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.   |
|                             | WPA2 certification   |
|                             | WPA3 certification   |
|                             | • IEEE 802.11i   |
|                             | • WAPI   |
| Network Architecture        | Ad-hoc (Peer to Peer)  |
| Models                      |  |
|                             | Infrastructure (Access Point Required)   |
| Roaming                     | IEEE 802.11 compliant roaming between access points  |
| Output Power <sup>3</sup>   | • 802.11b: +17dBm minimum  |
|                             | • 802.11g: +16dBm minimum  |
|                             |  |
|                             | • 802.11a: +17dBm minimum<br>• 802.11n HT20(2.4GHz): +14dBm minimum                                      |



|                                      | • 802.11n HT40(2.4GHz): +13dBm minimum   |
|--------------------------------------|--|
|                                      | • 802.11n HT20(5GHz): +14dBm minimum   |
|                                      | • 802.11n HT40(5GHz): +13dBm minimum   |
|                                      | • 802.11ac VHT80(5GHz): +10dBm minimum   |
|                                      | • 802.11ac VHT160(5GHz): +10dBm minimum  |
|                                      | • 802.11ax HE40(2.4GHz): +12dBm minimum  |
|                                      | • 802.11ax HE80(5GHz): +10dBm minimum  |
|                                      | • 802.11ax HE160(5GHz): +10dBm minimum   |
| Power Consumption                    | Transmit mode 2.0 W  |
|                                      | Receive mode 1.6 W   |
|                                      | • Idle mode (PSP) 180 mW (WLAN Associated)   |
|                                      | <ul> <li>Idle mode 50 mW (WLAN unassociated)</li> </ul>                              |
|                                      | Connected Standby 10mW   |
|                                      | • Radio disabled 8 mW  |
| Power Management                     | ACPI and PCI Express compliant power management                                      |
|                                      | 802.11 compliant power saving mode   |
| Receiver Sensitivity <sup>4</sup>    | •802.11b, 1Mbps: -93.5dBm maximum  |
|                                      | •802.11b, 11Mbps: -84dBm maximum   |
|                                      | • 802.11a/g, 6Mbps: -86dBm maximum   |
|                                      | • 802.11a/g, 54Mbps: -72dBm maximum  |
|                                      | • 802.11n, MCS07: -67dBm maximum   |
|                                      | • 802.11n, MCS15: -64dBm maximum   |
|                                      | • 802.11ac, MCS0(VHT80): -84dBm maximum  |
|                                      | • 802.11ac, MCS9(VHT80): -59dBm maximum  |
|                                      | • 802.11ac, MCS9(VHT160): -58.5dBm maximum   |
|                                      | •802.11ax, MCS11(HE40): -57dBm maximum   |
|                                      | •802.11ax, MCS11(HE80): -54dBm maximum   |
|                                      | •802.11ax, MCS11(HE160): -53.5dBm maximum  |
| Antenna type                         | High efficiency antenna with spatial diversity, mounted in the display enclosure     |
|                                      |  |
|                                      | Two embedded dual band 2.4/5/6 GHz antennas are provided to the card to support WLAN |
|                                      | MIMO communications and Bluetooth communications                                     |
| Form Factor                          | PCI-Express M.2 MiniCard   |
| Dimensions                           | 1. Type 2230: 2.3 x 22.0 x 30.0 mm   |
|                                      | 2. Type 1216: 1.67 x 12.0 x 16.0 mm  |
| Weight                               | 1. Type 2230: 2.8g   |
|                                      | 2. Type 1216: 1.3g   |
| Operating Voltage                    | 3.3v +/- 9%  |
| Temperature                          | Operating: 14° to 158° F (–10° to 70° C)   |
| -                                    | Non-operating: –40° to 176° F (–40° to 80° C)  |
| Humidity                             | Operating: 10% to 90% (non-condensing)   |
| -                                    | Non-operating: 5% to 95% (non-condensing)  |
| Altitude                             | Operating: 0 to 10,000 ft (3,048 m)  |
|                                      | Non-operating: 0 to 50,000 ft (15,240 m)   |
| LED Activity                         | LED Amber – Radio OFF; LED OFF – Radio ON  |
|                                      | etooth® 4.0/4.1/4.2/5.0/5.1/5.2/5.3 wireless card Technology                         |
| Bluetooth <sup>®</sup> Specification | 4.0/4.1/4.2/5.0/5.1/5.2 5.3 wireless card Compliant                                  |
| Frequency Band                       | 2402 to 2480 MHz   |
| Number of Available Channels         | Legacy: 0~79 (1 MHz/CH)  |
|                                      | BLE: 0~39 (2 MHz/CH)   |
| Data Dates and Three-shart           |  |
| Data Rates and Throughput            | Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps                                 |
|                                      | BLE: 1 Mbps data rate; throughput up to 0.2 Mbps                                     |



|   | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels<br>Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5)<br>or 864 kbps symmetric (3-EV5) |
|---|---|
| Transmit Power                            | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum   |
| Transmit Power                            | transmit power of + 9.5 dBm for BR and EDR.   |
| Power Consumption                         | Peak (Tx): 330 mW   |
|   |   |
|   | Peak (Rx): 230 mW   |
|   |   |
|   | Selective Suspend: 17 mW  |
| Bluetooth <sup>®</sup> Software Supported | Microsoft Windows Bluetooth Software  |
| Link Topology                             |   |
| Power Management                          | Microsoft Windows ACPI, and USB Bus Support   |
| Certifications                            | FCC (47 CFR) Part 15C, Section 15.247 & 15.249  |
| Power Management                          | ETS 300 328, ETS 300 826  |
| Certifications                            |   |
|   | Low Voltage Directive IEC950  |
|   | UL, CSA, and CE Mark  |
| Bluetooth <sup>®</sup> Profiles Supported | BT4.1-ESR 5/6/7 Compliance  |
| bluetooth Fromes Supported                | LE Link Layer Ping  |
|   | LE Dual Mode  |
|   | LE Link Layer   |
|   | LE Low Duty Cycle Directed Advertising  |
|   | LE L2CAP Connection Oriented Channels   |
|   | Train Nudging & Interlaced Scan   |
|   | BT4.2 ESR08 Compliance  |
|   | LE Secure Connection- Basic/Full  |
|   | LE Privacy 1.2 – Link Layer Privacy   |
|   | LE Privacy 1.2 –Extended Scanner Filter Policies<br>LE Data Packet Length Extension   |
|   | FAX Profile (FAX)   |
|   | Basic Imaging Profile (BIP)2  |
|   | Headset Profile (HSP)   |
|   | Hands Free Profile (HFP)  |
|   | Advanced Audio Distribution Profile (A2DP)  |
|   | BT5.2   |
|   | ESR9/10 Compliance  |
|   | LE Advertisement Extensions   |
|   | Channel Selection Algo  |
|   | Limited High Duty Cycle Non-Connectable Advertising   |
|   | 2Mbps LE  |
|   | LE Long Range   |

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. Usage of the 6GHz band relies on Windows 11 Operating System support.



| Wireless LAN Standards     IEEE 802.11a<br>IEEE 802.11b<br>IEEE 802.11a<br>IEEE | Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 wireless card M.2 vPro® 160MHz CNVi WW WLAN <sup>1</sup> |                                      |  |
|---|---|--------------------------------------|--|
| IEEE 802.11g         IEEE 802.11ac         IEEE 802.11a         IEEE 802.11a      <   | Wireless LAN Standards  | IEEE 802.11a                         |  |
| IEEE 002.11a         IEEE 002.11ax         IEEE 002.11ax         IEEE 002.11a         IEEE 002.11d         IEEE 002.11e         IEEE 002.11e         IEEE 002.11e         IEEE 002.11e         IEEE 002.11k         IEEE 002.11v  |   | IEEE 802.11b                         |  |
| IEEE 802.11 ac         IEEE 802.11 bc         IEEE 8   |   | IEEE 802.11g                         |  |
| IEEE 802.11 axIEEE 802.11 dIEEE 802.11 dIEEE 802.11 hIEEE 802.11 hIEEE 802.11 kIEEE 802.11 kStar 5.25 GHz5.25 - 5.35 GHz5.25 - 5.35 GHz6.33 - 6.375 GHz6.33 - 6.375 GHz6.33 - 6.375 GHz802.112; 6.9, 12, 18, 24, 36, 48, 54 Mbps802.112; 73.3Mbps802.113; 73.3Mbps802.113; 73.3Mbps802.113; 71.3Mbps802.114; 71.3Mbps802.112; 71.22 bit in hardware802.112; 71.22 bit in hardware802.112; 71.22 bit in hardware802.111; 71.22 bit in hard  |   |                                      |  |
| IEEE 802.110         IEEE 802.111         IEEE 802.114         Secord State  |   | IEEE 802.11ac                        |  |
| IEEE 802.11e         IEEE 802.11i         IEEE 802.11i         IEEE 802.11i         IEEE 802.11v         Interoperability         W-Frequency Band         802.11b/g/n/ax         - 2.402 - 2.426 GHz         802.11b/g/n/ax         - 4.9 - 4.95 GHz         - 5.25 GHz         - 6.335 - 6.875 GHz         - 6.335 - 6.515 GHz         - 6.335 - 7.115 GHz         - 6.335 - 7.115 GHz         - 6.335 - 7.115 GHz         - 802.110: 1, 2, 5, 5, 11 Mbps   |   | IEEE 802.11ax                        |  |
| IEEE 802.11h           IEEE 802.11i           IEEE 802.11r           IEEE 802.11r           IEEE 802.11v           Interoperability           Wi-Fi certified           Frequency Band           802.11a/n/ac/ax           9.2.402 - 2.482 GHz           802.11a/n/ac/ax           9.3.5 GHz           9.5.5 - 5.35 GHz           9.5.25 - 5.35 GHz           9.5.25 - 5.35 GHz           9.5.25 - 5.35 GHz           9.5.35 - 6.475 GHz           9.5.35 - 6.475 GHz           9.6.35 - 6.475 GHz           9.6.35 - 6.475 GHz           9.6.35 - 6.475 GHz           9.6.25 - 6.475 GHz           9.802.11b: 1, 2, 5, 5, 11 Mbps           9.802.11b: 1, 2, 5, 5, 11 Mbps           9.802.11b: 1, 2, 4, 36, 48, 54 Mbps           9.802.11a: max 300Mbps           9.802.11a: max 2.46bps           Modulation           Direct Sequence Spread Spectrum           0FDM, PESK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM           10224QAM           10224QAM           Security <sup>2</sup> IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only           • AEE CMP: 12b tin hardware           902.11x: try 2Max: 802.1x, WPA2-PSK, WP   |   | IEEE 802.11d                         |  |
| IEEE 802.11i         IEEE 802.11v         Interoperability         Wi-Ficerrified         Frequency Band         802.11b/g/n/ax         -2.402 - 2.482 GHz         802.11a/n/ac/ax         -4.9 - 4.95 GHz (Japan)         -5.15 - 5.25 GHz         -5.25 GHz         -5.25 GHz         -5.25 GHz         -5.25 GHz         -5.35 - 6.35 GHz         -5.35 GHz         -5.35 GHz         -6.35 - 6.35 GHz         -6.35 - 6.35 GHz         -6.35 - 6.35 GHz         -6.35 - 6.35 GHz         -6.35 - 6.37 GHz         -6.39 - 7.115 GHz         -6.21 Tla: 6, 9, 12, 18, 24, 36, 48, 54 Mbps         -802.11 a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps         -802.11 a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps         -802.11 a: max 300Mbps         -802.11 a: max 300Mbps         -802.11 a: max 3.2 CA; 16, 24, 24, 25 CAM         .10240AM         VEEE and WFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         -AES-CCMP: 128 bit in hardware   |   | IEEE 802.11e                         |  |
| IEEE 802.11 ik         Interoperability       Wi-Fi certified         Frequency Band       802.11 b/g/n/ax         • 2.402 - 2.482 GHz       802.11 a/n/ac/ax         • 0.2.11 a/n/ac/ax       • 2.402 - 2.482 GHz         802.11 a/n/ac/ax       • 2.55 GHz         • 5.15 - 5.25 GHz       • 5.825 - 5.850 GHz         • 5.825 - 5.850 GHz       • 5.825 - 5.850 GHz         • 6.335 - 6.815 GHz       • 6.335 - 6.815 GHz         • 6.535 - 6.815 GHz       • 6.855 - 7.115 GHz         • 6.895 - 7.115 GHz       • 6.895 - 7.115 GHz         • 802.118: 1, 2, 55, 11 Mbps       • 802.118: 6, 9, 12, 18, 24, 36, 48, 54 Mbps         • 802.118: 1, 9, 12, 18, 24, 36, 48, 54 Mbps       • 802.111: max 300Mbps         • 802.112: 1, 2, 4, 36, 48, 54 Mbps       • 802.112: 1733Mbps         • 802.112: 1, 2, 4, 36, 48, 54 Mbps       • 802.112: 1733Mbps         • 802.112: 100 Mbps       • 802.112: 1733Mbps         • 802.112: 172 Mbps       • 802.112: 172 Mbps         • 802.112: 172 Mbps       • 802.112: 172 Mbps         • 802.112: 800 Mbps       • 802.112: 800 Mbps         • 802.112: 800 Mbps       •  |   |                                      |  |
| IEEE 802.11r         Interoperability       Wi-Fi certified         Frequency Band       802.11b/(Jn/Ax         802.11a/nac/ax       802.11a/nac/ax         + 2,402 - 2,482 GHz       8002.11a/nac/ax         802.11a/nac/ax       + 4,9 - 4,95 GHz (Japan)         + 5.15 - 5.25 GHz       + 5,47 - 5,725 GHz         + 5,825 - 5,850 GHz       + 5,825 - 6,815 GHz         + 6,435 - 6,515 GHz       + 6,435 - 6,515 GHz         + 6,435 - 6,515 GHz       + 6,435 - 6,515 GHz         + 6,435 - 6,515 GHz       + 6,435 - 6,515 GHz         + 6,435 - 6,515 GHz       + 6,435 - 6,515 GHz         + 6,335 - 6,647 GHz       + 6,435 - 6,515 GHz         + 6,335 - 6,647 GHz       + 6,435 - 6,515 GHz         • 6,802.11b: 1, 2, 5,5,111 Mbps       + 802.11a: max 300Mbps         + 802.11a: max 300Mbps       + 802.11a: max 300Mbps         + 802.11a: max 300Mbps       + 802.11a: max 2.46bps         Modulation       Direct Sequence Spread Spectrum         OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM         - 1024QAM       + IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         + AES-CCMP: 128 bit in hardware       + 802.13.1. WPA-PSK, WPA2-PSK, TKIP, and AES.         • WPA2 certification       + IEEE 802.1.1         • WPA2 certification       <  |   | IEEE 802.11i                         |  |
| IEEE 802.11v         Interoperability       Wi-Ficertified         Frequency Band       802.11b/g/n/ax         * 2.402 - 2.482 GHz       802.11a/n/ac/ax         * 4.9 - 4.95 GHz (Japan)       * 5.15 - 5.25 GHz         * 5.25 - 5.35 GHz       * 5.25 - 5.35 GHz         * 5.25 - 5.35 GHz       * 5.47 - 5.725 GHz         * 5.825 - 5.850 GHz       * 5.825 - 5.850 GHz         * 6.355 - 6.875 GHz       * 6.355 - 6.875 GHz         * 6.355 - 6.875 GHz       * 6.385 - 7.115 GHz         * 6.355 - 6.875 GHz       * 6.895 - 7.115 GHz         * 6.355 - 6.875 GHz       * 6.895 - 7.115 GHz         * 802.117: 1.2, 5.5, 11 Mbps       * 802.117: 6.9, 12, 18, 24, 36, 48, 54 Mbps         * 802.117: c. 9, 12, 18, 24, 36, 48, 54 Mbps       * 802.117: max 300Mbps         * 802.118: max 3.04Gbps       * 802.113: max 3.04Gbps         Modulation       Direct Sequence Spread Sprectrum         OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM       .1024QAM         Security <sup>2</sup> * IEEE and WFI compliant 64 / 128 bit WEP encryption for a/b/g mode only         * AES-CCMP: 128 bit in hardware       * 802.118         * 802.118: tit 200       * WPA2 certification         * WPA2 certification       * WPA2         * WPA2 certification       * WPA2         * WPA2 certif  |   | IEEE 802.11k                         |  |
| IEEE 802.11v         Interoperability       Wi-Ficertified         Frequency Band       802.11b/g/n/ax         * 2.402 - 2.482 GHz       802.11a/n/ac/ax         * 4.9 - 4.95 GHz (Japan)       * 5.15 - 5.25 GHz         * 5.25 - 5.35 GHz       * 5.25 - 5.35 GHz         * 5.25 - 5.35 GHz       * 5.47 - 5.725 GHz         * 5.825 - 5.850 GHz       * 5.825 - 5.850 GHz         * 6.355 - 6.875 GHz       * 6.355 - 6.875 GHz         * 6.355 - 6.875 GHz       * 6.385 - 7.115 GHz         * 6.355 - 6.875 GHz       * 6.895 - 7.115 GHz         * 6.355 - 6.875 GHz       * 6.895 - 7.115 GHz         * 802.117: 1.2, 5.5, 11 Mbps       * 802.117: 6.9, 12, 18, 24, 36, 48, 54 Mbps         * 802.117: c. 9, 12, 18, 24, 36, 48, 54 Mbps       * 802.117: max 300Mbps         * 802.118: max 3.04Gbps       * 802.113: max 3.04Gbps         Modulation       Direct Sequence Spread Sprectrum         OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM       .1024QAM         Security <sup>2</sup> * IEEE and WFI compliant 64 / 128 bit WEP encryption for a/b/g mode only         * AES-CCMP: 128 bit in hardware       * 802.118         * 802.118: tit 200       * WPA2 certification         * WPA2 certification       * WPA2         * WPA2 certification       * WPA2         * WPA2 certif  |   | IEEE 802.11r                         |  |
| Interoperability Wi-Fi certified<br>Frequency Band 802.11b/g/n/ax<br>+ 2.402 - 2.482 CHz<br>802.11a/n/ac/ax<br>+ 4.9 - 4.95 CHz<br>802.11a/n/ac/ax<br>+ 4.9 - 4.95 CHz<br>+ 5.15 - 5.25 GHz<br>+ 5.25 - 5.35 GHz<br>+ 5.25 - 5.35 GHz<br>+ 5.855 - 6.415 GHz<br>+ 6.435 - 6.515 GHz<br>+ 6.435 - 6.515 GHz<br>+ 6.535 - 6.875 GHz<br>+ 6.535 - 6.875 GHz<br>+ 6.959 - 7.115 GHz<br>Data Rates 802.11b: 1, 2, 5.5, 11 Mbps<br>+ 802.11b: 1, 2, 5.5, 11 Mbps<br>+ 802.11b: 1, 2, 5.5, 11 Mbps<br>+ 802.11b: 1, 2, 5.4, 48, 54 Mbps<br>+ 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps<br>+ 802.11a: max 300Mbps<br>+ 802.11a: max 300Mbps<br>+ 802.11a: max 2.4Gbps<br>Modulation 0FOM, pPSK, QCK, 16-QAM, 64-QAM, 256-QAM<br>, 1024QAM<br>Security <sup>2</sup> + IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only<br>+ AES-CCMP: 128 bit in hardware<br>+ 802.11a: max 2.4Gbps<br>Modulation 0FOM, PSK, QPA-PSK, WPA2-PSK, TKIP, and AES.<br>+ WPA2 certification<br>+ WPA3 certification<br>+ WPA1<br>+ 002.11n H70(2/4GH2): + 14dBm minimum<br>+ 802.11n H70(2/4GH2): + 14dBm minimum   |   |                                      |  |
| Frequency Band       802.11b/g/n/ax         • 2.402 - 2.482 GHz       802.11a/n/ac/ax         • 4.9 - 4.95 GHz (Japan)       • 5.15 - 5.25 GHz         • 5.25 - 5.35 GHz       • 5.25 - 5.35 GHz         • 5.47 - 5.725 GHz       • 5.855 - 6.415 GHz         • 6.355 - 6.615 GHz       • 6.355 - 6.575 GHz         • 6.355 - 6.575 GHz       • 6.355 - 6.575 GHz         • 6.355 - 6.575 GHz       • 6.355 - 6.575 GHz         • 802.11b: 1, 2, 5.5, 11 Mbps       • 802.11b: 1, 2, 5.5, 11 Mbps         • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps       • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps         • 802.11a: max 2.460ps       • 802.11a: max 2.460ps         Modulation       Direct Sequence Spreat Spectrum         OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM       , 1024QAM         V24QAM       • IEEE and WFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware       • 802.11x: max 2.460ps         Security <sup>2</sup> • IEEE and WFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • WPA2 certification       • WPA3 certification         • WPA2 certification       • WPA3 certification         • WPA3 certification       • WPA3 certification         • WPA1 UP Power <sup>3</sup> • 802.11b: +17dBm minimum         • 802.11b: +17dBm minimum       • 8  | Interoperability  |                                      |  |
| <ul> <li>2.402 - Ž.482 GHz</li> <li>B02.11a/n/ac/ax</li> <li>8.9 - 4.95 GHz (Japan)</li> <li>5.15 - 5.25 GHz</li> <li>5.47 - 5.725 GHz</li> <li>5.47 - 5.725 GHz</li> <li>5.47 - 5.725 GHz</li> <li>5.485 - 5.850 GHz</li> <li>5.49 - 5.55 GHz</li> <li>6.435 - 6.515 GHz</li> <li>6.435 - 6.515 GHz</li> <li>6.635 - 6.875 GHz</li> <li>6.025 - 7.115 GHz</li> <li>6.635 - 7.115 GHz</li> <li>6.025 - 7.115 GHz</li> <li>802.110; fl, 2, 1, 2, 1, 2, 4, 3, 6, 48, 54 Mbps</li> <li>802.111; max 300Mbps</li> <li>802.111a; (T33Mbps)</li> <li>802.111a; (T34Mbps)</li> <li>802.111b; (T36Bbps)</li> <li>802.111b; (T36Bbps)</li> <li< th=""><th></th><th></th></li<></ul>   |   |                                      |  |
| 802.113/n/ac/ax           • 4.9 - 4.95 GHz (Japan)           • 5.15 - 5.25 GHz           • 5.25 - 5.35 GHz           • 5.25 - 5.35 GHz           • 5.47 - 5.725 GHz           • 5.825 - 5.850 GHz           • 5.825 - 5.850 GHz           • 5.825 - 5.850 GHz           • 5.825 - 6.415 GHz           • 6.535 - 6.675 GHz           • 6.535 - 6.875 GHz           • 6.895 - 7.115 GHz           • 6.895 - 7.115 GHz           • 802.110: 1, 2, 5.5, 11 Mbps           • 802.111: 2, 5.5, 11 Mbps           • 802.111: 2, 13, 2, 43, 64, 85, 54 Mbps           • 802.111: (B, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.111: (B, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.111: (B, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.111: (B, 9, 12, 18, 24, 36, 49, 54 Mbps           • 802.111: (B, 9, 12, 18, 24, 36, 49, 54 Mbps           • 802.111: (B, 9, 12, 82, 43, 64, 94, 54 Mbps           • 802.111: (B, 9, 12, 82, 43, 64, 954 Mbps           • 802.111: (B, 9, 12, 82, 43, 64, 954 Mbps           • 802.111: (B, 92, 12, 82, 43, 64, 954 Mbps           • 802.111: (B, 92, 12, 82, 43, 64, 954 Mbps           • 802.111: (B, 92, 12, 82, 43, 64, 954 Mbps           • 802.111: (B, 92, 12, 82, 11, 82, 92, 64, 93, 94, 94, 954, 94, 954, 94, 954, 94, 954, 94, 954, 94, 954, 94, 954, 94, 954, 94, 94, 954, 94, 954, 94,  | Trequency Bana  |                                      |  |
| <ul> <li>4.9 – 4.95 GHz (Japan)</li> <li>5.15 – 5.25 GHz</li> <li>5.25 – 5.35 GHz</li> <li>5.825 – 5.850 GHz</li> <li>5.825 – 5.850 GHz</li> <li>5.955 – 6.415 GHz</li> <li>6.435 – 6.515 GHz</li> <li>6.635 – 6.515 GHz</li> <li>6.895 – 7.115 GHz</li> <li>6.895 – 7.115 GHz</li> <li>802.110: 1, 2, 55, 11 Mbps</li> <li>802.1110: 1, 2, 55, 11 Mbps</li> <li>802.1110: 1, 2, 55, 11 Mbps</li> <li>802.1110: 1, 2, 55, 11 Mbps</li> <li>802.1111: 173 Mbps</li> <li>802.1111: max 300Mbps</li> <li>802.1111: max 300Mbps</li> <li>802.1111: max 300Mbps</li> <li>802.1111: 173 Mbps</li> <li>802.1112: 128 bit in Mardware</li> <li>802.112 K, 0PSK, CUK, 16-QAM, 64-QAM, 256-QAM</li> <li>1024QAM</li> <li>Security<sup>2</sup></li> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>4E5-CCMP: 128 bit in hardware</li> <li>802.112: 128 bit in Ardware</li> <li>802.113: max 2:405ps</li> <li>802.114: max</li> <li>WPA2 certification</li> <li>WPA3 certification</li> <li>WEA3 certification</li> <li>WEE 802.111</li> <li>WAPI</li> <li>Madels</li> <li>Infrastructure (Access Point Required)</li> <li>Roaming</li> <li>IEEE 802.111</li> <li>902.110: 117dBm minimum</li> <li>802.111 HT20(2:4GHz): ±14dBm minimum</li> </ul>  |   |                                      |  |
| • 5.15 - 5.25 GHz           • 5.25 - 5.35 GHz           • 5.25 - 5.25 GHz           • 5.825 - 5.850 GHz           • 5.825 - 5.850 GHz           • 6.435 - 6.515 GHz           • 6.535 - 6.875 GHz           • 6.895 - 7.115 GHz           • 6.895 - 7.115 GHz           • 6.895 - 7.115 GHz           • 802.110; 1, 2, 5.5, 11 Mbps           • 802.111; 2, 5.5, 11 Mbps           • 802.111; 3, 5.5, 11 Mbps           • 802.111; 3, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.111; 3, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.111; 3, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.111; 3000ps           • 802.112; 1733Mbps           • 802.113; 3000ps           • 802.113; 3000ps           • 802.114; 30000ps           • 802.111; 30000ps           • 802.112; 81000000000000000000000000000000000000  |   |                                      |  |
| • 5.25 - 5.35 GHz           • 5.47 - 5.725 GHz           • 5.825 - 5.850 GHz           • 5.825 - 5.850 GHz           • 6.435 - 6.515 GHz           • 6.435 - 6.515 GHz           • 6.353 - 6.875 GHz           • 6.895 - 7.115 GHz           • 6.895 - 7.115 GHz           • 802.110: 1, 2, 55, 11 Mbps           • 802.113: 6, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.113: 6, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.113: 6, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.111: max 300Mbps           • 802.112: 1733Mbps           • 802.113: 0, 91, 2, 18, 24, 36, 48, 54 Mbps           • 802.113: max 2.4Gbps           Modulation           Direct Sequence Spread Spectrum           OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM           · 1024QAM           Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only           • AES-CCMP: 128 bit in hardware           • 802.113: wWPA-PSK, WPA2-PSK, TKIP, and AES.           • WPA2 certification           • WPA2 certification           • WPA2 certification           • WPA2 certification           • IEEE 802.11           • WPA2           • Map           Reaming  |   |                                      |  |
| <ul> <li>S.47 – 5.725 GHz</li> <li>S.825 – 5.850 GHz</li> <li>S.955 – 6.415 GHz</li> <li>6.435 – 6.515 GHz</li> <li>6.6395 – 7.115 GHz</li> <li>6.6395 – 7.115 GHz</li> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.110: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.111: max 300Mbps</li> <li>802.112: 1738 Mbps</li> <li>802.112: 128 bit where with a start was a start w</li></ul>  |   |                                      |  |
| • 5.825 - 5.850 GHz• 5.955 - 6.415 GHz• 6.435 - 6.515 GHz• 6.535 - 6.875 GHz• 802.11b: 1, 2, 5.5, 11 Mbps• 802.11b: 1, 2, 5.5, 11 Mbps• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps• 802.11a: 1733Mbps• 802.11a: 10000000000000000000000000000000000  |   |                                      |  |
| • 5.955 - 6.415 GHz• 6.435 - 6.515 GHz• 6.535 - 6.875 GHz• 6.895 - 7.115 GHz• 802.11b: 1, 2, 5.5, 11 Mbps• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps• 802.11a: 30 Mbps• 802.11a: 1733 Mbps• 1EEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only• AE5-CCMP: 128 bit in hardware• 802.1x authentication• WPA2 certification• WPA2 certification• WPA2 certification• WPA2 certification• IEEE 802.11• WPA1Network ArchitectureModelsInfrastructure (Access Point Required)Roaming0utput Power <sup>3</sup> • 802.11b: +17dBm minimum• 802.11b: +17dBm minimum• 802.11b: +17dBm minimum• 802.11h HT20(2.4GHz): +14dBm minimum   |   |                                      |  |
| • 6.435 - 6.515 GHz• 6.535 - 6.875 GHz• 6.895 - 7.115 GHzData Rates• 802.11b: 1, 2, 5.5, 11 Mbps• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps• 802.11a: max 300Mbps• 802.11a: max 2.4GbpsModulationDirect Sequence Spread SpectrumOFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAMSecurity²• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only• AES-CCMP: 128 bit in hardware• 802.11a: way 2.400.11x: way 2.400.11x• WPA, WPA2: 802.11x. WPA-PSK, WPA2-PSK, TKIP, and AES.• WPA3 certification• WPA3 certification• IEEE 802.11i• WAP1ModelsRoamingOutput Power³• 802.11a: +17dBm minimum• 802.11a: +17dBm minimum• 802.11a: HT20(2.4GHz): +14dBm minimum• 802.11n HT20(2.4GHz): +14dBm minimum• 802.11n HT20(2.4GHz): +14dBm minimum   |   |                                      |  |
| • 6.535 - 6.875 GHz         • 6.895 - 7.115 GHz         • 802.11b: 1, 2, 5.5, 11 Mbps         • 802.11a: G, 9, 12, 18, 24, 36, 48, 54 Mbps         • 802.11a: G, 9, 12, 18, 24, 36, 48, 54 Mbps         • 802.11a: max 300Mbps         • 802.11a: max 2.46bps         Modulation         Direct Sequence Spread Spectrum         OFDM, BPSK, OPSK, CCK, 16-QAM, 64-QAM, 256-QAM         .1024QAM         Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware         • 802.11a: max 2.46bps         WPA         VPA2: PSK, TKIP, and AES.         • WPA2: certification         • WPA2: certification         • WPA3 certification         • WPA3 certification         • WPA3         Network Architecture         Models         Infrastructure (Access Point Required)         Roaming         IEEE 802.11 compliant roaming between access points         Output Power <sup>3</sup> • 802.119: +17dBm minimum         • 802.119: +17dBm minimum         • 802.110: HT20(2.4GHz): +14dBm minimum         • 802.110: HT20(2.4GHz): +14dBm minimum         • 802.110: HT20(2.4GHz): +14dBm minimum         • 802.110   |   |                                      |  |
| • 6.895 - 7.115 GHz         Data Rates       • 802.11b: 1, 2, 5.5, 11 Mbps         • 802.113: 6, 9, 12, 18, 24, 36, 48, 54 Mbps       • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps         • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps       • 802.11a: 1733Mbps         • 802.11a: 1733Mbps       • 802.11a: max 2.4Gbps         Modulation       Direct Sequence Spread Spectrum         OFDM, BP5K, QP5K, CCK, 16-QAM, 64-QAM, 256-QAM         , 1024QAM         Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware         • 802.11x unbentication         • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.         • WPA wPA2: certification         • WPA3 certification         • WPA3 certification         • WPA4         • WPA1         Network Architecture         Models         Roaming         UEEE 802.111 compliant roaming between access points         Output Power <sup>3</sup> • 802.110: +17dBm minimum         • 802.110: +17dBm minimum         • 802.110: HT402(X-GH2): +14dBm minimum         • 802.110: HT402(X-GH2): +14dBm minimum         • 802.110: HT20(S-GH2): +14dBm minimum   |   |                                      |  |
| Data Rates• 802.11b: 1, 2, 5.5, 11 Mbps<br>• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps<br>• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps<br>• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps<br>• 802.11a: max 2.4GbpsModulationDirect Sequence Spread Spectrum<br>OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM<br>, 1024QAMSecurity2• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only<br>• AES-CCMP: 128 bit in hardware<br>• 802.11a: at authentication<br>• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.<br>• WPA2 certification<br>• WPA3 certification<br>• IEEE 802.111<br>• WAPINetwork Architecture<br>ModelsAd-hoc (Peer to Peer)<br>Infrastructure (Access Point Required)<br>Infrastructure (Access Point Required)<br>• 802.11b: ±17dBm minimum<br>• 802.11b: ±17dBm minimum<br>• 802.11n HT20(2.4GHz): ±13dBm minimum<br>• 802.11n HT20(2.4GHz): ±13dBm minimum<br>• 802.11n HT20(5GHz): ±14dBm minimum   |   |                                      |  |
| • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps• 802.11a: max 300Mbps• 802.11a: max 30Mbps• 802.11a: max 2.4GbpsModulationDirect Sequence Spread Spectrum<br>OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM<br>, 1024QAMSecurity2• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only<br>• AES-CCMP: 128 bit in hardware<br>• 802.11x authentication<br>• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.<br>• WPA2 certification<br>• IEEE 802.11i<br>• WAPINetwork Architecture<br>ModelsModelsInfrastructure (Access Point Required)<br>• 802.11b: +17dBm minimum<br>• 802.11b: +17dBm minimum<br>• 802.11n HT20(2.4GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum  | Data Rates  |                                      |  |
| • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps         • 802.11n: max 300Mbps         • 802.11a:: max.24Gbps         Modulation         Direct Sequence Spread Spectrum         OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM         , 1024QAM         Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware         • 802.11a:         • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.         • WPA2 certification         • WPA3 certification         • WPA2 certification         • WAP1         Models         Infrastructure (Access Point Required)         Roaming         Output Power <sup>3</sup> • 802.11b: +17dBm minimum         • 802.11a: +17dBm minimum         • 802.11n HT20(2.4GHz): +13dBm minimum         • 802.11n HT20(2.4GHz): +13dBm minimum         • 802.11n HT20(2.4GHz): +13dBm minimum   |   |                                      |  |
| • 802.11n: max 300Mbps<br>• 802.11a:: 1733Mbps<br>• 802.11a:: 1733Mbps<br>• 802.11a:: max 2.4GbpsModulationDirect Sequence Spread Spectrum<br>OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM<br>, 1024QAMSecurity2• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only<br>• AES-CCMP: 128 bit in hardware<br>• 802.11x authentication<br>• WPA, WPA2: 802.11x. WPA-PSK, WPA2-PSK, TKIP, and AES.<br>• WPA2 certification<br>• IEEE 802.11i<br>• WPA3 certification<br>• IEEE 802.11i<br>• WAPINetwork ArchitectureAd-hoc (Peer to Peer)<br>Infrastructure (Access Point Required)RoamingIEEE 802.11 compliant roaming between access pointsOutput Power3• 802.11g: +16dBm minimum<br>• 802.11n HT20(2.4GHz): +13dBm minimum<br>• 802.11n HT40(2.4GHz): +13dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum  |   |                                      |  |
| • 802.11ac: 1733Mbps         • 802.11ax: max 2.4Gbps         Modulation         Direct Sequence Spread Spectrum         OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM         , 1024QAM         Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware         • 802.1x authentication         • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.         • WPA3 certification         • WPA3 certification         • WPA3 certification         • IEEE 802.11i         • WAPI         Network Architecture         Models         Infrastructure (Access Point Required)         Infrastructure (Access Point Required)         0utput Power <sup>3</sup> • 802.11b: +17dBm minimum         • 802.11g: +16dBm minimum         • 802.11g: +16dBm minimum         • 802.11g: +16dBm minimum         • 802.11h HT20(2.4GHz): +14dBm minimum         • 802.11h HT40(2.4GHz): +14dBm minimum         • 802.11h HT40(2.4GHz): +14dBm minimum         • 802.11h HT40(2.4GHz): +14dBm minimum  |   |                                      |  |
| • 802.11ax: max 2.4Gbps         Modulation       Direct Sequence Spread Spectrum<br>OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM<br>, 1024QAM         Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only<br>• AES-CCMP: 128 bit in hardware<br>• 802.1x authentication<br>• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.<br>• WPA2 certification<br>• WPA3 certification<br>• IEEE 802.11i<br>• WAPI         Network Architecture<br>Models       Ad-hoc (Peer to Peer)<br>Infrastructure (Access Point Required)         Roaming       IEEE 802.11 compliant roaming between access points         Output Power <sup>3</sup> • 802.11b: +17dBm minimum<br>• 802.11b: H7dBm minimum<br>• 802.11h HT20(2.4GHz): +14dBm minimum<br>• 802.11h HT40(2.4GHz): +13dBm minimum<br>• 802.11h HT40(2.4GHz): +14dBm minimum<br>• 802.11h HT40(2.4GHz): +14dBm minimum<br>• 802.11h HT40(2.4GHz): +14dBm minimum  |   |                                      |  |
| Modulation       Direct Sequence Spread Spectrum         OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM         , 1024QAM         Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware       • 802.1 x authentication         • WPA, WPA2: 802.1 x. WPA-PSK, WPA2-PSK, TKIP, and AES.         • WPA2 certification       • IEEE 802.11i         • WPA3 certification       • IEEE 802.11i         • WAPI       Ad-hoc (Peer to Peer)         Models       Infrastructure (Access Point Required)         Roaming       IEEE 802.11 compliant roaming between access points         Output Power <sup>3</sup> • 802.11b: +17dBm minimum         • 802.11b: +17dBm minimum       • 802.11a: +17dBm minimum         • 802.11n HT20(2.4GHz): +14dBm minimum       • 802.11n HT20(2.4GHz): +14dBm minimum   |   |                                      |  |
| OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM         .1024QAM         Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware         • 802.1x authentication         • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.         • WPA2 certification         • WPA3 certification         • WPA3 certification         • IEEE 802.111         • WAPI         Network Architecture         Models         Infrastructure (Access Point Required)         Roaming         IEEE 802.11:         • 802.11b: +17dBm minimum         • 802.11b: +17dBm minimum         • 802.11b: +17dBm minimum         • 802.11n HT20(2.4GHz): +14dBm minimum         • 802.11n HT20(2.4GHz): +14dBm minimum   | Modulation  |                                      |  |
| , 1024QAM         Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware       • 802.1x authentication         • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.       • WPA2 certification         • WPA2 certification       • WPA3 certification         • WPA3 certification       • IEEE 802.11i         • WAPI       Ad-hoc (Peer to Peer)         Models       Infrastructure (Access Point Required)         Roaming       IEEE 802.111 compliant roaming between access points         Output Power <sup>3</sup> • 802.11b: +17dBm minimum         • 802.11g: +16dBm minimum       • 802.11g: +16dBm minimum         • 802.11n HT20(2.4GHz): +14dBm minimum       • 802.11n HT20(5GHz): +14dBm minimum   | Fiodulation   |                                      |  |
| Security <sup>2</sup> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only         • AES-CCMP: 128 bit in hardware       • 802.1x authentication         • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.       • WPA2 certification         • WPA2 certification       • WPA3 certification         • WPA3 certification       • IEEE 802.11i         • WAPI       Ad-hoc (Peer to Peer)         Models       Infrastructure (Access Point Required)         Output Power <sup>3</sup> • 802.11b: +17dBm minimum         • 802.11n HT20(2.4GHz): +14dBm minimum         • 802.11n HT20(5GHz): +14dBm minimum  |   |                                      |  |
| <ul> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>WPA3 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> <li>Network Architecture</li> <li>Ad-hoc (Peer to Peer)</li> <li>Infrastructure (Access Point Required)</li> <li>Roaming</li> <li>IEEE 802.11 compliant roaming between access points</li> <li>0utput Power<sup>3</sup></li> <li>802.11b: +17dBm minimum</li> <li>802.11b: +17dBm minimum</li> <li>802.11a: +17dBm minimum</li> <li>802.11n HT20(2.4GHz): +14dBm minimum</li> <li>802.11n HT20(5GHz): +14dBm minimum</li> </ul>  | Security <sup>2</sup>   |                                      |  |
| <ul> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>WPA3 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> <li>Network Architecture</li> <li>Ad-hoc (Peer to Peer)</li> <li>Infrastructure (Access Point Required)</li> <li>Ifrastructure (Access Point Required)</li> <li>802.11b: +17dBm minimum</li> <li>802.11g: +16dBm minimum</li> <li>802.11a: +17dBm minimum</li> <li>802.11a: +17dBm minimum</li> <li>802.11n HT20(2.4GHz): +14dBm minimum</li> <li>802.11n HT40(2.4GHz): +14dBm minimum</li> </ul>   |   |                                      |  |
| <ul> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>WPA3 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> <li>Network Architecture</li> <li>Ad-hoc (Peer to Peer)</li> <li>Infrastructure (Access Point Required)</li> <li>Roaming</li> <li>IEEE 802.11 compliant roaming between access points</li> <li>Output Power<sup>3</sup></li> <li>802.11 b: +17dBm minimum</li> <li>802.11 g: +16dBm minimum</li> <li>802.11 a: +17dBm minimum</li> <li>802.11 n HT20(2.4GHz): +14dBm minimum</li> <li>802.11 n HT40(2.4GHz): +14dBm minimum</li> <li>802.11 n HT40(2.4GHz): +14dBm minimum</li> </ul>  |   |                                      |  |
| • WPA2 certification• WPA3 certification• WPA3 certification• IEEE 802.11i• WAPINetwork ArchitectureAd-hoc (Peer to Peer)Infrastructure (Access Point Required)RoamingIEEE 802.11 compliant roaming between access pointsOutput Power <sup>3</sup> • 802.11b: +17dBm minimum• 802.11g: +16dBm minimum• 802.11a: +17dBm minimum• 802.11a: +17dBm minimum• 802.11n HT20(2.4GHz): +14dBm minimum• 802.11n HT40(2.4GHz): +14dBm minimum• 802.11n HT20(5GHz): +14dBm minimum   |   |                                      |  |
| • IEEE 802.11i<br>• WAPINetwork ArchitectureAd-hoc (Peer to Peer)<br>Infrastructure (Access Point Required)ModelsInfrastructure (Access Point Required)RoamingIEEE 802.11 compliant roaming between access pointsOutput Power³• 802.11b: +17dBm minimum<br>• 802.11g: +16dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11n HT20(2.4GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum  |   |                                      |  |
| • WAPINetwork ArchitectureAd-hoc (Peer to Peer)<br>Infrastructure (Access Point Required)RoamingIEEE 802.11 compliant roaming between access pointsOutput Power³• 802.11b: +17dBm minimum<br>• 802.11g: +16dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11n HT20(2.4GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum   |   | WPA3 certification                   |  |
| Network ArchitectureAd-hoc (Peer to Peer)ModelsInfrastructure (Access Point Required)RoamingIEEE 802.11 compliant roaming between access pointsOutput Power <sup>3</sup> • 802.11b: +17dBm minimum<br>• 802.11g: +16dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11n HT20(2.4GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum  |   | • IEEE 802.11i                       |  |
| ModelsInfrastructure (Access Point Required)RoamingIEEE 802.11 compliant roaming between access pointsOutput Power³• 802.11b: +17dBm minimum<br>• 802.11g: +16dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11n HT20(2.4GHz): +14dBm minimum<br>• 802.11n HT20(2.4GHz): +13dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum   |   |                                      |  |
| ModelsInfrastructure (Access Point Required)RoamingIEEE 802.11 compliant roaming between access pointsOutput Power³• 802.11b: +17dBm minimum<br>• 802.11g: +16dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11n HT20(2.4GHz): +14dBm minimum<br>• 802.11n HT20(2.4GHz): +13dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum   | Network Architecture  | Ad-hoc (Peer to Peer)                |  |
| RoamingIEEE 802.11 compliant roaming between access pointsOutput Power³• 802.11b: +17dBm minimum<br>• 802.11g: +16dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11a: +17dBm minimum<br>• 802.11n HT20(2.4GHz): +14dBm minimum<br>• 802.11n HT40(2.4GHz): +13dBm minimum<br>• 802.11n HT20(5GHz): +14dBm minimum   |   |                                      |  |
| Output Power <sup>3</sup> • 802.11b: +17dBm minimum           • 802.11g: +16dBm minimum           • 802.11g: +16dBm minimum           • 802.11a: +17dBm minimum           • 802.11n HT20(2.4GHz): +14dBm minimum           • 802.11n HT40(2.4GHz): +13dBm minimum           • 802.11n HT20(5GHz): +14dBm minimum  |   |                                      |  |
| <ul> <li>802.11g: +16dBm minimum</li> <li>802.11a: +17dBm minimum</li> <li>802.11n HT20(2.4GHz): +14dBm minimum</li> <li>802.11n HT40(2.4GHz): +13dBm minimum</li> <li>802.11n HT20(5GHz): +14dBm minimum</li> </ul>  | Output Power <sup>3</sup>   |                                      |  |
| <ul> <li>802.11a: +17dBm minimum</li> <li>802.11n HT20(2.4GHz): +14dBm minimum</li> <li>802.11n HT40(2.4GHz): +13dBm minimum</li> <li>802.11n HT20(5GHz): +14dBm minimum</li> </ul>   | •   |                                      |  |
| <ul> <li>802.11n HT20(2.4GHz): +14dBm minimum</li> <li>802.11n HT40(2.4GHz): +13dBm minimum</li> <li>802.11n HT20(5GHz): +14dBm minimum</li> </ul>  |   |                                      |  |
| <ul> <li>802.11n HT40(2.4GHz): +13dBm minimum</li> <li>802.11n HT20(5GHz): +14dBm minimum</li> </ul>  |   |                                      |  |
| • 802.11n HT20(5GHz): +14dBm minimum  |   |                                      |  |
|   |   |                                      |  |
| • 8U2.   I D H   4U(5GHZ); +   30BM MINIMIM   |   | • 802.11n HT40(5GHz): +13dBm minimum |  |



|                                      | • 802.11ac VHT80(5GHz): +10dBm minimum  |
|--------------------------------------|---|
|                                      | • 802.11ac VHT160(5GHz): +10dBm minimum   |
|                                      | • 802.11ax HE40(2.4GHz): +12dBm minimum   |
|                                      | • 802.11ax HE80(5GHz): +10dBm minimum   |
|                                      | • 802.11ax HE160(5GHz): +10dBm minimum  |
| Power Consumption                    | • Transmit mode 2.0 W   |
|                                      | Receive mode 1.6 W  |
|                                      | <ul> <li>Idle mode (PSP) 180 mW (WLAN Associated)</li> </ul>                            |
|                                      | <ul> <li>Idle mode 50 mW (WLAN unassociated)</li> </ul>                                 |
|                                      | Connected Standby 10mW  |
|                                      | Radio disabled 8 mW   |
| Power Management                     | ACPI and PCI Express compliant power management   |
|                                      | 802.11 compliant power saving mode  |
| Receiver Sensitivity <sup>4</sup>    | •802.11b, 1Mbps: -93.5dBm maximum   |
|                                      | •802.11b, 11Mbps: -84dBm maximum  |
|                                      | • 802.11a/g, 6Mbps: -86dBm maximum  |
|                                      | • 802.11a/g, 54Mbps: -72dBm maximum   |
|                                      | • 802.11n, MCS07: -67dBm maximum  |
|                                      | • 802.11n, MCS15: -64dBm maximum  |
|                                      | • 802.11ac, MCS0(VHT80): -84dBm maximum   |
|                                      | • 802.11ac, MCS9(VHT80): -59dBm maximum   |
|                                      | • 802.11ac, MCS9(VHT160): -58.5dBm maximum  |
|                                      | •802.11ax, MCS11(HE40): -57dBm maximum  |
|                                      | •802.11ax, MCS11(HE80): -54dBm maximum  |
|                                      | •802.11ax, MCS11(HE160): -53.5dBm maximum   |
| Antenna type                         | High efficiency antenna with spatial diversity, mounted in the display enclosure        |
|                                      |   |
|                                      | Two embedded dual band 2.4/5/6 GHz antennas are provided to the card to support WLAN    |
|                                      | MIMO communications and Bluetooth communications  |
| Form Factor                          | PCI-Express M.2 MiniCard  |
| Dimensions                           | 1. Type 2230: 2.3 x 22.0 x 30.0 mm  |
|                                      | 2. Type 1216: 1.67 x 12.0 x 16.0 mm   |
| Weight                               | 1. Type 2230: 2.8g  |
|                                      | 2. Type 1216: 1.3g  |
| Operating Voltage                    | 3.3v +/- 9%   |
| Temperature                          | Operating: 14° to 158° F (–10° to 70° C)  |
|                                      | Non-operating: –40° to 176° F (–40° to 80° C)   |
| Humidity                             | Operating: 10% to 90% (non-condensing)  |
|                                      | Non-operating: 5% to 95% (non-condensing)   |
| Altitude                             | Operating: 0 to 10,000 ft (3,048 m)   |
|                                      | Non-operating: 0 to 50,000 ft (15,240 m)  |
| LED Activity                         | LED Amber – Radio OFF; LED OFF – Radio ON   |
|                                      | etooth® 4.0/4.1/4.2/5.0/5.1/5.2 /5.3 wireless card Technology                           |
| Bluetooth <sup>®</sup> Specification | 4.0/4.1/4.2/5.0/5.1/5.2/5.3 wireless card Compliant                                     |
| requency Band                        | 2402 to 2480 MHz  |
| Number of Available Channels         | Legacy: 0~79 (1 MHz/CH)   |
|                                      | BLE: 0~39 (2 MHz/CH)  |
| Data Rates and Throughput            | Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps                                    |
| vata Nates anu Thiouynput            | BLE: 1 Mbps data rate; throughput up to 0.2 Mbps  |
|                                      | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels          |
|                                      | Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or |
|                                      | 864 kbps symmetric (3-EV5)  |
|                                      |   |

## Technical Specifications – Networking

| Transmit Power   | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR. |  |
|--|---|--|
| Power Consumption  | Peak (Tx): 330 mW   |  |
|  | Peak (Rx): 230 mW   |  |
|  | Selective Suspend: 17 mW  |  |
| Bluetooth <sup>®</sup> Software Supported<br>Link Topology | Microsoft Windows Bluetooth Software  |  |
| Power Management   | Microsoft Windows ACPI, and USB Bus Support   |  |
| Certifications   | FCC (47 CFR) Part 15C, Section 15.247 & 15.249  |  |
| Power Management<br>Certifications                         | ETS 300 328, ETS 300 826  |  |
|  | Low Voltage Directive IEC950  |  |
|  | UL, CSA, and CE Mark  |  |
| Bluetooth <sup>®</sup> Profiles Supported                  | BT4.1-ESR 5/6/7 Compliance  |  |
|  | LE Link Layer Ping  |  |
|  | LE Dual Mode  |  |
|  | LE Link Layer   |  |
|  | LE Low Duty Cycle Directed Advertising  |  |
|  | LE L2CAP Connection Oriented Channels   |  |
|  | Train Nudging & Interlaced Scan   |  |
|  | BT4.2 ESR08 Compliance  |  |
|  | LE Secure Connection- Basic/Full  |  |
|  | LE Privacy 1.2 –Link Layer Privacy  |  |
|  | LE Privacy 1.2 –Extended Scanner Filter Policies  |  |
|  | LE Data Packet Length Extension   |  |
|  | FAX Profile (FAX)   |  |
|  | Basic Imaging Profile (BIP)2  |  |
|  | Headset Profile (HSP)   |  |
|  | Hands Free Profile (HFP)  |  |
|  | Advanced Audio Distribution Profile (A2DP)  |  |
|  | BT5.2   |  |
|  | ESR9/10 Compliance  |  |
|  | LE Advertisement Extensions   |  |
|  | Channel Selection Algo  |  |
|  | Limited High Duty Cycle Non-Connectable Advertising   |  |
|  | 2Mbps LE  |  |
|  | LE Long Range   |  |

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. Usage of the 6GHz band relies on Windows 11 Operating System support.



### I/O DEVICES

| HP Business Slim Standal | one USB/PS2 Wired Keyboard     |   |  |  |
|--------------------------|--------------------------------|---|--|--|
| Physical Characteristics | Keys                           | 104, 105, 106, 107, 109 layout (depending upon country)           |  |  |
|                          | Dimensions<br>(L x W x H)      | 171.97 x 68.35 x 8.27 in (436.8± 1.5 x 137.6± 1.0 x 21.0± 1.0 cm) |  |  |
|                          | Weight                         | 1.32 lb (0.6± 0.08 kg)  |  |  |
| Electrical               | Operating voltage              | 4.4-5.25VDC   |  |  |
|                          | Power consumption              | 50-mA maximum (with 5 VDC power supplied and three LEDs ON)/      |  |  |
|                          | System interface               | USB or PS/2   |  |  |
|                          | ESD                            | Contact Discharge: 2, 4,6,8KV<br>Air Discharge: 2, 4, 8,10,12.5KV |  |  |
|                          | EMI – RFI                      | Conforms to FCC rules for a Class B computing device              |  |  |
| Mechanical               | Keycaps                        | Low-profile design  |  |  |
|                          | Switch actuation               | 60±12.5g nominal peak force with tactile feedback                 |  |  |
|                          | Switch life                    | 10 million keystrokes (Life tester)                               |  |  |
|                          | Switch type                    | Contamination-resistant switch membrane                           |  |  |
|                          | Key-leveling mechanisms        | For all double-wide and greater-length keys                       |  |  |
|                          | Cable length                   | 6 ft (1.8 m)  |  |  |
| Environmental            | Acoustics                      | 43-dBA maximum sound pressure level                               |  |  |
|                          | Operating temperature          | 50° to 122° F (10° to 50° C)                                      |  |  |
|                          | Non-operating temperature      | Minus 30 degress to 60 degress Celsius                            |  |  |
|                          | Operating humidity             | 10% to 90% (non-condensing at ambient)                            |  |  |
|                          | Non-operating humidity         | 20% to 80% (non-condensing at ambient)                            |  |  |
|                          | Operating shock                | 40 g, six surfaces  |  |  |
|                          | Non-operating shock            | 80 g, six surfaces  |  |  |
|                          | Operating vibration            | 2-g peak acceleration   |  |  |
|                          | Non-operating vibration        | 4-g peak acceleration   |  |  |
|                          | Drop (out of box)              | 26 in (66 cm) on carpet, six-drop sequence                        |  |  |
|                          | Drop (in box)                  | 30 in (76.2 cm) on concrete, 16-drop sequence                     |  |  |
| Approvals                | UL, FCC, CE Mark, TUV GS, VCCI | UL, FCC, CE Mark, TUV GS, VCCI, BSMI, RCM, KCC                    |  |  |
| Ergonomic compliance     | ANSI HFS 100, ISO 9241-4, and  | ANSI HFS 100, ISO 9241-4, and TUVGS                               |  |  |



| HP USB Business Slim Wire | ed SmartCard CCID Keyboard     |  |  |
|---------------------------|--------------------------------|--|--|
| Physical Characteristics  | Keys                           | 104, 105, 107, 109 layout (depending upon country)   |  |
|                           | Dimensions<br>(L x W x H)      | 17.34 x 5.68 x 0.78in (440.6 x 144.5 x 1.98 cm)      |  |
|                           | Weight                         | 1.32 lb (598g)                                       |  |
| Electrical                | Operating voltage              | 5 VDC, +/-5%   |  |
|                           | Power consumption              | 100mA (All LED on)                                   |  |
|                           | System interface               | USB Type A plug connector                            |  |
|                           | ESD                            | Contact Discharge: 8 KV Air Discharge: 12.5 KV       |  |
|                           | EMI - RFI                      | Conforms to FCC rules for a Class B computing device |  |
| Mechanical                | Кеусарѕ                        | Low-profile design                                   |  |
|                           | Switch actuation               | 60±10g nominal peak force with tactile feedback      |  |
|                           | Switch life                    | 10 million keystrokes (Life tester)                  |  |
|                           | Switch type                    | Contamination-resistant switch membrane              |  |
|                           | Key-leveling mechanisms        | For all double-wide and greater-length keys          |  |
|                           | Cable length                   | 6 ft (1.8 m)   |  |
| Environmental             | Acoustics                      | 43-dBA maximum sound pressure level                  |  |
|                           | Operating temperature          | 50° to 122° F (10° to 50° C)                         |  |
|                           | Non-operating temperature      | -22° to 140° F (-30° to 60° C)                       |  |
|                           | Operating humidity             | 10% to 90% (non-condensing at ambient)               |  |
|                           | Non-operating humidity         | 20% to 80% (non-condensing at ambient)               |  |
|                           | Operating shock                | 40 g, six surfaces                                   |  |
|                           | Non-operating shock            | 80 g, six surfaces                                   |  |
|                           | Operating vibration            | 2-g peak acceleration                                |  |
|                           | Non-operating vibration        | 4-g peak acceleration                                |  |
|                           | Drop (out of box)              | 26 in (66 cm) on carpet, six-drop sequence           |  |
|                           | Drop (in box)                  | 30 in (76.2 cm) on concrete, 16-drop sequence        |  |
| Approvals                 | CE Marking, TUV, EAC, FCC, cUL | us/CSAus, ICES, RCM, VCCI, KCC, BSMI                 |  |
| Ergonomic compliance      | ISO 9241-4, TUVGS              |  |  |

| HP 125 (AntiMicrobial) Wi | red Keyboard (China only)           |  |  |  |
|---------------------------|-------------------------------------|--|--|--|
| Physical Characteristics  | Keys                                | 104/105/107/109layout (depending upon country)                               |  |  |
|                           | Dimensions<br>(L x W x H)           | 436 x 138 x24.7 mm   |  |  |
|                           | Weight                              | 471g   |  |  |
| Electrical                | Operating voltage                   | 5V +- 5%   |  |  |
|                           | Power consumption                   | 50mA   |  |  |
|                           | System interface                    | USB Type A plug connector  |  |  |
|                           | ESD                                 | Contact Discharge: 8 KV Air Discharge: 12.5 KV                               |  |  |
|                           | EMI - RFI                           | Conforms to FCC rules for a Class B computing device                         |  |  |
| Mechanical                | Keycaps                             | Low-profile design   |  |  |
|                           | Switch actuation                    | 55±10g nominal peak force with tactile feedback                              |  |  |
|                           | Switch life                         | 10 million keystrokes (Life tester)  |  |  |
|                           | Switch type                         | Contamination-resistant switch membrane                                      |  |  |
|                           | Key-leveling mechanisms             | For all double-wide and greater-length keys                                  |  |  |
|                           | Cable length                        | 1.8 m  |  |  |
| Environmental             | Acoustics                           | 43-dBA maximum sound pressure level  |  |  |
|                           | Operating temperature               | 50° to 122° F (10° to 50° C)   |  |  |
|                           | Non-operating temperature           | -4° to 149° F (-20° to 65° C)  |  |  |
|                           | Operating humidity                  | 10% to 95% (non-condensing at ambient)                                       |  |  |
|                           | Non-operating humidity              | 0% to 95% (non-condensing at ambient)  |  |  |
|                           | Operating shock                     | 40 g, six surfaces   |  |  |
|                           | Non-operating shock                 | 80 g, six surfaces   |  |  |
|                           | Operating vibration                 | 2-g peak acceleration  |  |  |
|                           | Non-operating vibration             | 4-g peak acceleration  |  |  |
|                           | Drop (out of box)                   | 26 in (66 cm) on carpet, six-drop sequence                                   |  |  |
|                           | Drop (in box)                       | 30 in (76.2 cm) on concrete, 16-drop sequence                                |  |  |
| Approvals                 | UL, cUL, FCC, CE, TUV GS, VCCI,     | UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, RCM, KCC, USB-IF, WHQL, EN/IEC 60601-1 |  |  |
| Ergonomic compliance      | ANSI HFS 100, ISO 9241-4, and TUVGS |  |  |  |

| HP 655 wireless Keyboard | 1   |  |  |
|--------------------------|---|--|--|
| Physical Characteristics | Keys  | 104, 105, 107,109 layouts                            |  |
|                          | Dimensions<br>(L x W x H)   | 16.86 x 4.55 x 0.71 in (428.22 x 115.47 x 18.06 mm)  |  |
|                          | Weight  | 0.96 lb (435g)                                       |  |
| Electrical               | Operating voltage   | 3 VDC, +/-5%   |  |
|                          | Power consumption   | 20 mA Max (All LED on)                               |  |
|                          | System interface  | 2.4GHz Wireless                                      |  |
|                          | ESD   | Contact Discharge: 8 KV Air Discharge: 15 KV         |  |
|                          | EMI - RFI   | Conforms to FCC rules for a Class B computing device |  |
| Mechanical               | Keycaps   | Plunger, 2.0 mm key travel                           |  |
|                          | Key actuation   | 60±10g nominal peak force with tactile feedback      |  |
|                          | Key life  | 10 million keystrokes (Life tester)                  |  |
|                          | Key structure type  | Rubber dome & Membrane                               |  |
|                          | Key-leveling mechanisms   | For all double-wide and greater-length keys          |  |
| Environmental            | Operating temperature   | 50° to 122° F (10° to 50° C)                         |  |
|                          | Non-operating temperature   | -22° to 140° F (-30° to 60° C)                       |  |
|                          | Operating humidity  | 10% to 90% (non-condensing at ambient)               |  |
|                          | Non-operating humidity  | 20% to 80% (non-condensing at ambient)               |  |
|                          | Operating shock   | 40 g, six surfaces                                   |  |
|                          | Non-operating shock   | 80 g, six surfaces                                   |  |
|                          | Operating vibration   | 2-g peak acceleration                                |  |
|                          | Non-operating vibration   | 4-g peak acceleration                                |  |
|                          | Drop (out of box)   | 26 in (66 cm) on carpet, six-drop sequence           |  |
|                          | Drop (in box)   | 30 in (76.2 cm) on concrete, 16-drop sequence        |  |
| Approvals                | CB, CE, FCC, CULus, ICES, IC, I TRC, TRA, CASA, UA, EAC, CNC, ANATEL, NOM-NYCE SCT, IFETEL, MPTC, RCM, BIS, PosTel, VCCI, TELEC, KC, MCMC, IDA, BSMI, NCC, DWLF&M, TP-BY, MOC |  |  |
| Ergonomic compliance     | TUVGS   |  |  |



| HP Wired Desktop 320K K<br>Physical Characteristics | Keys                           | 104, 105, 107  | 7 109 Javouts  |  |  |
|---|--------------------------------|--|--|--|--|
| •   | Dimensions(L x W x H)          | 18.86*4.55*0.66 in (426.2 x 110.9 x 16.7 mm)   |  |  |  |
|   | Weight                         | 1.00 lb(452q)  |  |  |  |
| Electrical  | Operating voltage 5 VDC, +/-5% |  |  |  |  |
|   |                                | 50 mA Max (All LED on)   |  |  |  |
|   | Power consumption              |  | USB Port   |  |  |
|   | System interface               |  | Contact Discharge: 8 KV Air Discharge: 15 KV (Class B)   |  |  |
|   | ESD                            |  |  |  |  |
|   | EMI - RFI                      |  | ndard EN 55022: 2006+A<br>Part 15 Class B  | 1: 2007, Class B.  |  |
| Mechanical  | Кеусарѕ                        | 2.0mm +/-0.2   | 2mm at 120gf Key travel  |  |  |
| Environmental                                       | Operating temperature          | 10° C to 90° C   |  |  |  |
|   | Non-operating temperature      | -30° C to 95°  | C  |  |  |
|   | Operating humidity             | N/A  |  |  |  |
|   | Non-operating humidity         | 10% to 90% (non-condensing at ambient)   |  |  |  |
|   | Operating shock                | N/A  |  |  |  |
|   | Non-operating shock            | Axis: X, Y, Z a<br>operation.<br>Number of<br>Pulse dura<br>Velocity ch<br>ii. Trapezoida<br>Operational<br>Sample size: 1<br>Condition: Sa<br>Orientation: A<br>Top.<br>Configuration<br>Number of sh<br>Minimum fair<br>to find margin | mple power off.<br>xis (all 6 faces) – sample i<br>shocks: 1 shock/face.<br>tion: < 3 ms<br>ange: 50lps (inch-per-sec<br>l Shock- Transportation E<br>5pcs.<br>mple power off.<br>All six faces: Front, Rear, L<br>a: As intended for shipmer<br>ocks: 1 shock/face.<br>ed acceleration: 30G's. Te | cond)- 65lps desired.<br>Environment, Non-<br>Left, Right, Bottom, and<br>nt<br>est also at 40 and 50G's |  |
|   |                                | Frequency<br>(Hz)  | Slope (dB/oct)   | PSD (g²/Hz)  |  |
|   |                                | 5-350  | 0  | 0.0001   |  |
|   | Operating vibration            | 350-500  | -6   | -  |  |
|   |                                | 500  | -  | 0.00005  |  |
|   |                                |  | (~0.21G <sub>nms</sub> )<br>Total Test time: 10 r  | ninutes  |  |
|   | Non-operating vibration        | Frequency<br>(Hz)  | Slope (dB/oct)   | PSD (g²/Hz)  |  |

|                      |                            | 5.100  | 0                                 | 0.015                       |  |
|----------------------|----------------------------|--|-----------------------------------|-----------------------------|--|
|                      |                            | 100-137  | -6                                | -                           |  |
|                      |                            | 137-350  | 0                                 | 0.008                       |  |
|                      |                            | 350-500  | -6                                | -                           |  |
|                      |                            | 500  | -                                 | 0.0039                      |  |
|                      | Drop (out of box)          | 76cm on carpet, s  | 76cm on carpet, six-drop sequence |                             |  |
|                      | Drop (in box)              | 10 times drop inc<br>surface.<br>Drop Height: 91cr             | _                                 | corner and 3 edges on rigid |  |
| Approvals            | CB, CE, FCC, ICES, EAC, NO | CB, CE, FCC, ICES, EAC, NOM-NYCE SCT, RCM, BIS, VCCI, KC, BSMI |                                   |                             |  |
| Ergonomic compliance | TUVGS                      |  |                                   |                             |  |

| ouse                      |  |
|---------------------------|--|
| Keys                      | Left/right key   |
| Dimensions(L x W x H)     | 4.09 x2.50 x 1.40 in (103.8x 63.4 x 35.5 mm)   |
| Weight                    | 0.16 lb(72g)   |
| Operating voltage         | 5 VDC, +/-0.25V  |
| Power consumption         | 100 mA Max   |
| System interface          | USB Port   |
| ESD                       | Contact Discharge: 8 KV Air Discharge: 15 KV (Class B)   |
| EMI - RFI                 | European Standard EN 55022: 2006+A1: 2007, Class B.<br>FCC/CFR 47 : Part 15 Class B  |
| Keycaps                   | 0.3mm key travel   |
| Key actuation             | 75±20g   |
| Key life                  | 1million cycles  |
| Key structure type        | Tact Switch  |
| Key-leveling mechanisms   | N/A  |
| Operating temperature     | 10° to 90° C   |
| Non-operating temperature | -30° C to 95° C  |
| Operating humidity        | N/A  |
| Non-operating humidity    | 10% to 90% (non-condensing at ambient)   |
| Operating shock           | N/A  |
|                           | KeysDimensions(L x W x H)WeightOperating voltagePower consumptionSystem interfaceESDEMI - RFIKeycapsKey actuationKey lifeKey-leveling mechanismsOperating temperatureNon-operating temperatureOperating humidityNon-operating humidity |



| I                    |                               | i. Half-Sine Sho   | ock – End-Use Handling,                        | Non-Operational          |
|----------------------|-------------------------------|--|--|--------------------------|
|                      |                               | Sample size: 5pcs.   |  |                          |
|                      |                               |  | nple power off.                                |                          |
|                      |                               |  | is (all 6 faces) – sample r                    | normal mode of           |
|                      |                               | operation.   |  |                          |
|                      |                               | Number of shocks: 1 shock/face.  |  |                          |
|                      |                               | Pulse duration: < 3 ms<br>Velocity change: 50lps (inch-per-second)- 65lps desired. |  |                          |
|                      |                               | velocity change. Jolps (inch-per-second)- oblps desired.                           |  |                          |
|                      |                               | ii. Trapezoidal  | Shock- Transportation E                        | nvironment. Non-         |
|                      | Non-operating shock           | Operational  |  | , -                      |
|                      |                               | Sample size: 5   |  |                          |
|                      |                               |  | nple power off.                                |                          |
|                      |                               |  | l six faces: Front, Rear, L                    | eft, Right, Bottom, and  |
|                      |                               | Top.   | Ac intended for chipmor                        | .+                       |
|                      |                               |  | As intended for shipmer<br>ocks: 1 shock/face. | IL                       |
|                      |                               |  | d acceleration: 30G's. Te                      | est also at 40 and 50G's |
|                      |                               | to find margin.  |  |                          |
|                      |                               | Velocity change: 266lps (inch-per-second) for product mass (m)                     |  |                          |
|                      |                               | 20 <m<40lb.< th=""></m<40lb.<>   |  |                          |
|                      |                               | Frequency<br>(Hz)  | Slope (dB/oct)                                 | PSD (g²/Hz)              |
|                      |                               | 5-350  | 0  | 0.0001                   |
|                      | Operating vibration           | 350-500  | -6   | -                        |
|                      |                               | 500  | -  | 0.00005                  |
|                      |                               |  | (~0.21Gnms)                                    |                          |
|                      |                               | Total Test time: 10 minutes  |  |                          |
|                      |                               | Frequency<br>(Hz)  | Slope (dB/oct)                                 | PSD (g²/Hz)              |
|                      |                               | 5.100  | 0  | 0.015                    |
|                      | Non-operating vibration       | 100-137  | -6   | -                        |
|                      |                               | 137-350  | 0  | 0.008                    |
|                      |                               | 350-500  | -6   | -                        |
|                      |                               | 500  | -  | 0.0039                   |
|                      | Drop (out of box)             | 76cm on carpet, six-drop sequence  |  |                          |
|                      | Drop (in box)                 | N/A  |  |                          |
| Approvals            | CB, CE, FCC, cULus, ICES, EAC | CB, CE, FCC, cULus, ICES, EAC, NOM-NYCE SCT, RCM, VCCI, KC, BSMI                   |  |                          |
| Ergonomic compliance | TUVGS                         |  |  |                          |
|                      |                               |  |  |                          |



| HP 655 wireless Mouse         |  |   |  |
|-------------------------------|--|---|--|
| <b>Dimensions</b> (H x L x W) | 4.74 x 2.75 x 1.63 in (120.29 x 69.97 x41.39 mm) |   |  |
| Weight                        | 0.194lb (88g)                                    |   |  |
| Environmental                 | Operating temperature                            | 50° to 122° F (10° to 50° C)  |  |
|                               | Non-operating temperature                        | -22° to 140° F (-30° to 60° C)  |  |
|                               | Operating humidity                               | 10% to 90% (non-condensing at ambient)  |  |
|                               | Non-operating humidity                           | 20% to 80% (non-condensing at ambient)  |  |
|                               | Operating shock                                  | 40 g, six surfaces  |  |
|                               | Non-operating shock                              | 80 g, six surfaces  |  |
|                               | Operating vibration                              | 2-g peak acceleration   |  |
|                               | Non-operating vibration                          | 4-g peak acceleration   |  |
| Electrical                    | Operating voltage                                | 3 VDC, +/-5%  |  |
|                               | Power consumption (typical)                      | 10 mA Max   |  |
|                               | Resolution                                       | 1,200 DPI (Default)   |  |
|                               | Sensor   | Pixart PAW3222DB-TJDS   |  |
|                               | Tracking speed                                   | 10G(max), 1G=9.8m/s2  |  |
|                               | Tracking acceleration                            | 2.4GHz Wireless   |  |
| Mechanical                    | Color  | Jack Black  |  |
| Regulatory approvals          | Compliant  | CB, CE, FCC, cULus, ICES, IC, TRC, TRA, ICASA, UA, EAC, CNC,<br>ANATEL, NOM-NYCE SCT, IFETEL, MPTC, RCM, PosTel, VCCI,<br>TELEC, KC, MCMC, IDA, BSMI, NCC, DWLF&M, TP-BY, MOC |  |
| Ergonomic compliance          | Compliant  | TUVGS   |  |



| HP PS/2 Mouse                 |   |   |  |
|-------------------------------|---|---|--|
| <b>Dimensions</b> (H x L x W) | 4.53 x 2.48 x1.46 in (115.2x 63 x37 mm) |   |  |
| Weight                        | 0.22lb (101.6g)                         |   |  |
| Environmental                 | Operating temperature                   | 41° to 122° F (5° to 50° C)                     |  |
|                               | Non-operating temperature               | (-4° to 140° F )(-20° to 60° C)                 |  |
|                               | Operating humidity                      | 10% to 85% (non-condensing at ambient)          |  |
|                               | Non-operating humidity                  | 5% to 95% (non-condensing at ambient)           |  |
|                               | Operating shock                         | 40 g, six surfaces                              |  |
|                               | Non-operating shock                     | 80 g, six surfaces                              |  |
|                               | Operating vibration                     | 2-g peak acceleration                           |  |
|                               | Non-operating vibration                 | 4-g peak acceleration                           |  |
| Electrical                    | Tracking speed                          | 30 inch/sec (max)                               |  |
|                               | Tracking acceleration                   | 8G(max), 1G=9.8m/s2                             |  |
|                               | System interface                        | PS/2  |  |
| Mechanical                    | Switch actuation                        | 60±15g nominal peak force with tactile feedback |  |
|                               | Switch life                             | 3 million keystrokes (Life tester)              |  |
|                               | Switch type                             | Contamination-resistant switch membrane         |  |
|                               | Key-leveling mechanisms                 | For all double-wide and greater-length keys     |  |
|                               | Cable length                            | 6 ft (1.8 m)                                    |  |
|                               | Color                                   | Jack Black                                      |  |
| Regulatory approvals          | Compliant                               | UL, FCC, CE Mark, TUV GS, VCCI, BSMI, RCM, KCC  |  |



| HP USB 125 (Antimicrobia      | nl)/128 Laser Mouse (China only) |   |  |  |  |
|-------------------------------|----------------------------------|---|--|--|--|
| <b>Dimensions</b> (H x L x W) | 112 x 63 x 36.2 mm (L x W x H)   | 112 x 63 x 36.2 mm (L x W x H)                      |  |  |  |
| Weight                        | 85 g                             |   |  |  |  |
| Environmental                 | Operating temperature            | 50° to 122° F (10° to 50° C)                        |  |  |  |
|                               | Non-operating temperature        | -22° to 140° F (-30° to 60° C)                      |  |  |  |
|                               | Operating humidity               | 10% to 90% (non-condensing at ambient)              |  |  |  |
|                               | Non-operating humidity           | 20% to 80% (non-condensing at ambient)              |  |  |  |
|                               | Operating shock                  | 40 g, six surfaces                                  |  |  |  |
|                               | Non-operating shock              | 80 g, six surfaces                                  |  |  |  |
|                               | Operating vibration              | 2-g peak acceleration                               |  |  |  |
|                               | Non-operating vibration          | 4-g peak acceleration                               |  |  |  |
| Electrical                    | Operating voltage                | 5 VDC, +/-5%  |  |  |  |
|                               | Power consumption (typical)      | 100mA   |  |  |  |
|                               | Resolution                       | 1,200 DPI   |  |  |  |
|                               | Sensor                           | Optical/ Laser USB mouse sensor                     |  |  |  |
|                               | Tracking speed                   | 30 inch/sec (max)                                   |  |  |  |
|                               | Tracking acceleration            | 8G(max), 1G=9.8m/s2                                 |  |  |  |
| Mechanical                    | Connector                        | USB   |  |  |  |
|                               | Cable length                     | 6 ft (1.8 m)  |  |  |  |
|                               | Color                            | Jack Black  |  |  |  |
| Regulatory approvals          | Compliant                        | UL, FCC, CE Mark, TUV GS, VCCI, BSMI, RCM, KCC, EAC |  |  |  |

Technical Specifications – Audio/Multimedia

#### AUDIO/MULTIMEDIA

| HP Pro Mini 400 G9 Deskto  | p PC  |
|----------------------------|---|
| Туре                       | Integrated  |
| HD Stereo Codec            | Realtek ALC3252   |
| Audio I/O Ports            | Front: Headset connector supports a CTIA and OMTP headset and is retaskable as a Line-in, Line-<br>out, Microphone-in or Headphone-out port                     |
| Internal Speaker Amplifier | 2W class D mono amplifier for the internal speaker only. External speakers must be powered  |
| Multi-streaming Capable    | Playback multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the front jacks or integrated speaker. |
| Sampling                   | Supports resolutions from 16 to 24-bit; 44.1 kHz<br>to 192 kHz for DAC and ADC  |
| Wavetable Syntheses        | Yes - Uses OS soft wavetable  |
| Analog Audio               | Yes   |
| # of Channels on Line-Out  | Stereo (Left & Right channels)  |
| Internal Speaker           | Yes   |

#### HP Pro SFF 400 G9 Desktop PC

| Туре                       | Integrated   |
|----------------------------|--|
| HD Stereo Codec            | Realtek ALC3252  |
| Audio I/O Ports            | Front: Headset connector supports a CTIA and OMTP headset and is retaskable as a Line-in, Line-<br>out, Microphone-in or Headphone-out port<br>Rear: Audio line-in/line-out jack connector*, 3.5mm and support stereo output and retasking |
| Internal Speaker Amplifier | 2W class D mono amplifier for the internal speaker only. External speakers must be powered   |
| Multi-streaming Capable    | Playback multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the front and rear jacks or integrated speaker.   |
| Sampling                   | Supports resolutions from 16 to 24-bit; 44.1 kHz to 192 kHz for DAC and ADC  |
| Wavetable Syntheses        | Yes - Uses OS soft wavetable   |
| Analog Audio               | Yes  |
| # of Channels on Line-Out  | Stereo (Left & Right channels)   |
| Internal Speaker           | Yes  |

\*NOTE: System default is line-out. Line-in / Line-out can be adjusted through the audio setting

# Technical Specifications – Audio/Multimedia

#### HP Pro Tower 400/480 G9 PCI Desktop PC

| Integrated   |
|--|
| Realtek ALC3252  |
| Front: Headset connector supports a CTIA and OMTP headset and is retaskable as a Line-in, Line-<br>out, Microphone-in or Headphone-out port<br>Rear: Audio line-in/line-out jack connector*, 3.5mm and support stereo output and retasking |
| <b>r</b> 2W class D mono amplifier for the internal speaker only. External speakers must be powered  |
| Playback multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the front and rear jacks or integrated speaker.   |
| Supports resolutions from 16 to 24-bit; 44.1 kHz to 192 kHz for DAC and ADC  |
| Yes - Uses OS soft wavetable   |
| Yes  |
| Stereo (Left & Right channels)   |
| Yes  |
|  |

#### \*NOTE: System default is line-out. Line-in / Line-out can be adjusted through the audio setting

#### HP ProOne 440 G9 24 All-in-One PC

| Туре                       | Integrated  |
|----------------------------|---|
| HD Stereo Codec            | Realtek ALC3252   |
| Audio I/O Ports            | Side 3.5mm headset connector supports an OMTP or CTIA style headset and is re-taskable as a<br>Line-in, Line-out, Microphone-in or Headphone-out port |
| Internal Speaker Amplifier | 2W per channel class D stereo amplifier for the internal speakers only  |
| Multi-streaming Capable    | Playback multi-streaming allows independent audio streams to be sent to/from the side jack and<br>integrated speakers.                                |
| Sampling                   | Supports resolutions from 16 to 24-bit; 44.1 kHz to 192 kHz for DAC and ADC   |
| Wavetable Syntheses        | Yes – Uses OS Soft Wavetable  |
| Analog Audio               | Yes   |
| # of Channels on Line-Out  | Stereo (Left & Right channels)  |
| Internal Speaker           | Yes - Stereo  |

#### **INTEGRATED WEBCAM AND MICROPHONE**

Optional integrated 5 MP RGB webcam & microphone; maximum resolution of 2592 x 1944 Optional integrated 5 MP RGB webcam with IR sensor & microphone; maximum resolution of 2592 x 1944

Technical Specifications – Power

### POWER

|   | <u>Mini</u>   | <u>SFF</u>  | TWR   | <u>AiO</u>   |
|---|---|---|---|--|
| External Power Supplies <sup>1</sup>                          | 90W EPS, active PFC, 88%<br>average efficiency at<br>115V & 89% at 230Vac | N/A   | N/A   | 120W EPS, active PFC,<br>88% average efficiency<br>at 115V & 89% at<br>230Vac<br>150W EPS, active PFC,<br>88% efficiency in<br>115Vac / 89%<br>efficiency in 230Vac<br>180W EPS, active PFC,<br>88% average efficiency<br>at 115V & 89% at<br>230Vac<br>230W EPS, active PFC,<br>89% average efficiency<br>at 115V / 230Vac<br>280W EPS, active PFC,<br>89% average efficiency<br>at 115V / 230Vac |
| 80 PLUS Gold  |   | 87/90/87% efficient at<br>20/50/100% load<br>(115V)                           | 180W active PFC / 80<br>PLUS Gold<br>87/90/87% efficient at<br>20/50/100% load<br>(115V)<br>90/92/89% efficient at<br>20/50/100% load<br>(230V)   | N/A  |
| 80 PLUS Platinum  |   | 90/92/89% efficient at<br>20/50/100% load<br>(115V)<br>91/93/90% efficient at | 260W active PFC / 80<br>PLUS Platinum<br>400Wactive PFC / 80<br>PLUS Platinum<br>90/92/89% efficient at<br>20/50/100% load<br>(115V)<br>91/93/90% efficient at<br>20/50/100% load<br>(230V) | N/A  |
| Operating Voltage Range                                       | 90Vac~264Vac  | 90Vac~264Vac  | 90Vac~264Vac  | 90Vac~264Vac   |
| Rated Voltage Range   | 100Vac~240Vac   | 100Vac~240Vac   | 100Vac~240Vac   | 100Vac~240Vac  |
| Rated Line Frequency  | 50HZ~60HZ   | 50HZ~60HZ   | 50HZ~60HZ   | 50HZ~60HZ  |
| Operating Line Frequency                                      | 47HZ~63HZ   | 47HZ~63HZ   | 47HZ~63HZ   | 47HZ~63HZ  |
| Rated Input Current with<br>Energy Efficient* Power<br>Supply | 90W≦1.7A  | 180W Gold $\leq$ 2.3A<br>240W Platinum $\leq$ 2.9A                            | 180W≦2.3A<br>260W≦3.1A<br>400W≦5.2A   | 120W≦1.7A<br>150W≦2.5A<br>180W≦2.5A<br>230W≦3.5A   |
| DC Output   | +19.5V  | +12V  | +12V  | +19.5V   |



### Technical Specifications – Power

| Current Leakage (NFPA 99:<br>2012) |                            | Less than 500<br>microamps of leakage | Less than 500<br>microamps of leakage | Less than 500<br>microamps of leakage  |
|------------------------------------|----------------------------|---------------------------------------|---------------------------------------|--|
| 2012/                              |                            | current at 264 Vac with               |                                       | current at 264 Vac with  |
|                                    | Less than 500 microamps    |                                       |                                       | the ground wire  |
|                                    | of leakage current at 264  |                                       | disconnected, as                      | disconnected, as   |
|                                    | Vac with the ground wire   |                                       | required for Non-                     | required for Non-  |
|                                    | disconnected, as required  | •                                     | patient Electrical                    | patient Electrical   |
|                                    | for Non-patient Electrical |                                       | Appliances and                        | Appliances and   |
|                                    |                            | Equipment used in a                   | Equipment used in a                   | Equipment used in a  |
|                                    |                            | patient care facility or              |                                       | patient care facility or   |
|                                    |                            |                                       |                                       | that contact patients in   |
|                                    |                            | normal use. Per section               |                                       |  |
|                                    |                            | 10.3.5.1.                             | 10.3.5.1.                             | 10.3.5.1.  |
|                                    | 10.3.5.1.                  | Less than 100                         | Less than 100                         | Less than 100  |
|                                    | Less than 100 microamps    | microamps of leakage                  | microamps of leakage                  | microamps of leakage   |
|                                    | of leakage current at 264  | current at 264 Vac with               | current at 264 Vac with               | current at 264 Vac with  |
|                                    | Vac with the ground wire   | the ground wire intact                | the ground wire intact                | the ground wire intact   |
|                                    | intact with normal         | with normal polarity, as              | with normal polarity, as              | with normal polarity, as   |
|                                    | polarity, as required for  | required for Non-                     | required for Non-                     | required for Non-  |
|                                    | Non-patient Electrical     | patient Electrical                    | patient Electrical                    | patient Electrical   |
|                                    | Appliances and             | Appliances and                        | Appliances and                        | Appliances and   |
|                                    | Equipment used in a        | Equipment used in a                   | Equipment used in a                   | Equipment used in a  |
|                                    |                            | patient care facility or              | patient care facility or              | patient care facility or   |
|                                    |                            |                                       | that contact patients in              |  |
|                                    |                            | normal use. Per section               |                                       |  |
|                                    | 10.3.5.1.                  | 10.3.5.1.                             | 10.3.5.1.                             | 10.3.5.1.  |
| Power Supply Fan                   | N/A                        | 50mm variable speed                   | 70mm variable speed                   | N/A  |
| Power cord length*                 | 6.0 ft. (1.83 m)           | 6.0 ft. (1.83 m)                      | 6.0 ft. (1.83 m)                      | 6.0 ft. (1.83 m)   |
| Dimensions                         | 90W: 126 x 50 x 30 mm      | 200 x 85 x 53 mm                      | 165 x 95 x 73 mm                      | 120W: 138mm x<br>68.5mm x 25.4mm<br>150W: 148 x 75.5 x<br>25.4mm<br>180W: 165.5mm x<br>79mm x 25.4mm<br>230W: 180mm x 88mm<br>x 25.4mm |

1. External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

\*NOTE: 2m for India



#### Technical Specifications – Power

The power supply shall comply with harmonic input current requirements as detailed in EN61000-3-2 and JEIDA MITI standards. The harmonic input current requirements must be met under the following operating conditions:

Load Requirements: 50% and 100%

Input Voltage: 230Vac/50Hz.

For active power factor correction the power factor at 50% &100% loads shall be greater than 0.9 over the entire nominal input voltage range (100-127VAC and 200-240VAC).

| Condition         | Standard Efficiency | 82/85/82% | 85/88/85% | 87/90/87% | 90/92/89% | Input Voltage |
|-------------------|---------------------|-----------|-----------|-----------|-----------|---------------|
| 10% of Rated Load | -                   | 75%       | 81%       | 84%       | 86%       | 115Vac/60HZ   |
| 20% of Rated Load | -                   | 82%       | 85%       | 87%       | 90%       | 115Vac/60HZ   |
| 50% of Rated Load | -                   | 85%       | 88%       | 90%       | 92%       | 115Vac/60HZ   |
|                   | PF>0.9              | PF>0.9    | PF>0.9    | PF>0.9    | PF>0.95   |               |
|                   | PF>0.9              | PF>0.9    | PF>0.9    | PF>0.9    | PF>0.9    | 230Vac/50HZ   |
| 100% of Rated     | 70%                 | 82%       | 85%       | 87%       | 89%       | 115Vac/60HZ   |
| Load              | PF>0.9              | PF>0.9    | PF>0.9    | PF>0.9    | PF>0.9    | 230Vac/50HZ   |



Technical Specifications – Weights and Dimensions

#### **WEIGHTS & DIMENSIONS<sup>1</sup>**

|   | DM   | <u>SFF</u>  |
|---|--|---|
| Chassis (W x D x H)                           | 6.97 x 6.89 x 1.35 in<br>177 x 175 x 34.2 mm   | 10.63 x 12.12 x 3.74 in<br>270 x 308 x 95 mm  |
| System Volume                                 | 64 cu in<br>1.05 L   | 481.85 cu in<br>7.9 L   |
| System Weight <sup>1</sup>                    | 2.74 lb<br>1.25 kg   | 9.59 lb<br>4.35 kg  |
| Max Supported Weight<br>(desktop orientation) | N/A  | 9.55 lb<br>4.38 kg  |
| Packaging Dimension (WxDxH)                   | 19.57 x 5.04 x 8.78 in<br>(497 x 128 x 223 mm)   | 15.52 x 19.65 x 8.07 in<br>(394 x 499 x 205 mm)   |
|   | <b>MPP*</b> : 19.61 x 9.25 x 5.20 in<br>(498 x 235 x 132 mm)   | <b>MPP*</b> : 15.52 x 19.65 x 8.07 in<br>(394 x 499 x 205 mm)   |
| Shipping Weight                               | 6.52 lb (2.97 kg)  | 15.31 lb (6.95 kg)  |
|   | <b>MPP*</b> : 7.50 lb (3.40 kg)  | <b>MPP*</b> : 15.97 lb (7.25 kg)  |
| Palletization Profile (Fabricated EPE)        | 18-units per layer<br>5 or 6 layers max depending on details<br>of air freight<br>90 or 108 units per pallet depending on<br>details of air freight<br>45.354 x 39.13 x 57.80 in, 1152 x 994 x<br>1468 mm (including pallet) | 1200 x 1000 x 2412 mm   |
| Palletization Profile** (Molded Pulp)         | 10-units per layer<br>10 to 19 layers max depending on<br>details of freight<br>100 or 190 units per pallet depending<br>on details of freight<br>46.26 x 39.21 x 103.74 in, 1175 x 996 x<br>2635 mm (including pallet)      | 6-units per layer<br>11 layer max<br>66 per pallet<br>47.24 x 39.37 x 94.63 in, 1200 x 1000 x<br>2412 mm (including pallet) |

1. Packaging material used will vary by country

2. Configured with 1 HDD & 1 ODD; DM configured with 1 HDD only

**\*NOTE:** "Molded pulp paper" cushion.

**\*\*NOTE:** The palletization is for single pack

### Technical Specifications – Weights and Dimensions

|   | TWR  |
|---|--|
| Chassis (W x D x H)                           | 6.1 x 12.13 x 13.27 in<br>155x 308 x 337 mm  |
| System Volume                                 | 981.9 cu in<br>16.1 L  |
| System Weight <sup>1</sup>                    | 11.7 lb<br>5.31 kg   |
| Max Supported Weight<br>(desktop orientation) | 11.2 lb<br>5.08 kg   |
| Packaging Dimension<br>(W x D x H)            | 15.75 x 19.65 x 11.30 in<br>(400 x 499 x 287 mm)   |
|   | <b>MPP</b> : 15.75 x 19.65 x 11.30 in<br>(400 x 499 x 287 mm)  |
| Shipping Weight                               | 17.69 lb (8.03 kg)<br><b>MPP</b> : 18.5 lb (8.4 kg)  |
| Palletization Profile (Fabricated EPE)        | 6-units per layer<br>8 layer max<br>48 per pallet<br>47.24 x 39.37 x 95.12 in, 1200 x 1000 x<br>2416 mm (including pallet) |
| Palletization Profile (Molded Pulp)           | 6-units per layer<br>8 layer max<br>48 per pallet<br>47.24 x 39.37 x 95.12 in, 1200 x 1000 x<br>2416 mm (including pallet) |

1. Packaging material used will vary by country

2. Configured with 1 HDD & 1 ODD; DM configured with 1 HDD only



Technical Specifications – Weights and Dimensions

#### **ALL-IN-ONE DIMENSIONS<sup>1</sup>**

|                           |              | Without Stand<br>(VESA Cover Plate) |           | Cantilever Stand<br>(Fixed Height Tilt Stand) |           | Adjustable Height Stand |                  |
|---------------------------|--------------|-------------------------------------|-----------|---|-----------|-------------------------|------------------|
|                           |              | cm/kg                               | inch/lb   | cm/kg   | inch/lb   | cm/kg                   | inch/lb          |
|                           | Width        | 53.93 cm                            | 21.23 in  | 53.93 cm                                      | 21.23 in  | 53.93 cm                | 21.23 in         |
|                           | Length/Depth | 8.96 cm                             | 3.53 in   | 18.70 cm                                      | 7.36 in   | 22.5 cm                 | 8.85 in          |
| Product                   | Height       | 35.36 cm                            | 13.92 in  | 40.28 cm                                      | 15.85 in  | 37.94 ~ 50.94<br>cm     | 14.93 ~ 20.05 in |
|                           | Weight       | 6.93 kg                             | 15.28 lb  | 7.315 kg                                      | 16.12 lb  | 7.775kg                 | 17.57 lb         |
|                           | Width        | 66.0 cm                             | 25.98 in  | 66.0 cm                                       | 25.98 in  | 66.0 cm                 | 25.98 in         |
| Dealasas                  | Length/Depth | 19.5 cm                             | 7.67 in   | 19.5 cm                                       | 7.67 in   | 19.5 cm                 | 7.67 in          |
| Package                   | Height       | 46.2 cm                             | 18.19 in  | 46.2 cm                                       | 18.19 in  | 46.2 cm                 | 18.19 in         |
|                           | Weight       | 10.87 kg                            | 23.96 lb  | 11.59 kg                                      | 25.55 lb  | 12.12 kg                | 26.72 lb         |
|                           | Width        | 120.0 cm                            | 47.24 in  | 120.0 cm                                      | 47.24 in  | 120.0 cm                | 47.24 in         |
|                           | Length/Depth | 100.0 cm                            | 39.37 in  | 100.0 cm                                      | 39.37 in  | 100.0 cm                | 39.37 in         |
| Palletization             | Height       | 198.8 cm                            | 78.27 in  | 198.8 cm                                      | 78.27 in  | 198.8 cm                | 78.27 in         |
| for Sea/Rail              | Weight       | 319.36 kg                           | 704.06 lb | 324.52 kg                                     | 715.44 kg | 354.36 kg               | 718.22 lb        |
|                           | Qty / Layer  | 7                                   |           | 7   |           | 7                       |                  |
|                           | Layers       | 4                                   |           | 4   | 1         |                         | 4                |
| Qty / Pallet via Sea/Rail |              | 28                                  | 3         | 2   | 8         | 2                       | 28               |
| Qty / Pallet via Air      |              | 2                                   | 1         | 2   | 1         | i                       | 21               |

1. Packaging material used will vary by country.

2. Configured with 1 HDD & 1 ODD.

3. Package weight is based on EPE package.

4. Actual system weight will depend on the system configuration.

Miscellaneous Features

#### **MISCELLANEOUS FEATURES**

#### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel<sup>®</sup> Wired for Management support; industry wide initiative to make Intel<sup>®</sup> architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

#### **Serviceability Features**

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:

.

- Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
  - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically)
  - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy
  - 2 red + 4 white BIOS recovery is in progress
  - 3 red + 2 white Memory could not be initialized
  - 3 red + 3 white Graphics adaptor could not be found
  - 3 red + 4 white Power supply failure / not connected
  - 3 red + 5 white Processor not installed
    - 3 red + 6 white Current processor does not support an enabled feature
  - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
  - 4 red + 3 white System internal temperature has exceeded its threshold
  - 5 red + 2 white System controller firmware is not valid
  - 5 red + 3 white System controller detected BIOS is not executing
    - 5 red + 4 white BIOS could not complete initialization / mainboard failure
  - 5 red + 5 white System controller rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
  - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 1 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, memory & optical drive Removal (For MT, SFF, and DM only)
- Green Pull Tabs, and Quick Release Latches for easy Identification

#### Miscellaneous Features

| Additional Features  | Description  |
|--|--|
| Product Orientation  | Microtower (MT) can be oriented in a tower (vertical) orientation.<br>Small Form Factor (SFF) can be oriented as either a desktop (horizontal) or a tower<br>(vertical) with optional vertical stand.<br>Desktop Mini (DM) can be oriented as either a desktop (horizontal) or a tower (vertical)<br>with optional vertical stand. |
| Boot Sectors Protection  | MBR and GPT sectors of the hard drive are critical to booting the operating system. By saving the MBR or GPT data (depending on the how the OS was installed), the BIOS will be able to monitor for changes and allow the user to override them with the backup copy at boot-up.   |
| Drive Protection System  | DPS Access through F10 Setup during Boot   |
|  | A diagnostic hard drive self- test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user   |
|  | Running independently of the operating system, it can be accessed through a Windows-<br>based diagnostics utility or through the computer's setup procedure. It produces an<br>evaluation on whether the hard drive is the source of the problem and needs to be<br>replaced   |
|  | The system expands on the Self-Monitoring, Analysis, and Reporting Technology<br>(SMART), a continuously running systems diagnostic that alerts the user to certain<br>types of failures   |
| SMART Technology (Self-Monitoring,<br>Analysis and Reporting Technology) | Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted  |
| SMART I - Drive Failure Prediction                                       | Predicts failures before they occur. Tracks fault prediction and failure indication<br>parameters such as re-allocated sector count, spin retry count, calibration retry count   |
| SMART II - Off-Line Data Collection                                      | By avoiding actual hard drive failures, SMART hard drives act as "insurance" against<br>unplanned user downtime and potential data loss from hard drive failure  |
| SMART III - Off-Line Read Scanning with<br>Defect Reallocation           | IOEDC: I/O Error Detection Circuitry   |
| SMART IV - End-to-End CRC for hard<br>drives                             | Detects errors in Read/Write buffers on HDD cache RAM  |

After Market Options

### **AFTER MARKET OPTIONS**

| Graphics Solutions  | <u>Mini</u> | <u>SFF</u> | <u>TWR</u> | <u>Ai0</u> | <u>Part Number</u> |
|---|-------------|------------|------------|------------|--------------------|
| NVIDIA T400 4GB GDDR6 3mDP                                  |             | X          | X          |            | <u>5Z7E0AA</u>     |
| AMD Radeon RX 6300 2GB GDDR6 DP+HDMI FH                     |             |            | X          |            | 7Y6P7AA            |
| AMD Radeon RX 6300 2GB GDDR6 DP+HDMI LP                     |             | X          |            |            | 803S9AA            |
| Intel Arc A380 6GB GDDR6 FH PCIe x16 3DP+HDMI               |             |            | X          |            | 9Q6G0AA            |
| HP DisplayPort™ To HDMI True 4k Adapter                     | Х           | X          | X          | X          | 2JA63AA            |
| HP HDMI Standard Cable Kit                                  | Х           | Х          | X          | X          | T6F94AA            |
| HP DisplayPort™ Cable Kit                                   | х           | X          | X          | Х          | VN567AA            |
| HP DisplayPort™ To VGA Adapter                              | Х           | X          | X          | X          | AS615AA            |
| HP DisplayPort™ To DVI-D Adapter                            | Х           | X          | X          | X          | FH973AA            |
|   |             |            |            |            |                    |
| Desktop Mini Accessories                                    | <u>Mini</u> | <u>SFF</u> | TWR        | <u>Ai0</u> | <u>Part Number</u> |
| HP Desktop Mini 2.5" SATA Drive Bay kit v2                  | X           |            |            |            | 13L70AA            |
| HP Desktop Mini LockBox V2                                  | X           |            |            |            | 3EJ57AA            |
| HP Desktop Mini DVD-Writer ODD Expansion Module             | X           |            |            |            | K9Q83AA            |
| HP Desktop Mini v4+ VESA Sleeve                             | X           |            |            |            | 99T54AA            |
| HP Desktop Mini v4+ VESA Sleeve with Power Supply<br>Holder | x           |            |            |            | 99T55AA            |
| HP B250 PC Mounting Bracket                                 | X           |            |            |            | 8RA46AA            |
| HP B200 PC Mounting Bracket                                 | X           |            |            |            | 762T5AA            |
| HP B300 PC Mounting Bracket                                 | X           |            |            |            | 2DW53AA            |
| HP B300 PC Mounting Bracket with Power Supply<br>Holder     | x           |            |            |            | 7DB37AA            |
| HP Desktop Mini Vertical Chassis Stand                      | X           |            |            |            | G1K23AA            |
| B550 PC Mounting Bracket                                    | X           |            |            |            | 16U00AA            |
| HP B560 PC Mounting Bracket                                 | X           |            |            |            | 763U8AA            |
| In Boot Chounting Bracket                                   |             |            |            |            |                    |

| Data Storage Drives                       | <u>Mini</u> | <u>SFF</u> | <u>twr</u> | <u>Ai0</u> | <u>Part Number</u> |
|---|-------------|------------|------------|------------|--------------------|
| HP PCIe Gen 4 NVME TLC M.2 512GB SSD      | X           | X          | X          | X          | 406L8AA            |
| HP PCIe Gen 4 NVME TLC M.2 1TB SSD        | X           | X          | X          | X          | 406L7AA            |
| HP 1TB 7200rpm SATA 6Gb/s 3.5" Hard Drive |             | X          | X          |            | QK555AA            |



## After Market Options

| Input Devices   | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> | Part Number |
|---|-------------|------------|-----|------------|-------------|
| HP Wired Desktop 320K Keyboard                                      | X           | X          | X   | X          | 9SR37AA     |
| HP USB Business Slim CCID SmartCard Keyboard                        | X           | X          | X   | X          | Z9H48AA     |
| HP Wired Desktop 320MK Mouse and Keyboard                           | X           | X          | X   | X          | 9SR36AA     |
| HP Wired Desktop 320M Mouse   | X           | X          | X   | X          | 9VA80AA     |
| HP 655 Wireless Keyboard and Mouse Combo                            | X           | X          | X   | X          | 4R009AA     |
| HP 455 Programmable Wireless Keyboard                               | X           | X          | X   | X          | 4R177AA     |
| HP 125 Wired Keyboard   | X           | X          | X   | X          | 266C9AA     |
| HP 125 Wired Mouse  | X           | X          | X   | X          | 265A9AA     |
| HP 128 Laser Wired Mouse  | X           | X          | X   | X          | 265D9AA     |
| HP 225 Wired Mouse and Keyboard Combo                               | X           | X          | X   | X          | 286J4AA     |
| HP 225 Antimicrobial Wired Mouse and Keyboard<br>Combo (China Only) | X           | X          | X   | X          | 286K3AA     |
| System Memory   | Mini        | <u>SFF</u> | TWR | AiO        | Part Number |
| HP 4GB DDR4-3200 UDIMM  |             | X          | X   |            | 13L78AA     |
| HP 8GB DDR4-3200 UDIMM  |             | X          | X   |            | 13L76AA     |
| HP 16GB DDR4-3200 UDIMM   |             | Х          | X   |            | 13L74AA     |
| HP 32GB DDR4-3200 UDIMM   |             | Х          | X   |            | 13L72AA     |
| HP 4GB DDR4-3200 SODIMM   | X           |            |     | X          | 13L79AA     |
| HP 8GB DDR4-3200 SODIMM   | X           |            |     | X          | 13L77AA     |
| HP 16GB DDR4-3200 SODIMM  | X           |            |     | X          | 13L75AA     |
| HP 32GB DDR4-3200 SODIMM  | X           |            |     | X          | 13L73AA     |
| HP 8GB DDR5-4800 UDIMM  |             | Х          | X   |            | 4M9X9AA     |
| HP 16GB DDR5-4800 UDIMM   |             | X          | X   |            | 4M9Y0AA     |
| HP 32GB DDR5-4800 UDIMM   |             | Х          | X   |            | 4M9Y2AA     |
| HP 8GB DDR5-4800 SODIMM   | X           |            |     | X          | 4M9Y4AA     |
| HP 16GB DDR5-4800 SODIMM  | X           |            |     | X          | 4M9Y5AA     |
| HP 32GB DDR5-4800 SODIMM  | X           |            |     | X          | 4M9Y7AA     |
| HP 8GB DDR5-5600 SODIMM   | X           |            |     | X          | 79U70AA     |
| HP 16GB DDR5-5600 SODIMM  | X           |            |     | X          | 79U71AA     |
| HP 32GB DDR5-5600 SODIMM  | X           |            |     | X          | 79U72AA     |
| Multimedia Devices  | Mini        | <u>SFF</u> | TWR | AiO        | Part Number |
| HP S101 Speaker Bar   |             | X          | X   |            | 5UU40AA     |
| HP Z G3 Conferencing Speaker Bar                                    | X           | X          | X   |            | 32C42AA     |
| HP Stereo 3.5mm Headset G2  | X           | X          | X   |            | 428K7AA     |
|   |             |            |     |            |             |

HP Stereo USB Headset G2

X

X

428K6AA

## After Market Options

| Communication Devices  | Mini        | <u>SFF</u> | TWR | <u>Ai0</u> | Part Number        |
|--|-------------|------------|-----|------------|--------------------|
| Intel® Ethernet I225-T1 GbE NIC                                |             | X          | X   |            | 406L9AA            |
| Intel® Ethernet I226-T1 2.5GbE NIC                             |             | X          | X   |            | 9P1U8AA            |
|  |             |            |     |            |                    |
| Security Devices   | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> | <u>Part Number</u> |
| HP Business PC Security Lock v3 Kit                            |             | X          | Х   |            | 3XJ17AA            |
| HP Keyed Cable Lock 10mm                                       | X           | X          | X   | X          | T1A62AA            |
| Stands and Mounting Accessories                                | Mini        | SFF        | TWR | AiO        | Part Number        |
| HP B250 PC Mounting Bracket                                    | <u> </u>    | <u> </u>   |     |            | 8RA46AA            |
| HP B300 PC Mounting Bracket                                    | X           |            |     |            | 2DW53AA            |
| HP B550 PC Mounting Bracket                                    | X           |            |     |            | 16U00AA            |
| HP Quick Release Bracket 2                                     | X           |            |     | X          | 6KD15AA            |
| HP ProOne G9 VESA Plate with Power Supply Holder               |             |            |     | X          | 56P78AA            |
|  | 0           | -1         |     |            | <u></u>            |
| I/O Devices  | <u>Mini</u> | <u>SFF</u> | TWR | <u>Ai0</u> | <u>Part Number</u> |
| HP DisplayPort Port Flex IO v2                                 | X           | X          | X   |            | 13L54AA            |
| 800 G9 SATA Power Cable Non RF                                 |             | X          |     |            | 8H5A4AA            |
| 400 G9 SATA Power Cable Non RF                                 |             |            | Х   |            | 8H5A3AA            |
| HP HDMI Port Flex IO v2  | X           | X          | X   |            | 13L55AA            |
| HP Type-C USB 3.1 Gen2 Port Flex IO v2                         |             | Х          | X   |            | 13L59AA            |
| HP Type-C USB 3.1 Gen2 Port with 100W PD Flex IO v2            | X           |            |     |            | 13L60AA            |
| HP VGA Port Flex IO v2   | X           | X          | X   |            | 13L53AA            |
| HP Serial Port Flex IO 2nd                                     | X           |            |     |            | 13L57AA            |
| HP PCIe x1 Parallel Port Card                                  |             | X          | X   |            | N1M40AA            |
| HP 800/600/400 G3 Serial/ PS/2 Adapter                         |             | X          | X   | <u> </u>   | 1VD82AA            |
| HP USB to Serial Port Adapter                                  | X           | X          | X   | X          | J7B60AA            |
| HP Serial Port Flex IO v3                                      | X           | X          | X   | <u> </u>   | 5B895AA            |
| HP USB-C To DisplayPort Adapter                                | X           | <u> </u>   |     | X          | N9K78AA            |
| HP Single Mini Display Port Adapter to Display Port<br>Adapter |             | x          | x   |            | 2MY05AA            |

**NOTE:** For more detail on HP I/O Devices please refer to the HP FLEX IO Option Cards QuickSpecs. URL is: http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c06042607



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Change Log

| Date           | Version History | Action      | Description of Change   |
|----------------|-----------------|-------------|---|
| April 26, 2024 | From v1 to v2   | Update      | T400 cards multi display support updated to 3   |
| April 29, 2024 | From v2 to v3   | Replacement | Intel® I225-LM 2.5 for Intel FoxPond1 I225-T1 2.5GbE  |
| May 3, 2024    | From v3 to v4   | Removal     | HP Desktop Mini Port Cover v3 from AMO section  |
| May 8, 2024    | From v4 to v5   | Removal     | DDR5-5600 64GB 2SO-DIMM card from Memory section  |
| July 22, 2024  | From v5 to v6   | Correction  | Integrated SATA storage connector corrected checked for AiO   |
| August 7, 2024 | From v6 to v7   | Correction  | Intel <sup>®</sup> 12th Generation Core™ Processors and Intel <sup>®</sup> Pentium <sup>®</sup> Processors specs corrected. |
|                | From v7 to v8   |             |   |
|                | From v8 to v9   |             |   |
|                | From v9 to v10  |             |   |
|                | From v10 to v11 |             |   |
|                | From v11 to v12 |             |   |
|                | From v12 to v13 |             |   |
|                | From v13 to v14 |             |   |
|                | From v14 to v15 |             |   |
|                | From v15 to v16 |             |   |
|                | From v16 to v17 |             |   |
|                | From v17 to v18 |             |   |
|                | From v18 to v19 |             |   |
|                | From v19 to v20 |             |   |
|                | From v20 to v21 |             |   |
|                | From v21 to v22 |             |   |
|                | From v22 to v23 |             |   |